Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

1. DESCRIPTION

The M37212M6-XXXSP/FP, M37212M4/M8-XXXSP are single-chip microcomputers designed with CMOS silicon gate technology. They have a OSD, I 2 C-BUS interface, and PWM, so it is useful for a channel selection system for TV.

The feature of the M37212EFSP/FP are similar to those of the M37212M6-XXXSP/FP except that these chips have a built-in PROM which can be written electrically. The differences between the M37212M6-XXXSP/FP and M37212M4/M8-XXXSP are the ROM size and the RAM size as shown below. Accordingly, the following descriptions will be for M37212M6-XXXSP/FP unless otherwise noted.

2. FEATURES

Number of basic instructions	7
●Memory size	
ROM 16K bytes (M37212M4-XXXSP)	
24K bytes (M37212M6-XXXSP/F	P
32K bytes (M37212M8-XXXSP)	
62K bytes (M37212EFSP/FP)	
RAM 320 bytes (M37212M4-XXXSP)	
384 bytes (M37212M6-XXXSP/F	Р
576 bytes (M37212M8-XXXSP)	
1280 bytes (M37212EFSP/FP)	
(*ROM correction memory included)	
●The minimum instruction execution time	
0.5 μs (at 8 MHz oscillation frequence	;y
$ \bullet \text{Power source voltage} \hspace{0.5cm} \dots \hspace{0.5cm} 5 \text{ V} \pm 10 \\$	%
●Subroutine nesting	
maximum 96 levels (M37212M4/M8-XXXSP, M37212M6-XXXSP/F	Ρ
maximum 128 levels (M37212EFSP/FP)	
●Interrupts	r
●8-bit timers	. 4
●Programmable I/O ports	
(Ports P0, P10–P14, P2, P30, P31, P40, P41)	
●Input ports (Ports P15–P17, P32–P37, P42)	
●Output ports (Ports P52–P55, P60–P63)	
●12 V withstand ports	
Delta drive ports	
•Serial I/O	
●Multi-master I ² C-BUS interface 1 (2 system	
•A-D comparator (6-bit resolution) 8 channel	
●PWM output circuit14-bit X 1, 8-bit X	
•Power dissipation	
(at 8 MHz oscillation frequency, Vcc=5.5V, at OSD displa	•
●ROM correction function	r

Note: Only M37212M8-XXXSP and M37212EFSP/FP have ROM

correction function.

 OSD function 	
Display characters	24 characters X 2 lines
(It is possibl	le to display 3lines or more by software)
Kinds of characters	256 kinds
Character display area	12 X 16 dots
Kinds of character sizes	3 kinds
Kinds of character colors	8 colors (R, G, B)
Coloring unit	character, character background, raster
Display position	
Horizontal: 64 levels	Vertical: 128 levels
Attribute	border

3. APPLICATION

T١



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

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SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

4. PIN CONFIGURATION

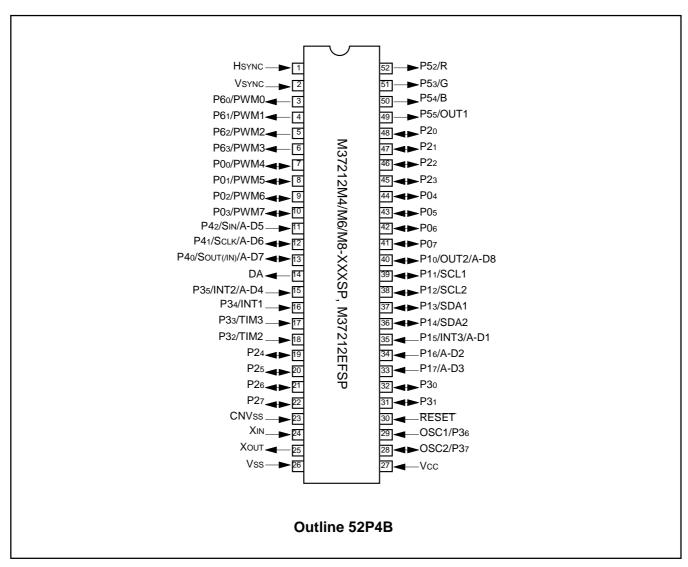


Fig. 4.1 Pin Configuration 1 (Top View)

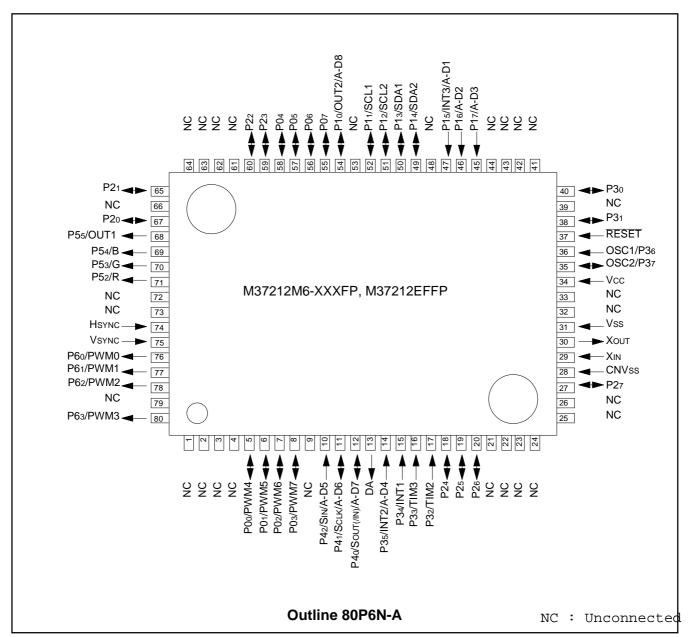


Fig. 4.2 Pin Configuration 2 (Top View)

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

5. FUNCTIONAL BLOCK DIAGRAM

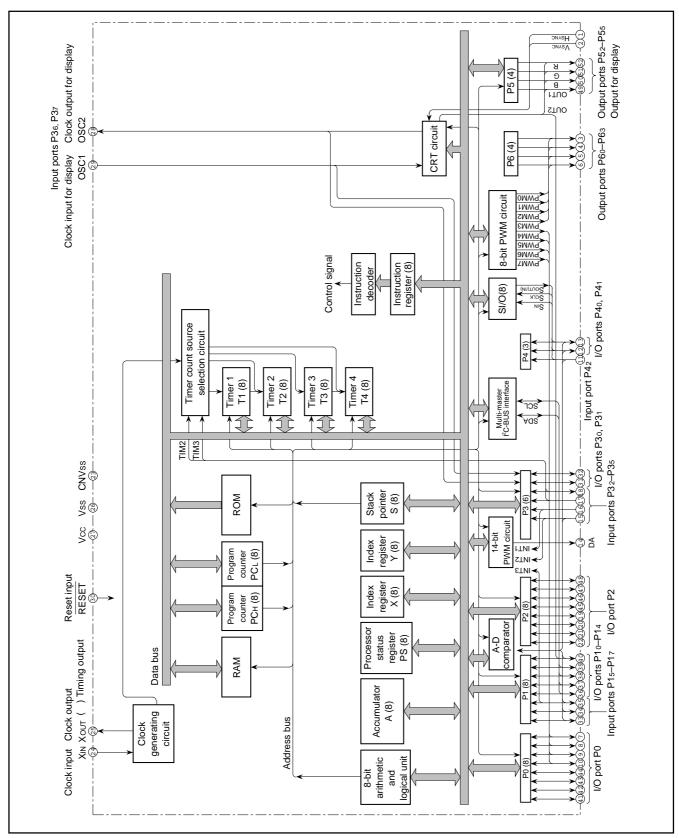


Fig. 5.1 Functional Block Diagram of M37212

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

6. PERFORMANCE OVERVIEW

Table 6.1 Performance Overview

Parameter				Functions	
Number of basic instructions				71	
Number of basic instructions				$0.5\;\mu\text{s}$ (the minimum instruction execution time, at 8 MHz oscillation fre quency)	
Instruction execution time				8 MHz (maximum)	
Memory size	ROM	M37212M	4-XXXSP	16K bytes	
		M37212M6-XXXSP/FP		24K bytes	
		M37212M8-XXXSP		32K bytes	
		M37212E	FSP/FP	62K bytes	
	RAM	M37212M	4-XXXSP	320 bytes	
		M37212M6-XXXSP/FP		384 bytes	
		M37212M8-XXXSP		576 bytes (ROM correction memory included)	
		M37212E	FSP/FP	1280 bytes (ROM correction memory included)	
	OSD F	ROM		8 K bytes	
	OSD F	RAM		96 bytes	
Input/Output ports	P0		I/O	8-bit ${\bf X}$ 1 (N-channel open-drain output structure, can be used as PWM output pins)	
	P10-P14		I/O	5-bit X 1 (CMOS input/output output structure, however, N-channel opendrain output structure, when P11–P14 are used as multi-master I ² C-BUS interface, can be used as OSD output, A-D input, multi-master I ² C-BUS interface)	
	P15-P17		Input	3-bit X 1 (can be used as INT input pin, A-D input pins)	
	P20-P27		I/O	8-bit X 1 (CMOS input/output structure)	
	P30, P31		I/O	2-bit X 1 (CMOS input/output structure)	
	P32–P37		Input	6-bit X 1 (can be used as external clock input pins, INT input pins, OSD display clock I/O pins, A-D input pins)	
	P40, P41		I/O	2-bit X 1 (N-channel open-drain output structure, can be used as serial I/O pins, A-D input pins)	
	P42		Input	1-bit X 1(can be used as serial input pin, A-D input pin)	
	P52-P55		Output	4-bit X 1 (CMOS output structure, can be used as OSD output pins)	
	P60-P63		Output	4-bit X 1 (N-channel open-drain output structure, can be used as PWM output pins)	
Serial I/O				8-bit X 1	
Multi-master I ² C-BUS interf	ace			1 (2 systems)	
A-D comparator				8 channels (6-bit resolution)	
PWM output circuit				14-bit X 1, 8-bit X 8	
Timers				8-bit timer X 4	
Subroutine nesting				96 levels (maximum)	
Interrupt				<14 sources> INT external interrupt X 3, Internal timer interrupt X 4, Serial I/O interrupt X 1, OSD interrupt X 1, Multi-master I ² C-BUS interface interrupt X 1, f(XIN)/4096 interrupt X 1, VSYNC interrupt X 1, BRK interrupt X 1, Reset X 1	
Clock generating circuit				2 built-in circuits (externally connected a ceramic resonator or a quartz-crystal oscillator)	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Table 6.2 Performance Overview (continued)

	Parameter	Functions	
OSD display	Number of display characters	24 characters X 2 lines	
function	Dot structure	12 X 16 dots	
	Kinds of characters	254 kinds	
	Kinds of character sizes	3 kinds	
	Character font coloring	1 screen: 8 kinds (per character unit)	
Display position		Horizontal: 64 levels, Vertical: 128 levels	
Power source v	oltage	5 V ± 10 %	
Power dissipation OSD ON		165 mW typ. (at oscillation frequency f(XIN) = 8 MHz, fosc = 8 MHz)	
OSD OFF		110 mW typ. (at oscillation frequency f(XIN) = 8 MHz)	
	In stop mode	1.65 mW (maximum)	
Operating temperature range		-10 °C to 70 °C	
Device structure		CMOS silicon gate process	
Package	M37212M4/M6/M8-XXXSP, M37212EFSP	52-pin plastic molded SDIP	
M37212M6-XXXFP, M37212EFSP		80-pin plastic molded QFP	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

7. PIN DESCRIPTION

Table 7.1 Pin Description

Pin	Name	Input/ Output	Functions	
Vcc, Vss.	Power source		Apply voltage of 5 V \pm 10 % to (typical) Vcc, and 0 V to Vss.	
CNVss	CNVss		This is connected to Vss.	
RESET	Reset input	Input	To enter the reset state, the reset input pin must be kept at a "L" for 2 μ s or more (under normal Vcc conditions). If more time is needed for the quartz-crystal oscillator to stabilize, this "L" condition should be maintained for the required time.	
XIN	Clock input	Input	This chip has an internal clock generating circuit. To control generating frequency, an external ceramic resonator or a quartz-crystal oscillator is connected between pins XIN and	
Хоит	Clock output	Output	XOUT. If an external clock is used, the clock source should be connected to the XIN pin and the XOUT pin should be left open.	
P00/PWM4- P03/PWM7, P04-P07	I/O port P0	I/O	Port P0 is an 8-bit I/O port with direction register allowing each I/O bit to be individually programmed as input or output. At reset, this port is set to input mode. The output structure is N-channel open-drain output. (See note)	
	PWM output	Output	Pins P00–P03 are also used as PWM output pins PWM4–PWM7 respectively. The output structure is N-channel open-drain output.	
P10/OUT2/ A-D8,	I/O port P1	I/O	Port P10–P14 are a 5-bit I/O port and has basically the same functions as port P0. The output structure is CMOS output.	
P11/SCL1,	OSD output	Output	Pins P10 is also used as OSD output pin OUT2. The output structure is CMOS output.	
P12/SCL2, P13/SDA1,	Multi-master I ² C-BUS interface	I/O	Pins P11–P14 are used as SCL1, SCL2, SDA1 and SDA2 respectively, when multi-master I ² C-BUS interface is used. The output structure is N-channel open-drain output.	
P14/SDA2,	Analog input	Input	P10 pin is also used as analog input pin A-D8.	
P15/INT3/	Input port P1	Input	Port P15–P17 are a 3-bit input port and has basically the same functions as port P0.	
A-D1,	Analog input	Input	Pins P15–P17 are also used as analog input pins A-D1 to A-D3 respectively.	
P16/A-D2, P17/A-D3	External interrupt input	Input	P1s pin is also used as INT external interrupt input pin INT3.	
P20-P27	I/O port P2	I/O	Port P2 is an 8-bit I/O port and has basically the same functions as port P0. The output structure is CMOS output. (See note)	
P30, P31	I/O port P3	I/O	Ports P30, P31 are a 2-bit I/O port and has basically the same functions as port P0. The output structure is CMOS output.	
P32/TIM2,	Input port P3	Input	Ports P32–P37 are a 6-bit input port and has basically the same functions as port P0.	
P33/TIM3,	External clock input	Input	Pins P32, P33 are also used as external clock input pins TIM2, TIM3 respectively.	
P34/INT1, P35/INT2/	External interrupt input	Input	Pins P34, P35 are also used as INT external interrupt input pins INT1, INT2 respectively.	
A-D4,	Analog input	Input	P35 pin is also used as analog input pin A-D4.	
P36/OSC1, P37/OSC2	Clock input for OSD display	Input	P36 pin is also used as OSD display clock input pin OSC1.	
	Clock output for OSD display	Output	P37 pin is also used as OSD display clock output pin OSC2. The output structure is CMOS output.	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Table 7.2 Pin Description (continued)

Pin	Name	Input/ Output	Functions
P40/SOUT(/IN)/ A-D7,	I/O port P4	I/O	Ports P40, P41 are a 2-bit I/O port and has basically the same functions as port P0. The output structure is N-channel open-drain output.
P41/SCLK/ A-D6,	Serial I/O data input/output	I/O	Pin P40 is also used as serial I/O data input/output pin SOUT(/IN). The output structure is N-channel open-drain output.
	Serial I/O synchronizing clock input/output	I/O	Pin P41 is also used as serial I/O synchronizing clock input/output pin Sclk. The output structure is N-channel open-drain output.
	Analog input pin	Input	Pin P40, P41 are also used as analog input pins A-D7, A-D6 respectively.
P42/SIN/	Input port P4	Input	Port P42 is a 1-bit input port and has basically the same functions as port P0.
A-D5,	Serial I/O data input	Input	Pin P42 is also used as serial I/O data input pin SIN.
	Analog input	Input	Pin P42 is also used as analog input pin A-D5.
P52/R, P53/G,	Output port P5	Output	Ports P52–P55 are a 4-bit output port and has basically the same functions as port P0. The output structure is CMOS output.
P54/B, P55/OUT1	OSD output	Output	Pins P52–P55 are also used as OSD output pins R, G, B, OUT1 respectively. The output structure is CMOS output.
P60PWM0- P63/PWM3	Output port P6	Output	Ports P60–P63 are a 4-bit I/O port and has basically the same functions as port P0. The output structure is N-channel open-drain output.
	PWM output	Output	Pins P60–P63 are also used as PWM output pins PWM0–PWM3 respectively. The output structure is N-channel open-drain output.
HSYNC	HSYNC input	Input	This is a horizontal synchronizing signal input for OSD.
VSYNC	VSYNC input	Input	This is a vertical synchronizing signal input for OSD.
DA	DA output	Output	This is a 14-bit PWM output pin.

Note: Port Pi (i = 0 to 3) has the port Pi direction register which can be used to program each bit as an input ("0") or an output ("1"). The pins programmed as "1" in the direction register are output pins. When pins are programmed as "0," they are input pins. When pins are programmed as output pins, the output data are written into the port latch and then output. When data is read from the output pins, the output pin level is not read but the data of the port latch is read. This allows a previously-output value to be read correctly even if the output "L" voltage has risen, for example, because a light emitting diode was directly driven. The input pins are in the floating state, so the values of the pins can be read. When data is written into the input pin, it is written only into the port latch, while the pin remains in the floating state.

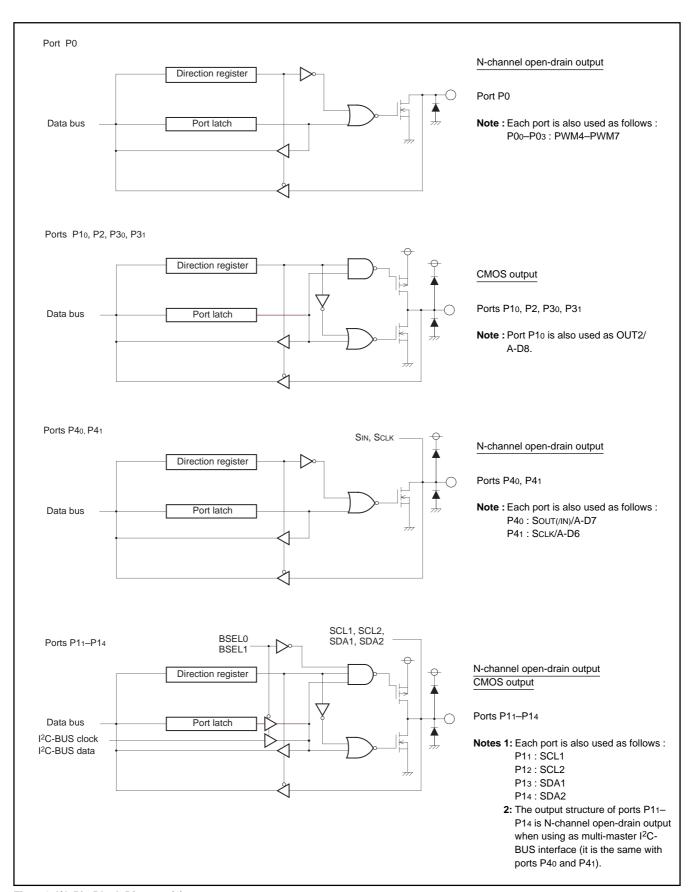


Fig. 7.1 I/O Pin Block Diagram (1)

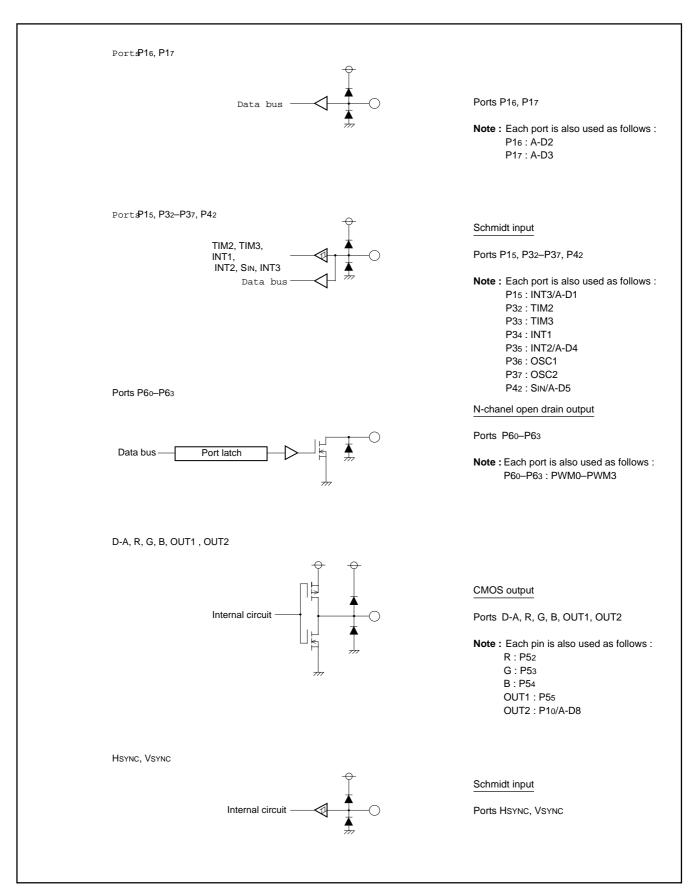


Fig. 7.2 I/O Pin Block Diagram (2)

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8. FUNCTIONAL DESCRIPTION 8.1 CENTRAL PROCESSING UNIT (CPU)

This microcomputer uses the standard 740 Family instruction set. Refer to the table of 740 Family addressing modes and machine instructions or the SERIES 740 <Software> User's Manual for details on the instruction set.

Machine-resident 740 Family instructions are as follows:

The FST. SLW instruction cannot be used.

The MUL, DIV, WIT and STP instructions can be used.

8.1.1 CPU Mode Register

The CPU mode register contains the stack page selection bit and internal system clock selection bit. The CPU mode register is allocated at address 00FB₁₆.

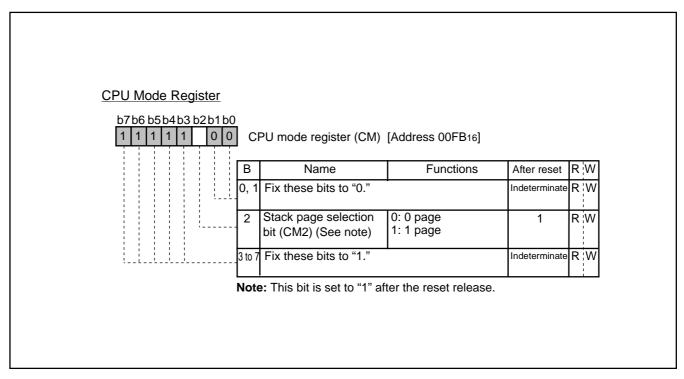


Fig. 8.1.1 CPU Mode Register

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.2 MEMORY

8.2.1 Special Function Register (SFR) Area

The special function register (SFR) area in the zero page contains control registers such as I/O ports and timers.

8.2.2 RAM

RAM is used for data storage and for stack area of subroutine calls and interrupts.

8.2.3 ROM

ROM is used for storing user programs as well as the interrupt vector area.

8.2.4 OSD RAM

RAM for display is used for specifying the character codes and colors to display.

8.2.5 OSD ROM

ROM for display is used for storing character data.

8.2.6 Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

8.2.7 Zero Page

The 256 bytes from addresses 000016 to 00FF16 are called the zero page area. The internal RAM and the special function registers (SFR) are allocated to this area.

The zero page addressing mode can be used to specify memory and register addresses in the zero page area. Access to this area with only 2 bytes is possible in the zero page addressing mode.

8.2.8 Special Page

The 256 bytes from addresses FF0016 to FFFF16 are called the special page area. The special page addressing mode can be used to specify memory addresses in the special page area. Access to this area with only 2 bytes is possible in the special page addressing mode.

8.2.9 ROM Correction Memory (RAM)

This is used as the program area for ROM correction.

Note: Only M37212M8-XXXSP and M37212EFSP/FP have ROM correction memory.

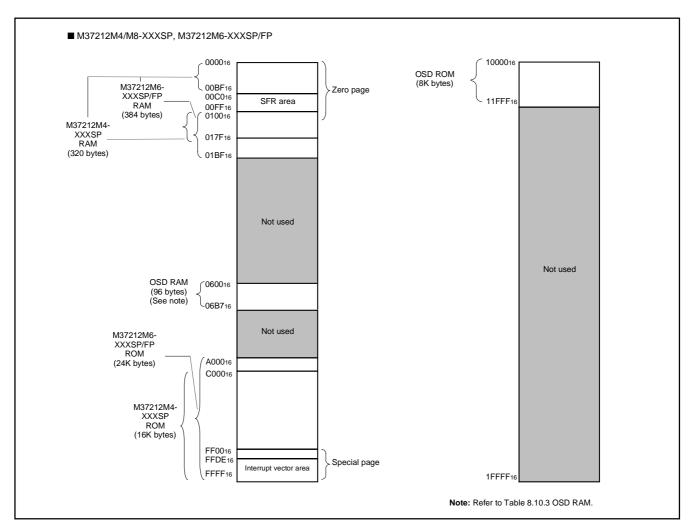


Fig. 8.2.1 Memory Map (M37212M4/M8-XXXSP, M37212M6-XXXSP/FP)



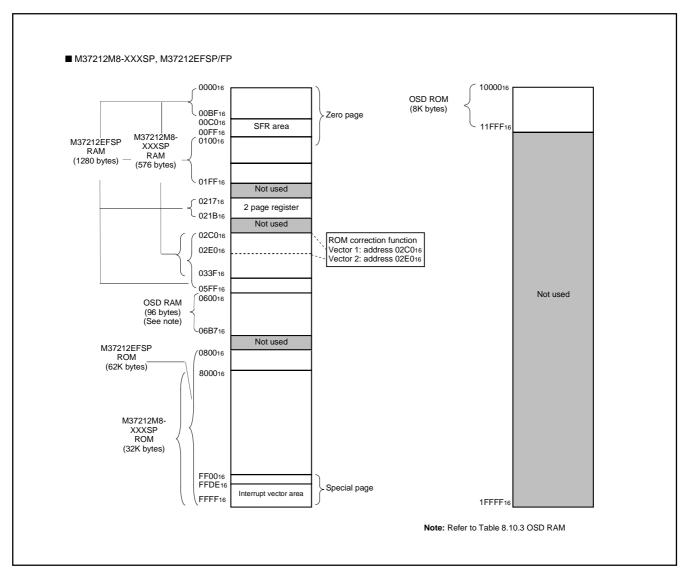


Fig. 8.2.2 Memory Map (M37212M8-XXXSP, M37212EFSP/FP)

■ SFR area (addresses C0 ₁₆ to DF ₁₆)				
·		e immediately after reset		
	[]: ₂	0" immediately after reset		
	Function bit	-		
	1: "	1" immediately after reset		
	: No function bit	Indeterminate immediately		
	O: Fix to this bit to "0" (do not write to "1")	after reset		
	1 : Fix to this bit to "1" (do not write to "0")			
Address Register		te immediately after reset		
	b7 b0 b7	b0		
C0 ₁₆ Port P0 (P0) C1 ₁₆ Port P0 direction register (D0)		? 0016		
C1 ₁₆ Port P0 direction register (D0) C2 ₁₆ Port P1 (P1)		?		
C316 Port P1 direction register (D1)		0016		
C4 ₁₆ Port P2 (P2)		?		
C5 ₁₆ Port P2 direction register (D2)		0016		
C6 ₁₆ Port P3 (P3)		?		
C7 ₁₆ Port P3 direction register (D3)	P31DP30D	0016		
C816 Port P4 (P4)	P41 P40 0	0 0 0 0 ? ? ?		
C9 ₁₆ Port P4 direction register (D4)	P41D P40D 0	0 0 0 0 ? ? ?		
CA ₁₆ Port P5 (P5)		0 ? ? ? ? 0 0		
CB ₁₆ Port P5 direction register (D5)	P55 P54 P53 P52 O O	0016		
CC ₁₆ Port P6 (P6)	P63 P62 P61 P60	0F16		
CD16	1 1 1 1	0F16		
CE ₁₆ DA-H register (DA-H)		?		
CF ₁₆ DA-L register (DA-L)		0 ? ? ? ? ? ? ?		
D016 PWM0 register (PWM0)		?		
D1 ₁₆ PWM1 register (PWM1)		?		
D2 ₁₆ PWM2 register (PWM2)		?		
D316 PWM3 register (PWM3)		?		
D4 ₁₆ PWM4 register (PWM4) D5 ₁₆ PWM output control register 1 (PW)	PW7 PW6 PW5 PW4 PW3 PW2 PW1 PW0	0016		
D616 PWM output control register 2 (PN)	PN4 PN3 PN2 PN1 PN0	0016		
l _	D7 D6 D5 D4 D3 D2 D1 D0	?		
D716 I ² C data shift register (S0) D816 I ² C address register (S0D)	SAD6 SAD5 SAD4 SAD3 SAD2 SAD1 SAD0RBW	0016		
D916 I ² C status register (S1)		0 0 1 0 0 0 ?		
DA16 I ² C control register (S1D)	BSEL1 BSEL0 10BIT ALS ESO BC2 BC1 BC0	0016		
DB ₁₆ I ² C clock control register (S2)	ACK ACK FAST CODA CODA CODA CODA	0016		
DC16 Serial I/O mode register (SM)	SM6 SM5 0 SM3 SM2 SM1 SM0	0016		
DD16 Serial I/O register (SIO)	0	?		
DE16		?		
DF16		?		

Fig. 8.2.3 Memory Map of Special Function Register (SFR) (1)



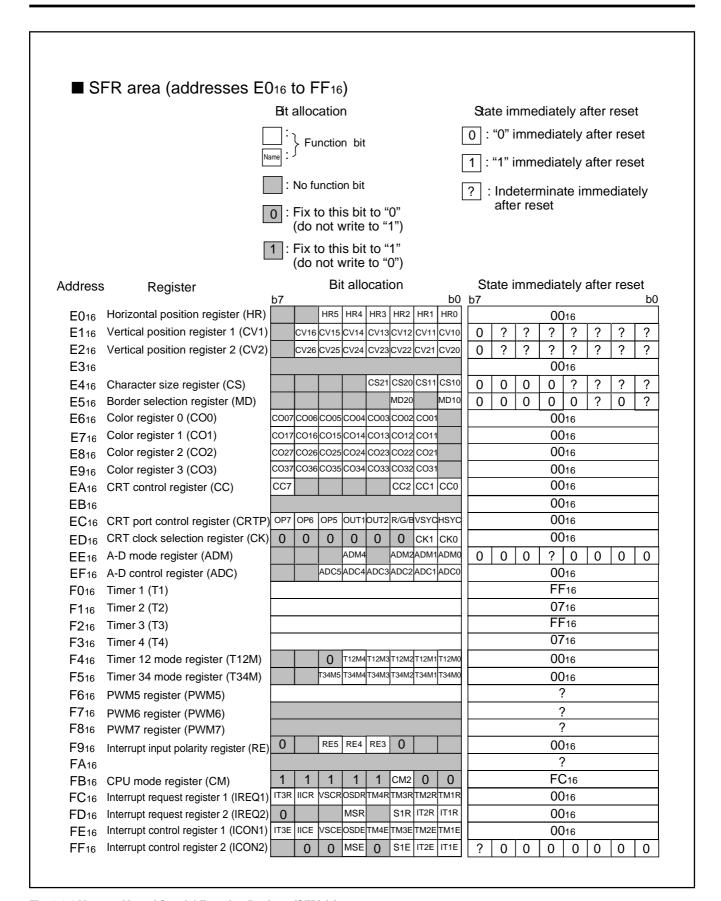


Fig. 8.2.4 Memory Map of Special Function Register (SFR) (2)



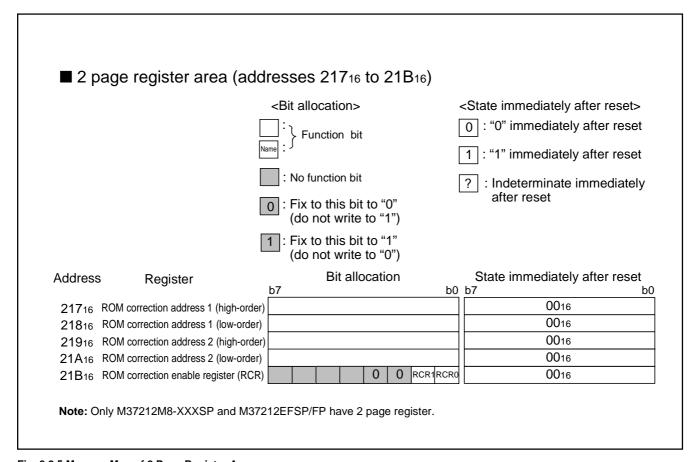


Fig. 8.2.5 Memory Map of 2 Page Register Area

	<bit allocation=""></bit>	<state after="" immediately="" reset=""></state>
	Function bit	0 : "0" immediately after reset 1 : "1" immediately after reset
	: No function bit	? : Indeterminate immediately
	O: Fix to this bit to "0" (do not write to "1")	after reset
	1: Fix to this bit to "1" (do not write to "0")	
Register	Bit allocation b7	State immediately after reset b0 b7 b0
Processor status register (PS) Program counter (PCH) Program counter (PCL)	N V T B D I	Z C ? ? ? ? ? 1 ? ? Contents of address FFFF16 Contents of address FFFE16

Fig. 8.2.6 Internal State of Processor Status Register and Program Counter at Reset

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.3 INTERRUPTS

Interrupts can be caused by 14 different sources consisting of 4 external, 8 internal, 1 software, and reset. Interrupts are vectored interrupts with priorities as shown in Table 8.3.1. Reset is also included in the table because its operation is similar to an interrupt.

When an interrupt is accepted,

- ① The contents of the program counter and processor status register are automatically stored into the stack.
- The interrupt disable flag I is set to "1" and the corresponding interrupt request bit is set to "0."
- ③ The jump destination address stored in the vector address enters the program counter.

Other interrupts are disabled when the interrupt disable flag is set to "1."

All interrupts except the BRK instruction interrupt have an interrupt request bit and an interrupt enable bit. The interrupt request bits are in interrupt request registers 1 and 2 and the interrupt enable bits are in interrupt control registers 1 and 2. Figures 8.3.2 to 8.3.6 show the interrupt-related registers.

Interrupts other than the BRK instruction interrupt and reset are accepted when the interrupt enable bit is "1," interrupt request bit is "1," and the interrupt disable flag is "0." The interrupt request bit can be set to "0" by a program, but not set to "1." The interrupt enable bit can be set to "0" and "1" by a program.

Reset is treated as a non-maskable interrupt with the highest priority. Figure 8.3.1 shows interrupt control.

8.3.1 Interrupt Causes

(1) VSYNC, OSD interrupts

The VSYNC interrupt is an interrupt request synchronized with the vertical sync signal.

The OSD interrupt occurs after character block display to the CRT is completed.

(2) INT1 to INT3 external interrupts

The INT1 to INT3 interrupts are external interrupt inputs, the system detects that the level of a pin changes from LOW to HIGH or from HIGH to LOW, and generates an interrupt request. The input active edge can be selected by bits 3 to 5 of the interrupt input polarity register (address 00F916): when this bit is "0," a change from LOW to HIGH is detected; when it is "1," a change from HIGH to LOW is detected. Note that both bits are cleared to "0" at reset.

(3) Timers 1 to 4 interrupts

An interrupt is generated by an overflow of timers 1 to 4.

Table 8.3.1 Interrupt Vector Addresses and Priority

Priority	Interrupt Source	Vector Addresses	Remarks
1	Reset	FFFF16, FFFE16	Non-maskable
2	OSD interrupt	FFFD16, FFFC16	
3	INT2 external interrupt	FFFB16, FFFA16	Active edge selectable
4	INT1 external interrupt	FFF916, FFF816	Active edge selectable
5	Timer 4 interrupt	FFF516, FFF416	
6	f(XIN)/4096 interrupt	FFF316, FFF216	
7	VSYNC interrupt	FFF116, FFF016	
8	Timer 3 interrupt	FFEF16, FFEE16	
9	Timer 2 interrupt	FFED16, FFEC16	
10	Timer 1 interrupt	FFEB16, FFEA16	
11	Serial I/O interrupt	FFE916, FFE816	
12	Multi-master I ² C-BUS interface interrupt	FFE716, FFE616	
13	INT3 external interrupt	FFE516, FFE416	Active edge selectable
14	BRK instruction interrupt	FFDF16, FFDE16	Non-maskable

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(4) Serial I/O interrupt

This is an interrupt request from the clock synchronous serial I/O function.

(5) f(XIN)/4096 interrupt

The f (XIN)/4096 interrupt occurs regularly with a f(XIN)/4096 period. Set bit 0 of PWM output control register 1 to "0."

(6) Multi-master I²C-BUS interface interrupt

This is an interrupt request related to the multi-master I^2C -BUS interface.

(7) BRK instruction interrupt

This software interrupt has the least significant priority. It does not have a corresponding interrupt enable bit, and it is not affected by the interrupt disable flag I (non-maskable).

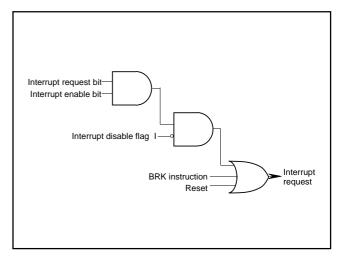


Fig. 8.3.1 Interrupt Control

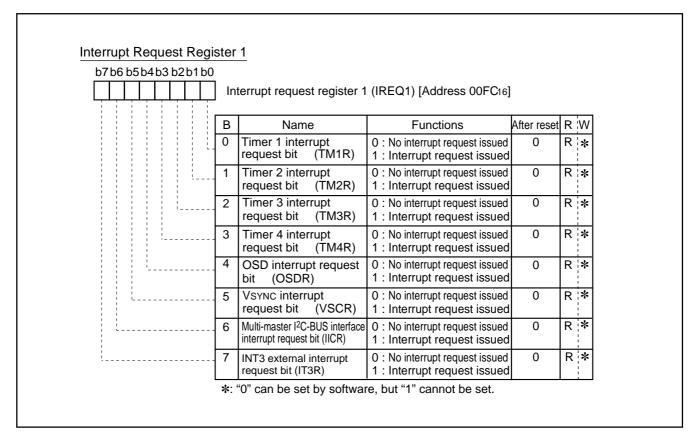


Fig. 8.3.2 Interrupt Request Register 1

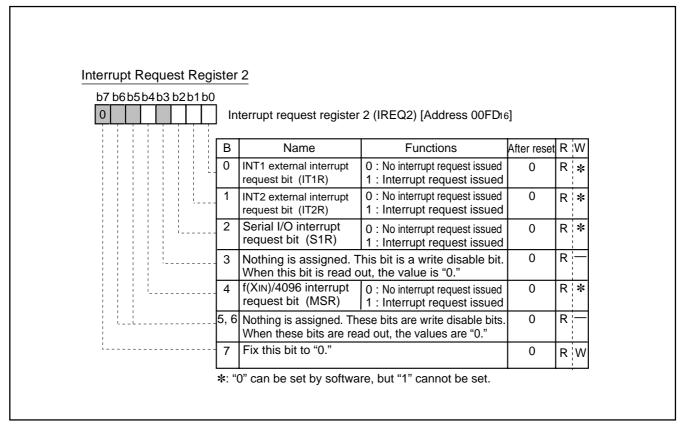


Fig. 8.3.3 Interrupt Request Register 2



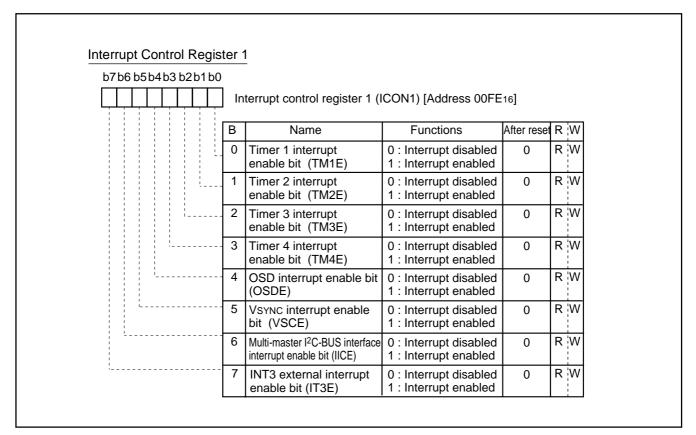


Fig. 8.3.4 Interrupt Control Register 1

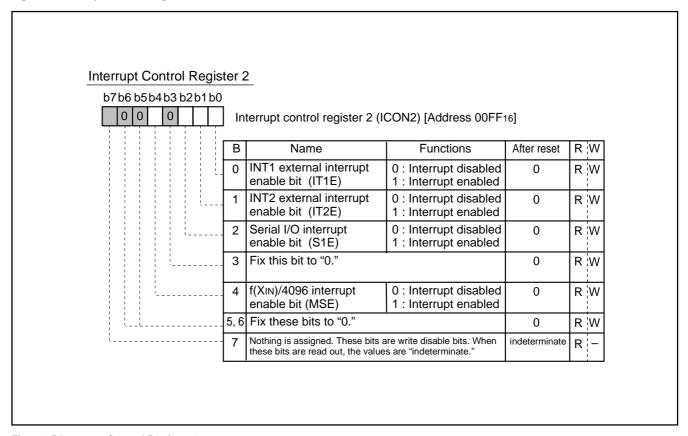


Fig. 8.3.5 Interrupt Control Register 2



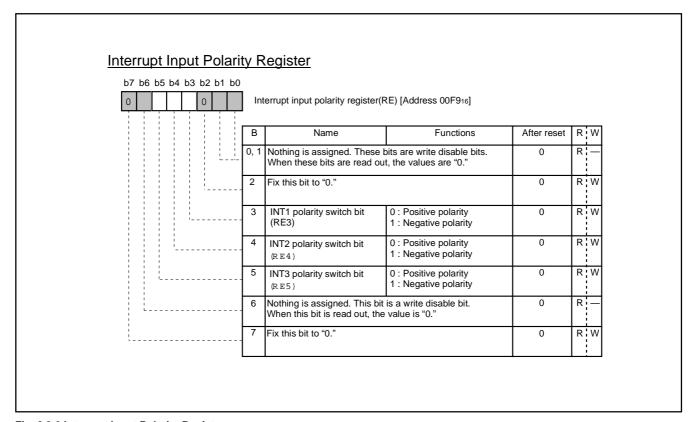


Fig. 8.3.6 Interrupt Input Polarity Register

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8.4 TIMERS

This microcomputer has 4 timers: timers 1 to 4. All timers are 8-bit timers with the 8-bit timer latch. The timer block diagram is shown in Figure 8.4.3.

All of the timers count down and their divide ratio is 1/(n+1), where n is the value of timer latch. By writing a count value to the corresponding timer latch (addresses 00F016 to 00F316: timers 1 to 4), the value is also set to a timer, simultaneously.

The count value is decremented by 1. The timer interrupt request bit is set to "1" by a timer overflow at the next count pulse, after the count value reaches "0016."

8.4.1 Timer 1

Timer 1 can select one of the following count sources:

- f(XIN)/16
- f(XIN)/4096

The count source of timer 1 is selected by setting bit 0 of timer 12 mode register 1 (address 00F416).

Timer interrupt request occurs at timer 1 overflow.

8.4.2 Timer 2

Timer 2 can select one of the following count sources:

- f(XIN)/16
- Timer 1 overflow signal
- External clock from the TIM2 pin

The count source of timer 2 is selected by setting bits 4 and 1 of timer 12 mode register (address 00F416). When timer 1 overflow signal is a count source for the timer 2, the timer 1 functions as an 8-bit prescaler.

Timer 2 interrupt request occurs at timer 2 overflow.

8.4.3 Timer 3

Timer 3 can select one of the following count sources:

- f(XIN)/16
- . External clock from the HSYNC pin
- External clock from the TIM3 pin

The count source of timer 3 is selected by setting bits 5 and 0 of timer 34 mode register (address 00F516).

Timer 3 interrupt request occurs at timer 3 overflow.

8.4.4 Timer 4

Timer 4 can select one of the following count sources:

- f(XIN)/16
- f(XIN)/2
- Timer 3 overflow signal

The count source of timer 3 is selected by setting bits 1 and 4 of timer 34 mode register (address 00F516). When timer 3 overflow signal is a count source for the timer 4, the timer 3 functions as an 8-bit prescaler.

Timer 4 interrupt request occurs at timer 4 overflow.

At reset, timers 3 and 4 are connected by hardware and "FF16" is automatically set in timer 3; "0716" in timer 4. The f(XIN)/16 is selected as the timer 3 count source. The internal reset is released by timer 4 overflow in this state and the internal clock is connected. At execution of the STP instruction, timers 3 and 4 are connected by hardware and "FF16" is automatically set in timer 3: "0716" in timer 4.

At execution of the STP instruction, timers 3 and 4 are connected by hardware and "FF16" is automatically set in timer 3; "0716" in timer 4. However, the f(XIN)/16 is not selected as the timer 3 count source. So set both bit 0 of timer 34 mode register (address 00F516) and bit 6 at address 00C716 to "0" before execution of the STP instruction (f(XIN)/16 is selected as the timer 3 count source). The internal STP state is released by timer 4 overflow in this state and the internal clock is connected.

As a result of the above procedure, the program can start under a stable clock.

The timer-related registers is shown in Figures 8.4.1 and 8.4.2.



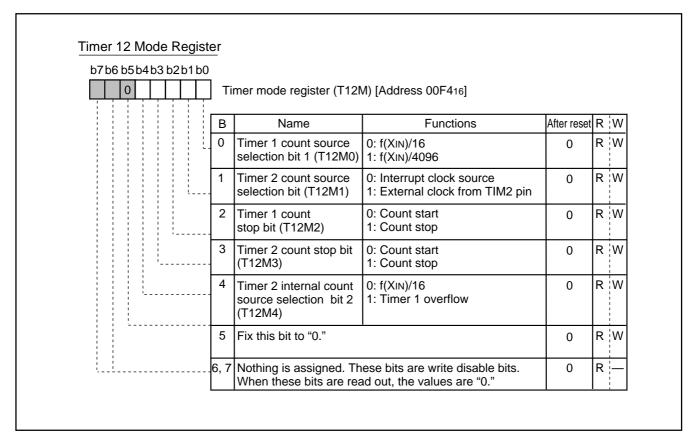


Fig. 8.4.1 Timer 12 Mode Register

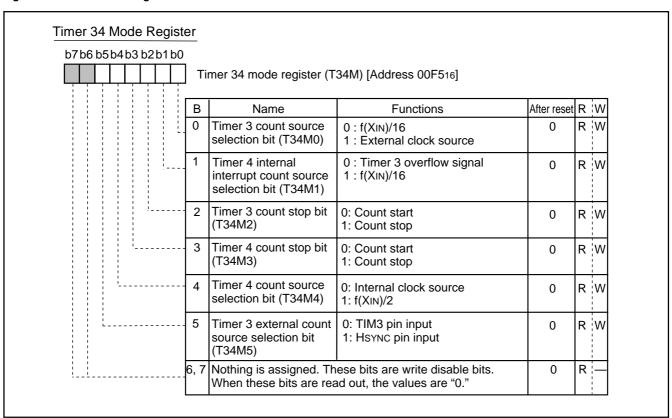


Fig. 8.4.2 Timer 34 Mode Register



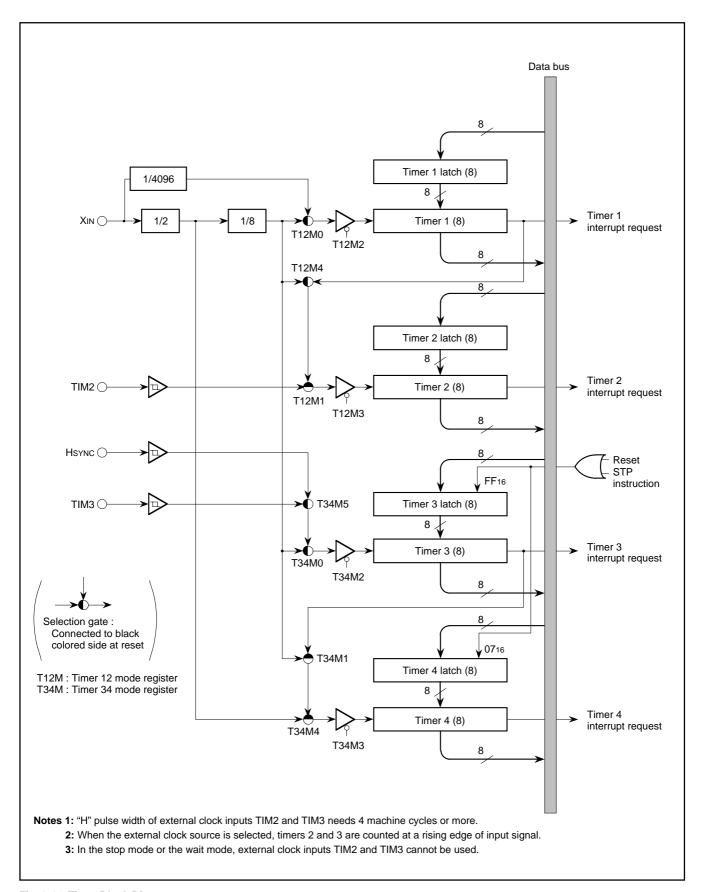


Fig. 8.4.3 Timer Block Diagram



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8.5 SERIAL I/O

This microcomputer has a built-in serial I/O which can either transmit or receive 8-bit data serially in the clock synchronous mode.

The serial I/O block diagram is shown in Figure 8.5.1. The synchronous clock I/O pin (SCLK), data output pin (SOUT), and data input pin (SIN) also functions as port P4.

Bit 3 of the serial I/O mode register (address 00DC16) selects whether the synchronous clock is supplied internally or externally (from the SCLK pin). When an internal clock is selected, bits 1 and 0 select whether f(XIN) or f(XCIN) is divided by 4, 16, 32, or 64. To use SIN pin for serial I/O, set the corresponding bit of the port P2 direction register (address 00C516) to "0."

The operation of the serial I/O is described below. The operation of the serial I/O differs depending on the clock source; external clock or internal clock.

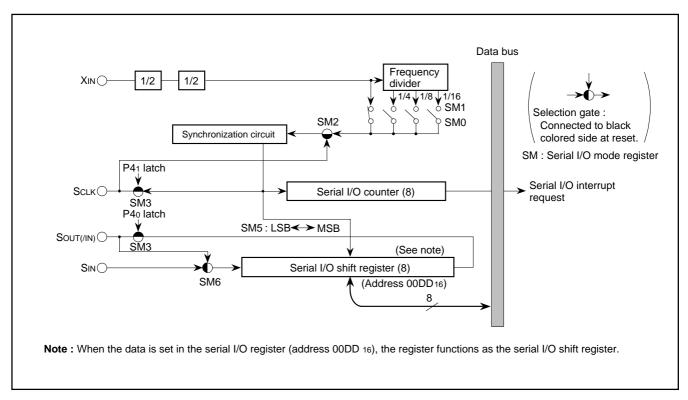


Fig. 8.5.1 Serial I/O Block Diagram

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Internal clock: The serial I/O counter is set to "7" during the write cycle into the serial I/O register (address 00DD16), and the transfer clock goes HIGH forcibly. At each falling edge of the transfer clock after the write cycle, serial data is output from the SOUT pin. Transfer direction can be selected by bit 5 of the serial I/O mode register. At each rising edge of the transfer clock, data is input from the SIN pin and data in the serial I/O register is shifted 1 bit.

After the transfer clock has counted 8 times, the serial I/O counter becomes "0" and the transfer clock stops at HIGH. At this time the interrupt request bit is set to "1."

External clock: The an external clock is selected as the clock source, the interrupt request is set to "1" after the transfer clock has been counted 8 counts. However, transfer operation does not stop, so the clock should be controlled externally. Use the external clock of 1 MHz or less with a duty cycle of 50%.

The serial I/O timing is shown in Figure 8.5.2. When using an external clock for transfer, the external clock must be held at HIGH for initializing the serial I/O counter. When switching between an internal clock and an external clock, do not switch during transfer. Also, be sure to initialize the serial I/O counter after switching.

- Notes 1: On programming, note that the serial I/O counter is set by writing to the serial I/O register with the bit managing instructions, such as SEB and CLB.
 - 2: When an external clock is used as the synchronous clock, write transmit data to the serial I/O register when the transfer clock input level is

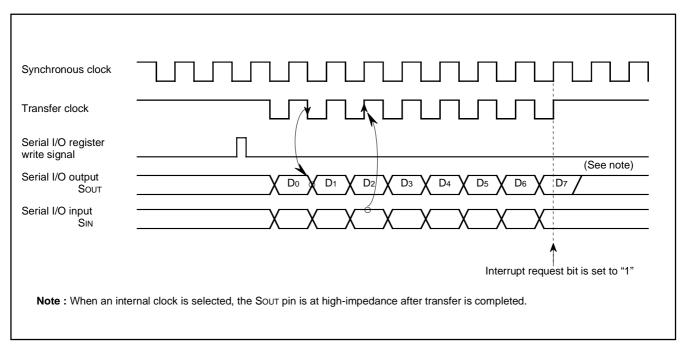


Fig. 8.5.2 Serial I/O Timing (for LSB first)



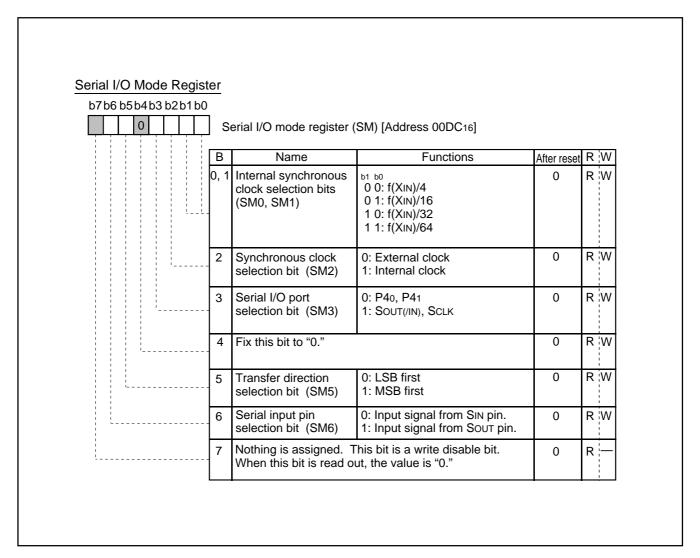


Fig. 8.5.3 Serial I/O Mode Register

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8.5.1 Serial I/O Common Transmission/Reception mode

By writing "1" to bit 6 of the serial I/O mode register, signals SIN and SOUT are switched internally to be able to transmit or receive the serial data

Figure 8.5.4 shows signals on serial I/O common transmission/reception mode.

Note: When receiving the serial data after writing "FF16" to the serial I/O register

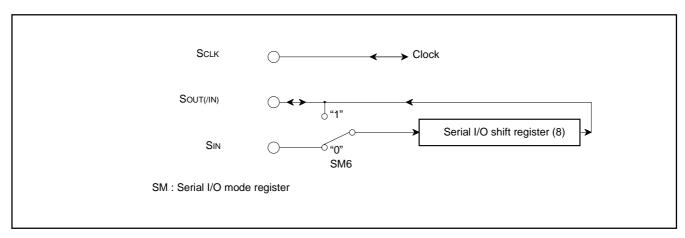


Fig. 8.5.4 Signals on Serial I/O Common Transmission/Reception Mode

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.6 MULTI-MASTER I²C-BUS INTERFACE

The multi-master I^2C -BUS interface is a serial communications circuit, conforming to the Philips I^2C -BUS data transfer format. This interface, offering both arbitration lost detection and a synchronous functions, is useful for the multi-master serial communications. Figure 8.6.1 shows a block diagram of the multi-master I^2C -BUS interface and Table 8.6.1 shows multi-master I^2C -BUS interface functions.

This multi-master I 2 C-BUS interface consists of the I 2 C address register, the I 2 C data shift register, the I 2 C clock control register, the I 2 C control register, the I 2 C status register and other control circuits.

Table 8.6.1 Multi-master I²C-BUS Interface Functions

Item	Function
Format	In conformity with Philips I ² C-BUS standard: 10-bit addressing format 7-bit addressing format High-speed clock mode Standard clock mode
Communication mode	In conformity with Philips I ² C-BUS standard: Master transmission Master reception Slave transmission Slave reception
SCL clock frequency	16.1 kHz to 400 kHz (at φ = 4 MHz)

 ϕ : System clock = f(XIN)/2

Note: We are not responsible for any third party's infringement of patent rights or other rights attributable to the use of the control function (bits 6 and 7 of the I²C control register at address 00DA16) for connections between the I²C-BUS interface and ports (SCL1, SCL2, SDA1, SDA2).

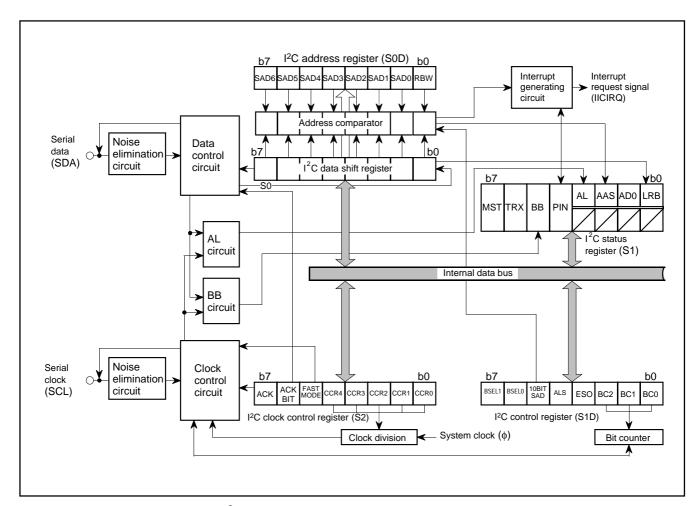


Fig. 8.6.1 Block Diagram of Multi-master I²C-BUS Interface

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8.6.1 I²C Data Shift Register

The I^2C data shift register (S0 : address 00D716) is an 8-bit shift register to store receive data and write transmit data.

When transmit data is written into this register, it is transferred to the outside from bit 7 in synchronization with the SCL clock, and each time one-bit data is output, the data of this register are shifted one bit to the left. When data is received, it is input to this register from bit 0 in synchronization with the SCL clock, and each time one-bit data is input, the data of this register are shifted one bit to the left.

The I^2C data shift register is in a write enable status only when the ESO bit of the I^2C control register (address 00DA16) is "1." The bit counter is reset by a write instruction to the I^2C data shift register. When both the ESO bit and the MST bit of the I^2C status register (address 00D916) are "1," the SCL is output by a write instruction to the I^2C data shift register. Reading data from the I^2C data shift register is always enabled regardless of the ESO bit value.

Note: To write data into the 1²C data shift register after setting the MST bit to "0" (slave mode), keep an interval of 8 machine cycles or more.

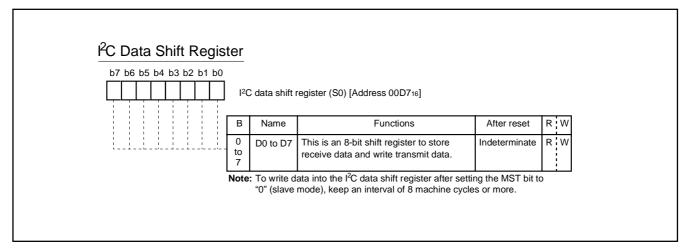


Fig. 8.6.2 Data Shift Register

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.6.2 I²C Address Register

The I^2C address register (address 00D816) consists of a 7-bit slave address and a read/write bit. In the addressing mode, the slave address written in this register is compared with the address data to be received immediately after the START condition are detected.

(1) Bit 0: read/write bit (RBW)

Not used when comparing addresses, in the 7-bit addressing mode. In the 10-bit addressing mode, the first address data to be received is compared with the contents (SAD6 to SAD0 + RBW) of the $\rm I^2C$ address register.

The RBW bit is cleared to "0" automatically when the stop condition is detected.

(2) Bits 1 to 7: slave address (SAD0-SAD6)

These bits store slave addresses. Regardless of the 7-bit addressing mode and the 10-bit addressing mode, the address data transmitted from the master is compared with the contents of these bits.

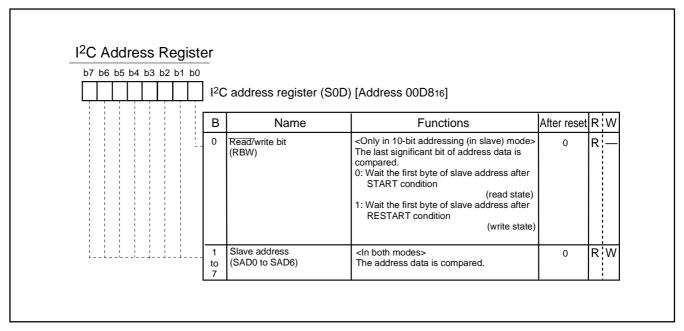


Fig. 8.6.3 I²C Address Register

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.6.3 I²C Clock Control Register

The I^2C clock control register (address 00DB16) is used to set ACK control, SCL mode and SCL frequency.

(1) Bits 0 to 4: SCL frequency control bits (CCR0–CCR4) These bits control the SCL frequency.

(2) Bit 5: SCL mode specification bit (FAST MODE)

This bit specifies the SCL mode. When this bit is set to "0," the standard clock mode is set. When the bit is set to "1," the high-speed clock mode is set.

(3) Bit 6: ACK bit (ACK BIT)

This bit sets the SDA status when an ACK clock* is generated. When this bit is set to "0," the ACK return mode is set and SDA goes to LOW at the occurrence of an ACK clock. When the bit is set to "1," the ACK non-return mode is set. The SDA is held in the HIGH status at the occurrence of an ACK clock.

However, when the slave address matches the address data in the reception of address data at ACK BIT = "0," the SDA is automatically made LOW (ACK is returned). If there is a mismatch between the slave address and the address data, the SDA is automatically made HIGH (ACK is not returned).

*ACK clock: Clock for acknowledgement

(4) Bit 7: ACK clock bit (ACK)

This bit specifies a mode of acknowledgment which is an acknowledgment response of data transmission. When this bit is set to "0," the no ACK clock mode is set. In this case, no ACK clock occurs after data transmission. When the bit is set to "1," the ACK clock mode is set and the master generates an ACK clock upon completion of each 1-byte data transmission. The device for transmitting address data and control data releases the SDA at the occurrence of an ACK clock (make SDA HIGH) and receives the ACK bit generated by the data receiving device.

Note: Do not write data into the 1²C clock control register during transmission. If data is written during transmission, the 1²C clock generator is reset, so that data cannot be transmitted normally.

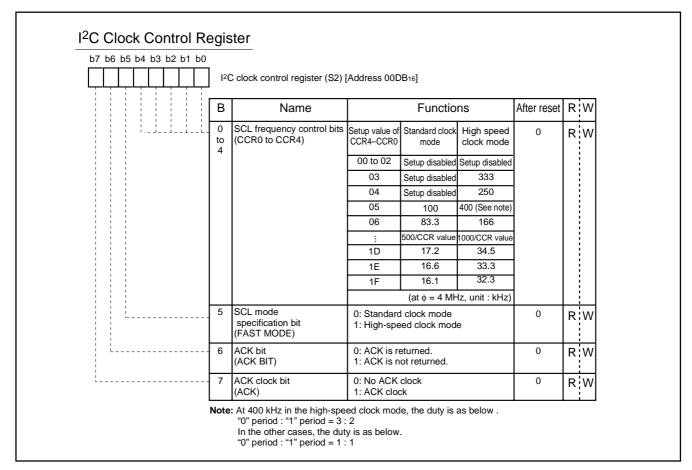


Fig. 8.6.4 I²C Address Register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.6.4 I²C Control Register

The I²C control register (address 00DA₁₆) controls the data communication format.

(1) Bits 0 to 2: bit counter (BC0-BC2)

These bits decide the number of bits for the next 1-byte data to be transmitted. An interrupt request signal occurs immediately after the number of bits specified with these bits are transmitted.

When a START condition is received, these bits become "0002" and the address data is always transmitted and received in 8 bits.

(2) Bit 3: I²C interface use enable bit (ESO)

This bit enables usage of the multimaster I²C BUS interface. When this bit is set to "0," the use disable status is provided, so the SDA and the SCL become high-impedance. When the bit is set to "1," use of the interface is enabled.

When ESO = "0," the following is performed.

- PIN = "1," BB = "0" and AL = "0" are set (they are bits of the I²C status register at address 00D916).
- Writing data to the I²C data shift register (address 00D716) is disabled.

(3) Bit 4: data format selection bit (ALS)

This bit decides whether or not to recognize slave addresses. When this bit is set to "0," the addressing format is selected, so that address data is recognized. When a match is found between a slave address and address data as a result of comparison or when a general call (refer to "8.6.5 I²C Status Register," bit 1) is received, transmission processing can be performed. When this bit is set to "1," the free data format is selected, so that slave addresses are not recognized

(4) Bit 5: addressing format selection bit (10BIT SAD)

This bit selects a slave address specification format. When this bit is set to "0," the 7-bit addressing format is selected. In this case, only the high-order 7 bits (slave address) of the I²C address register (address 00D816) are compared with address data. When this bit is set to "1," the 10-bit addressing format is selected, all the bits of the I²C address register are compared with address data.

(5) Bits 6 and 7: connection control bits between I²C-BUS interface and ports (BSEL0, BSEL1)

These bits controls the connection between SCL and ports or SDA and ports (refer to Figure 8.6.5).

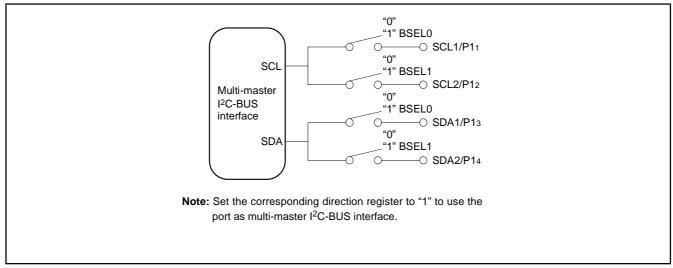


Fig. 8.6.5 Connection Port Control by BSEL0 and BSEL1



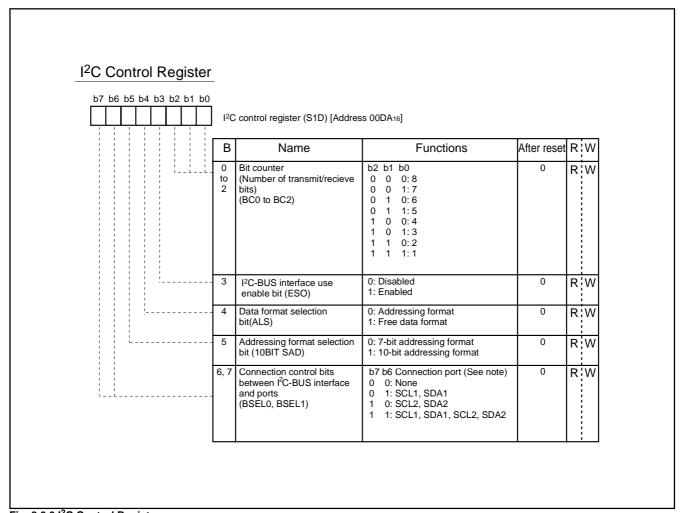


Fig. 8.6.6 I²C Control Register

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.6.5 I²C Status Register

The I^2C status register (address 00D916) controls the I^2C -BUS interface status. The low-order 4 bits are read-only bits and the high-order 4 bits can be read out and written to.

(1) Bit 0: last receive bit (LRB)

This bit stores the last bit value of received data and can also be used for ACK receive confirmation. If ACK is returned when an ACK clock occurs, the LRB bit is set to "0." If ACK is not returned, this bit is set to "1." Except in the ACK mode, the last bit value of received data is input. The state of this bit is changed from "1" to "0" by executing a write instruction to the $\rm I^2C$ data shift register (address 00D716).

(2) Bit 1: general call detecting flag (AD0)

This bit is set to "1" when a general call* whose address data is all "0" is received in the slave mode. By a general call of the master device, every slave device receives control data after the general call. The AD0 bit is set to "0" by detecting the STOP condition or START condition.

*General call: The master transmits the general call address "0016" to all slaves.

(3) Bit 2: slave address comparison flag (AAS)

This flag indicates a comparison result of address data.

- In the slave receive mode, when the 7-bit addressing format is selected, this bit is set to "1" in one of the following conditions.
 - The address data immediately after occurrence of a START condition matches the slave address stored in the high-order 7 bits of the I²C address register (address 00D816).
 - · A general call is received.
- In the slave reception mode, when the 10-bit addressing format is selected, this bit is set to "1" with the following condition.
 - When the address data is compared with the I²C address register (8 bits consists of slave address and RBW), the first bytes
- The state of this bit is changed from "1" to "0" by executing a write instruction to the I²C data shift register (address 00D716).

(4) Bit 3: arbitration lost* detecting flag (AL)

n the master transmission mode, when a device other than the microcomputer sets the SDA to "L,", arbitration is judged to have been lost, so that this bit is set to "1." At the same time, the TRX bit is set to "0," so that immediately after transmission of the byte whose arbitration was lost is completed, the MST bit is set to "0." When arbitration is lost during slave address transmission, the TRX bit is set to "0" and the reception mode is set. Consequently, it becomes possible to receive and recognize its own slave address transmitted by another master device.

*Arbitration lost: The status in which communication as a master is disabled

(5) Bit 4: I²C-BUS interface interrupt request bit (PIN)

This bit generates an interrupt request signal. Each time 1-byte data is transmitted, the state of the PIN bit changes from "1" to "0." At the same time, an interrupt request signal is sent to the CPU. The PIN bit is set to "0" in synchronization with a falling edge of the last clock (including the ACK clock) of an internal clock and an interrupt request signal occurs in synchronization with a falling edge of the PIN bit. When the PIN bit is "0," the SCL is kept in the "0" state and clock generation is disabled. Figure 8.6.8 shows an interrupt request signal generating timing chart.

The PIN bit is set to "1" in any one of the following conditions.

- Executing a write instruction to the I²C data shift register (address 00D7₁₆).
- When the ESO bit is "0"
- At reset

The conditions in which the PIN bit is set to "0" are shown below:

- Immediately after completion of 1-byte data transmission (including when arbitration lost is detected)
- · Immediately after completion of 1-byte data reception
- In the slave reception mode, with ALS = "0" and immediately after completion of slave address or general call address reception
- In the slave reception mode, with ALS = "1" and immediately after completion of address data reception

(6) Bit 5: bus busy flag (BB)

This bit indicates the status of use of the bus system. When this bit is set to "0," this bus system is not busy and a START condition can be generated. When this bit is set to "1," this bus system is busy and the occurrence of a START condition is disabled by the START condition duplication prevention function (See note).

This flag can be written by software only in the master transmission mode. In the other modes, this bit is set to "1" by detecting a START condition and set to "0" by detecting a STOP condition. When the ESO bit of the I²C control register (address 00DA16) is "0" and at reset, the BB flag is kept in the "0" state.

(7) Bit 6: communication mode specification bit (transfer direction specification bit: TRX)

This bit decides the direction of transfer for data communication. When this bit is "0," the reception mode is selected and the data of a transmitting device is received. When the bit is "1," the transmission mode is selected and address data and control data are output into the SDA in synchronization with the clock generated on the SCL.

When the ALS bit of the I^2C control register (address 00DA16) is "0" in the slave reception mode is selected, the TRX bit is set to "1" (transmit) if the least significant bit (R/ \overline{W} bit) of the address data transmitted by the master is "1." When the ALS bit is "0" and the R/ \overline{W} bit is "0," the TRX bit is cleared to "0" (receive).

The TRX bit is cleared to "0" in one of the following conditions.

- · When arbitration lost is detected.
- When a STOP condition is detected.
- When occurrence of a START condition is disabled by the START condition duplication prevention function (Note).
- With MST = "0" and when a START condition is detected.
- With MST = "0" and when ACK non-return is detected.
- At reset



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(8) Bit 7: Communication mode specification bit (master/slave specification bit: MST)

This bit is used for master/slave specification for data communication. When this bit is "0," the slave is specified, so that a START condition and a STOP condition generated by the master are received, and data communication is performed in synchronization with the clock generated by the master. When this bit is "1," the master is specified and a START condition and a STOP condition are generated, and also the clocks required for data communication are generated on the SCL.

The MST bit is cleared to "0" in one of the following conditions.

- Immediately after completion of 1-byte data transmission when arbitration lost is detected
- · When a STOP condition is detected.
- When occurrence of a START condition is disabled by the START condition duplication preventing function (Note).
- · At reset

Note: The START condition duplication prevention function disables the START condition generation, reset of bit counter reset, and SCL output, when the following condition is satisfied:

a START condition is set by another master device.

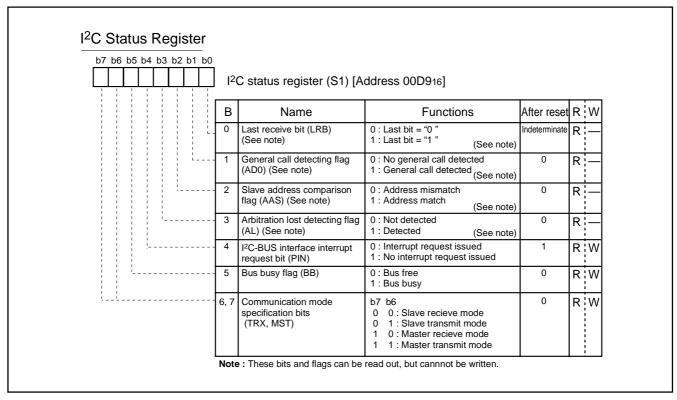


Fig. 8.6.7 I²C Status Register

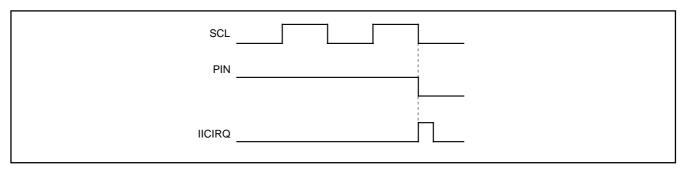


Fig. 8.6.8 Interrupt Request Signal Generation Timing



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8.6.6 START Condition Generation Method

When the ESO bit of the I²C control register (address 00DA16) is "1," execute a write instruction to the I²C status register (address 00D916) to set the MST, TRX and BB bits to "1." A START condition will then be generated. After that, the bit counter becomes "0002" and an SCL for 1 byte is output. The START condition generation timing and BB bit set timing are different in the standard clock mode and the high-speed clock mode. Refer to Figure 8.6.9 for the START condition generation timing diagram, and Table 8.6.2 for the START condition/STOP condition generation timing table.

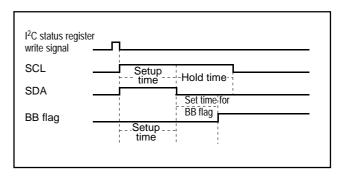


Fig. 8.6.9 START Condition Generation Timing Diagram

8.6.7 STOP Condition Generation Method

When the ESO bit of the I²C control register (address 00DA16) is "1," execute a write instruction to the I²C status register (address 00D916) for setting the MST bit and the TRX bit to "1" and the BB bit to "0". A STOP condition will then be generated. The STOP condition generation timing and the BB flag reset timing are different in the standard clock mode and the high-speed clock mode. Refer to Figure 8.6.10 for the STOP condition generation timing diagram, and Table 8.6.2 for the START condition/STOP condition generation timing table.

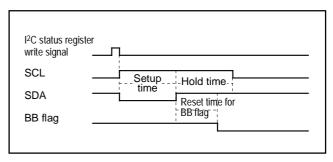


Fig. 8.6.10 STOP Condition Generation Timing Diagram

Table 8.6.2 START Condition/STOP Condition Generation Timing Table

Item	Standard Clock Mode	High-speed Clock Mode		
Setup time	F.O. (20 avalos)	2.5 μs (10 cycles)		
(START condition)	5.0 μs (20 cycles)			
Setup time	4.25 μs (17 cycles)	1.75 μs (7 cycles)		
(STOP condition)	4.25 μs (17 cycles)			
Hold time	5.0 μs (20 cycles)	2.5 μs (10 cycles)		
Set/reset time for BB flag	3.0 μs (12 cycles)	1.5 μs (6 cycles)		

Note: Absolute time at $\phi = 4$ MHz. The value in parentheses denotes the number of ϕ cycles.



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8.6.8 START/STOP Condition Detect Conditions

The START/STOP condition detect conditions are shown in Figure 8.6.11 and Table 8.6.3. Only when the 3 conditions of Table 8.6.3 are satisfied, a START/STOP condition can be detected.

Note: When a STOP condition is detected in the slave mode (MST = 0), an interrupt request signal "IICIRQ" is generated to the CPU.

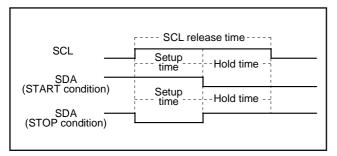


Fig. 8.6.11 START Condition/STOP Condition Detect Timing Diagram

Table 8.6.3 START Condition/STOP Condition Detect Conditions

Standard Clock Mode	High-speed Clock Mode
	-
6.5 μs (26 cycles) < SCL	1.0 μs (4 cycles) < SCL
release time	release time
Telease unite	lelease uille
0.05 (40 1) 0 ()	0.5 (0. 1.) 0.4 (1.
3.25 μs (13 cycles) < Setup time	0.5 μs (2 cycles) < Setup time
0.05 (40 1) 11.11.0	0.5 (0. 1.) 11.11.0
3.25 μs (13 cycles) < Hold time	0.5 μs (2 cycles) < Hold time

Note: Absolute time at ϕ = 4 MHz. The value in parentheses denotes the number of ϕ cycles.

8.6.9 Address Data Communication

There are two address data communication formats, namely, 7-bit addressing format and 10-bit addressing format. The respective address communication formats is described below.

(1) 7-bit addressing format

To meet the 7-bit addressing format, set the 10BIT SAD bit of the I^2C control register (address 00DA16) to "0." The first 7-bit address data transmitted from the master is compared with the high-order 7-bit slave address stored in the I^2C address register (address 00D816). At the time of this comparison, address comparison of the RBW bit of the I^2C address register (address 00D816) is not made. For the data transmission format when the 7-bit addressing format is selected, refer to Figure 8.6.12, (1) and (2).

(2) 10-bit addressing format

To meet the 10-bit addressing format, set the 10BIT SAD bit of the I^2C control register (address 00DA16) to "1." An address comparison is made between the first-byte address data transmitted from the master and the 7-bit slave address stored in the I^2C address register (address 00D816). At the time of this comparison, an address comparison between the RBW bit of the I^2C address register (address 00D816) and the R/\overline{W} bit which is the last bit of the address data transmitted from the master is made. In the 10-bit addressing mode, the R/\overline{W} bit which is the last bit of the address data not only specifies the direction of communication for control data but also is processed as an address data bit.

When the first-byte address data matches the slave address, the AAS bit of the I^2C status register (address 00D916) is set to "1." After the second-byte address data is stored into the I^2C data shift register (address 00D716), make an address comparison between the second-byte data and the slave address by software. When the address data of the 2nd bytes matches the slave address, set the RBW bit of the I^2C address register (address 00D816) to "1" by software. This processing can match the 7-bit slave address and R/\overline{W} data, which are received after a RESTART condition is detected, with the value of the I^2C address register (address 00D816). For the data transmission format when the 10-bit addressing format is selected, refer to Figure 8.6.12, (3) and (4).



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8.6.10 Example of Master Transmission

An example of master transmission in the standard clock mode, at the SCL frequency of 100 kHz and in the ACK return mode is shown below.

- ① Set a slave address in the high-order 7 bits of the I²C address register (address 00D816) and "0" in the RBW bit.
- ② Set the ACK return mode and SCL = 100 kHz by setting "8516" in the I²C clock control register (address 00DB16).
- Set "1016" in the I²C status register (address 00D916) and hold the
 SCI at the HIGH.
- Set a communication enable status by setting "4816" in the I²C control register (address 00DA16).
- Set the address data of the destination of transmission in the highorder 7 bits of the I²C data shift register (address 00D716) and set "0" in the least significant bit.
- ® Set "F016" in the I²C status register (address 00D916) to generate a START condition. At this time, an SCL for 1 byte and an ACK clock automatically occurs.
- $\ \$ Set transmit data in the I²C data shift register (address 00D716). At this time, an SCL and an ACK clock automatically occurs.
- Set "D016" in the I²C status register (address 00D916). After this, if
 ACK is not returned or transmission ends, a STOP condition will
 be generated.

8.6.11 Example of Slave Reception

An example of slave reception in the high-speed clock mode, at the SCL frequency of 400 kHz, in the ACK non-return mode, using the addressing format, is shown below.

- ① Set a slave address in the high-order 7 bits of the I²C address register (address 00D816) and "0" in the RBW bit.
- ② Set the no ACK clock mode and SCL = 400 kHz by setting "2516" in the I^2 C clock control register (address 00DB16).
- Set "1016" in the I²C status register (address 00D916) and hold the SCL at the HIGH.
- Set a communication enable status by setting "4816" in the I²C control register (address 00DA16).
- When a START condition is received, an address comparison is made.
- When all transmitted address are "0" (general call):
 AD0 of the I²C status register (address 00D916) is set to "1" and an interrupt request signal occurs.
 - •When the transmitted addresses match the address set in ①: ASS of the I²C status register (address 00D916) is set to "1" and an interrupt request signal occurs.
 - •In the cases other than the above:
 AD0 and AAS of the I²C status register (address 00D916) are set to "0" and no interrupt request signal occurs.
- © Set dummy data in the I²C data shift register (address 00D716).
- ® When receiving control data of more than 1 byte, repeat step ⑦.
- When a STOP condition is detected, the communication ends.

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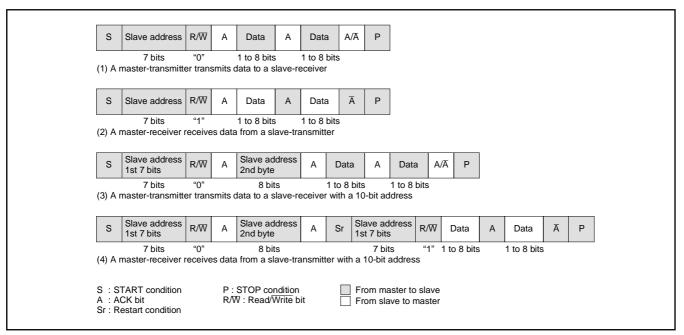


Fig. 8.6.12 Address Data Communication Format

8.6.12 Precautions when using multi-master I²C-BUS interface

(1) Read-modify-write instruction

The precautions when the raead-modify-write instruction such as SEB, CLB etc. is executed for each register of the multi-master I²C-BUS interface are described below.

•I2C data shift register (S0)

When executing the read-modify-write instruction for this register during transfer, data may become a value not intended.

•I²C address register (S0D)

When the read-modify-write instruction is executed for this register at detecting the STOP condition, data may become a value not intended. It is because hardware changes the read/write bit (RBW) at the above timing.

•I²C status register (S1)

Do not execute the read-modify-write instruction for this register because all bits of this register are changed by hardware.

•I²C control register (S1D)

When the read-modify-write instruction is executed for this register at detecting the START condition or at completing the byte transfer, data may become a value not intended. Because hardware changes the bit counter (BC0–BC2) at the above timing.

•I²C clock control register (S2)

The read-modify-write instruction can be executed for this register.

(2) START condition generating procedure using multi-master

①Procedure example (The necessary conditions of the generating procedure are described as the following ② to ⑤).

•

LDA — (Taking out of slave address value)

SEI (Interrupt disabled)

BBS 5,S1,BUSBUSY (BB flag confirming and branch process)

BUSFREE:

STA S0 (Writing of slave address value)
LDM #\$F0, S1 (Trigger of START condition generating)

CLI (Interrupt enabled)

•

•

BUSBUSY:

CLI (Interrupt enabled)

•

•

②Use "STA," "STX" or "STY" of the zero page addressing instruction for writing the slave address value to the I²C data shift register.

Suse "LDM" instruction for setting trigger of START condition generating.

Write the slave address value of above ② and set trigger of START condition generating of above ③ continuously shown the above procedure example.

©Disable interrupts during the following three process steps:

- · BB flag confirming
- Writing of slave address value
- Trigger of START condition generating

When the condition of the BB flag is bus busy, enable interrupts immediately.



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(3) RESTART condition generating procedure

①Procedure example (The necessary conditions of the generating procedure are described as the following ② to ⑥.)

Execute the following procedure when the PIN bit is "0."

#\$00, S1 (Select slave receive mode) (Taking out of slave address value) (Interrupt disabled) SO (Writing of slave address value) #\$F0, S1 (Trigger of RESTART condition generating)

CH (Interrupt enabled)

LDM

LDA

SEI

STA

LDM

@Select the slave receive mode when the PIN bit is "0." Do not write "1" to the PIN bit. Neither "0" nor "1" is specified for the writing to

The TRX bit becomes "0" and the SDA pin is released.

- 3 The SCL pin is released by writing the slave address value to the I²C data shift register. Use "STA," "STX" or "STY" of the zero page addressing instruction for writing.
- **(4)** Use "LDM" instruction for setting trigger of RESTART condition gen-
- ®Write the slave address value of above 3 and set trigger of RE-START condition generating of above 4 continuously shown the above procedure example.
- ®Disable interrupts during the following two process steps:
 - · Writing of slave address value
 - Trigger of RESTART condition generating

(4) STOP condition generating procedure

①Procedure example (The necessary conditions of the generating procedure are described as the following 2 to 4.)

SEI (Interrupt disabled)

(Select master transmit mode) LDM #\$C0. S1

NOP (Set NOP)

LDM #\$D0, S1 (Trigger of STOP condition generating)

CLI (Interrupt enabled)

@Write "0" to the PIN bit when master transmit mode is select.

®Execute "NOP" instruction after setting of master transmit mode. Also, set trigger of STOP condition generating within 10 cycles after selecting of master trasmit mode.

Disable interrupts during the following two process steps:

- Select of master transmit mode
- Trigger of STOP condition generating

(5) Writing to I²C status register

Do not execute an instruction to set the PIN bit to "1" from "0" and an instruction to set the MST and TRX bits to "0" from "1" simultaneously. It is because it may enter the state that the SCL pin is released and the SDA pin is released after about one machine cycle. Do not execute an instruction to set the MST and TRX bits to "0" from "1" simultaneously when the PIN bit is "1." It is because it may become the same as above.

(6) Process of after STOP condition generating

Do not write data in the I²C data shift register S0 and the I²C status register S1 until the bus busy flag BB becomes "0" after generating the STOP condition in the master mode. It is because the STOP condition waveform might not be normally generated. Reading to the above registers do not have the problem.



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8.7 PWM OUTPUT FUNCTION

This microcomputer is equipped with two 14-bit PWM (DA) and eight 8-bit PWMs (PWM0–PWM7). DA1 and DA2 have a 14-bit resolution with the minimum resolution bit width of 0.25 μ s and a repeat period of 4096 μ s (for f(XIN) = 8 MHz). PWM0–PWM7 have the same circuit structure and an 8-bit resolution with minimum resolution bit width of 4 μ s and repeat period of 1024 μ s (for f(XIN) = 8 MHz).

Figure 8.7.1 shows the PWM block diagram. The PWM timing generating circuit applies individual control signals to DA and PWM0–PWM7 using f(XIN) divided by 2 as a reference signal.

8.7.1 Data Setting

When outputting DA, first set the high-order 8 bits to the DA-H register (address 00CE16), then the low-order 6 bits to the DA-L register (address 00CF16). When outputting PWM0–PWM7, set 8-bit output data to the PWMi register (i means 0 to 7; addresses 00D016 to 00D416, 00F616 to 00F816).

8.7.2 Transferring Data from Registers to PWM Circuit

Data transfer from the 8-bit PWM register to the 8-bit PWM circuit is executed at writing data to the register.

The signal output from the 8-bit PWM output pin corresponds to the contents of this register.

Also, data transfer from the DA register (addresses 00CE16 and 00CF16) to the 14-bit PWM circuit is executed at writing data to the DA-L register (address 00CF16). Reading from the DA-H register (address 00CE16) means reading this transferred data. Accordingly, it is possible to confirm the data being output from the DA output pin by reading the DA register.

8.7.3 Operating of 8-bit PWM

The following explains PWM operation.

First, set the bit 0 of PWM output control register 1 (address 00D516) to "0" (at reset, bit 0 is already set to "0" automatically), so that the PWM count source is supplied.

PWM0–PWM3 are also used as pins P60–P63, PWM4–PWM7 are also used as ports P00–P03, respectively. For PWM0–PWM3, set the corresponding bits of the ports P6 direction register to "1" (output mode). For PWM4–PWM7, set those of the port P0 direction register to "1." And select each output polarity by bit 3 of PWM output control register 2 (address 00D616). Then, for PWM0–PWM5, set bits 2 to 7 of PWM output control register 1 to "1" (PWM output). For PWM6 and PWM7, set bits 0 and 1 of PWM output control register 2 to "1."

The PWM waveform is output from the PWM output pins by setting these registers.

Figure 8.7.2 shows the 8-bit PWM timing. One cycle (T) is composed of 256 (2⁸) segments. The 8 kinds of pulses, relative to the weight of each bit (bits 0 to 7), are output inside the circuit during 1 cycle. Refer to Figure 8.7.2 (a). The 8-bit PWM outputs waveform which is the logical sum (OR) of pulses corresponding to the contents of bits 0 to 7 of the 8-bit PWM register. Several examples are shown in Figure 8.7.2 (b). 256 kinds of output (HIGH area: 0/256 to 255/256) are selected by changing the contents of the PWM register. A length of entirely HIGH output cannot be output, i.e. 256/256.

8.7.4 Operating of 14-bit PWM

As with 8-bit PWM, set the bit 0 of PWM output control register 1 (address 00D516) to "0" (at reset, bit 0 is already set to "0" automatically), so that the PWM count source is supplied. Next, select the output polarity by bit 2 of PWM output control register 2 (address 00D616). Then, the 14-bit PWM outputs from the DA output pin by setting bit 1 of PWM output control register 1 to "0" (at reset, this bit already set to "0" automatically) to select the DA output.

The output example of the 14-bit PWM is shown in Figure 8.7.3.

The 14-bit PWM divides the data of the DA latch into the low-order 6 bits and the high-order 8 bits.

The fundamental waveform is determined with the high-order 8-bit data "DH." A HIGH area with a length t X DH (HIGH area of fundamental waveform) is output every short area of "t" = 256τ = $64~\mu s$ (τ is the minimum resolution bit width of 250 ns). The HIGH level area increase interval (tm) is determined with the low-order 6-bit data "DL." The HIGH are of smaller intervals "tm" shown in Table 5 is longer by t than that of other smaller intervals in PWM repeat period "T" = 64t. Thus, a rectangular waveform with the different HIGH width is output from the DA pins. Accordingly, the PWM output changes by τ unit pulse width by changing the contents of the DA-H and DA-L registers. A length of entirely HIGH cannot be output, i. e. 256/256.

8.7.5 Output after Reset

At reset, the output of ports P60–P63 and P00–P03 are in the high-impedance state, and the contents of the PWM register and the PWM circuit are undefined. Note that after reset, the PWM output is undefined until setting the PWM register.

Table 8.7.1 Relation Between the Low-order 6-bit Data and Highlevel Area Increase Interval

Low-order 6 bits of Data	Area Longer by τ than That of Other tm (m = 0 to 63)
00000	Nothing
000001	m = 32
000010	m = 16, 48
000100	m = 8, 24, 40, 56
001000	m = 4, 12, 20, 28, 36, 44, 52, 60
010000	m = 2, 6, 10, 14, 18, 22, 26, 30, 34, 38, 42, 46, 50, 54, 58, 62
100000	m = 1, 3, 5, 7, 57, 59, 61, 63



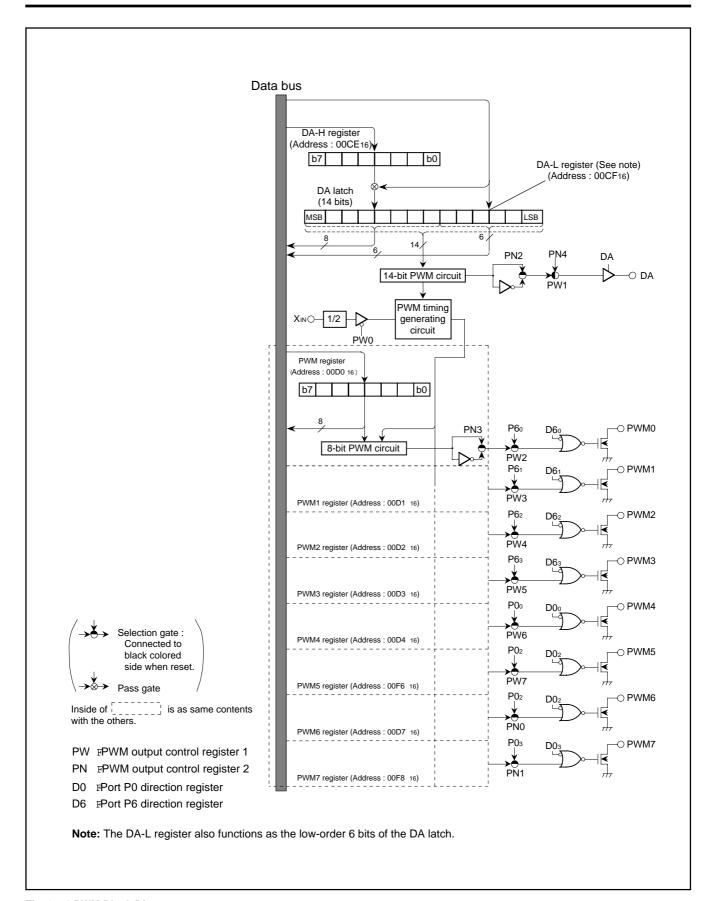


Fig. 8.7.1 PWM Block Diagram

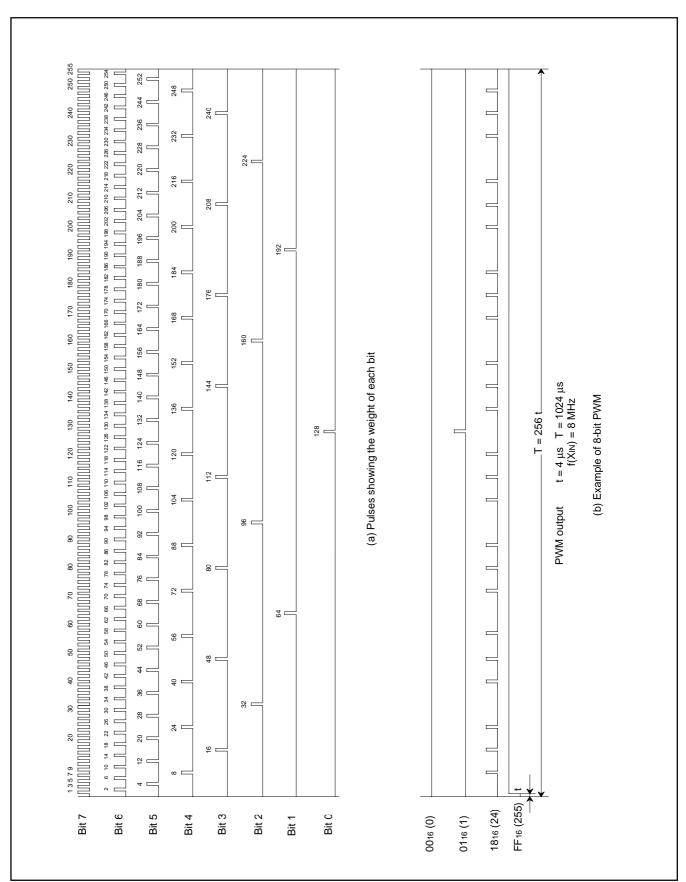


Fig. 8.7.2 PWM Timing



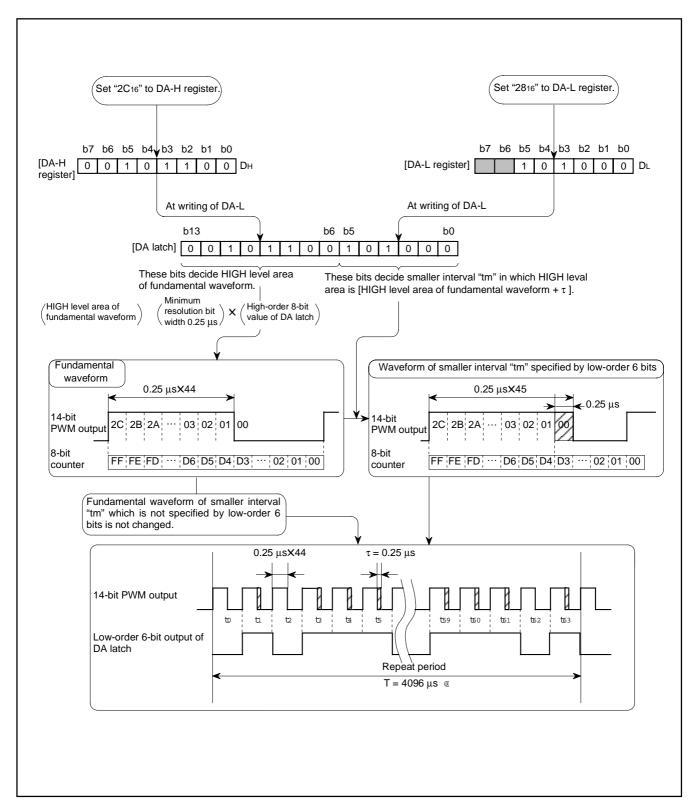


Fig. 8.7.3 14-bit PWM Timing (f(XIN) = 8 MHz)

b7b6b5	o7 b6 b5 b4 b3 b2 b1 b0							
	PWM output control register 1 (PW) [Address 00D516]							
						_		
			В	Name	Functions	After reset	R	W
			0	DA, PWM count source selection bit (PW0)	0 : Count source supply 1 : Count source stop	0	R	W
			1	DA/PN4 selection bit (PW1)	0 : DA output 1 : PN4 output	0	R	W
			2	P60/PWM0 output selection bit (PW2)	0: P60 output 1: PWM0 output	0	R	W
			3	P61/PWM1 output selection bit (PW3)	0: P61 output 1: PWM1 output	0	R	W
			4	P62/PWM2 output selection bit (PW4)	0: P62 output 1: PWM2 output	0	R	W
			5	P63/PWM3 output selection bit (PW5)	0: P63 output 1: PWM3 output	0	R	W
			6	P0o/PWM4 output selection bit (PW6)	0: P0o output 1: PWM4 output	0	R	W
į !			7	P01/PWM5 output selection bit (PW7)	0: P01 output 1: PWM5 output	0	R	W

Fig. 8.7.4 PWM Output Control Register 1

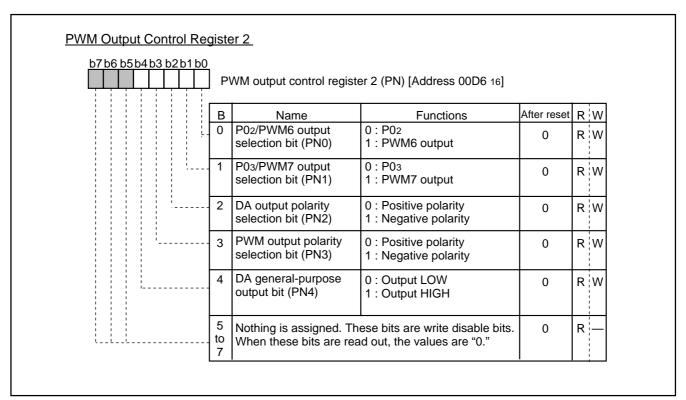


Fig. 8.7.5 PWM Output Control Register 2



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8.8 A-D COMPARATOR

A-D comparator consists of 6-bit D-A converter and comparator. A-D comparator block diagram is shown in Figure 8.8.1.

The reference voltage "Vret" for D-A conversion is set by bits 0 to 5 of the A-D control register (address 00EF16).

The comparison result of the analog input voltage and the reference voltage "Vref" is stored in bit 4 of the A-D mode register (address 00EE16).

For A-D comparison, set "0" to corresponding bits of the direction register to use ports as analog input pins. Write the data for select of analog input pins to bits 0 to 2 of the A-D control register 1 and write the digital value corresponding to Vref to be compared to the bits 0 to 5 of the A-D control register. The voltage comparison starts by writing to the A-D control register 2, and it is completed after 16 machine cycles (NOP instruction X 8).

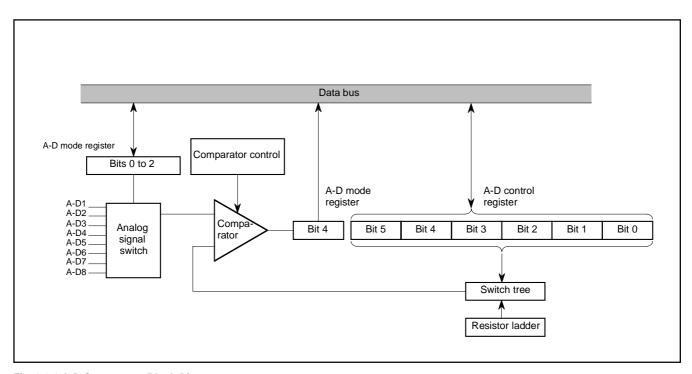


Fig. 8.8.1 A-D Comparator Block Diagram

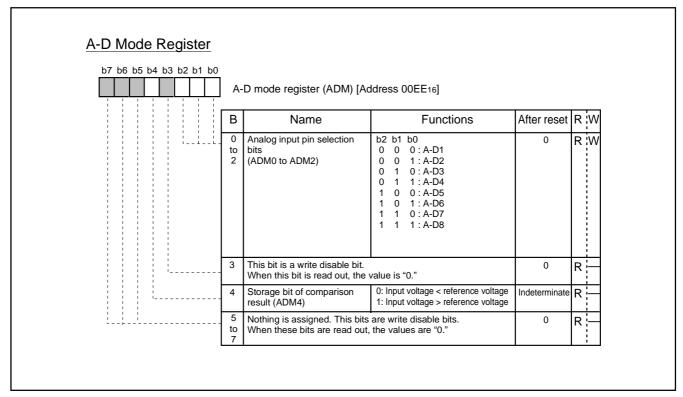


Fig. 8.8.2 A-D Mode Register

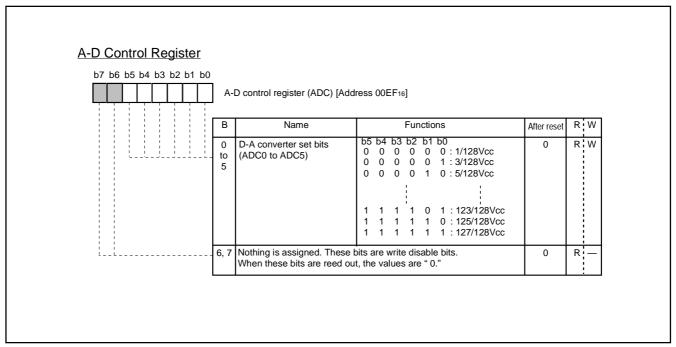


Fig. 8.8.3 A-D Control Register



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8.9 ROM CORRECTION FUNCTION

This can correct program data in ROM. Up to 2 addresses can be corrected, a program for correction is stored in the ROM correction memory in RAM as the top address. The ROM correction vectors are 2 vectors.

Vector 1 : address 02C016 Vector 2 : address 02E016

Set the address of the ROM data to be corrected into the ROM correction address register. When the value of the counter matches the ROM data address in the ROM correction vector as the top address, the main program branches to the correction program stored in the ROM memory for correction. To return from the correction program to the main program, the op code and operand of the JMP instruction (total of 3 bytes) are necessary at the end of the correction program. The ROM correction function is controlled by the ROM correction enable register.

Notes 1: Specify the first address (op code address) of each instruction as the ROM correction address.

- 2: Use the JMP instruction (total of 3 bytes) to return from the correction program to the main program.
- 3: Do not set the same ROM correction address to vectors 1 and 2.
- 4: Only M37212M8-XXXSP and M37212EFSP/FP have ROM correction function.

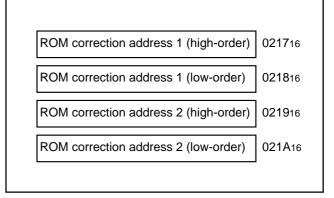


Fig. 8.9.1 ROM Correction Address Registers

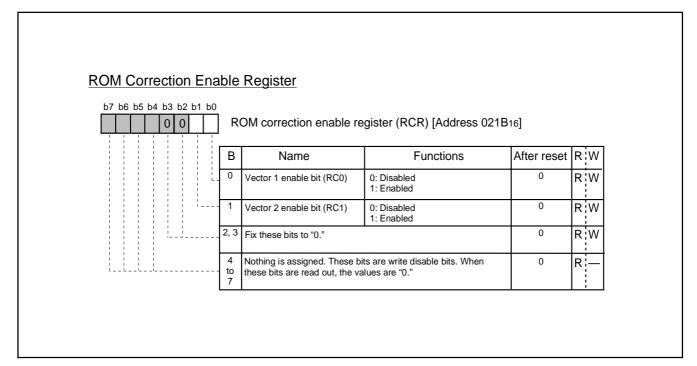


Fig. 8.9.2 ROM Correction Enable Register



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8.10 OSD FUNCTIONS

Table 8.10.1 outlines the OSD functions. This microcomputer incorporates an OSD control circuit of 24 characters X 2 lines. OSD is controlled by the CRT control register. Up to 256 kinds of characters can be displayed. The colors can be specified for each character and up to 4 kinds of colors can be displayed on one screen. A combination of up to 8 colors can be obtained by using each output signal (R, G, and B).

Characters are displayed in a 12 X 16 dots configuration to obtain smooth character patterns (refer to Figure 8.10.1).

The following shows the procedure how to display characters on the CRT screen.

- ① Write the display character code in OSD RAM.
- ② Specify the display color by using the color register.
- Write the color register in which the display color is set in OSD RAM.
- Specify the vertical position by using the vertical position register.
- ⑤ Specify the character size by using the character size register.
- ® Specify the horizontal position by using the horizontal position register.
- Write the display enable bit to the designated block display flag of the CRT control register. When this is done, the OSD starts according to the input of the VSYNC signal.

Table 8.10.1 Features of Each Display Mode

_	
Parameter	Functions
Number of display characters	24 characters X 2 lines
Dot structure	12 X 16 dots
Kinds of characters	256 kinds
Kinds of character sizes	3 kinds
Attribute	Border (black)
Character font coloring	1 screen : 8 kinds (per character unit)
Character background coloring	1 screen : 8 kinds (per character unit)
OSD output	R, G, B
Display position	Horizontal: 64 levels, Vertical: 128 levels
Display expansion (multiline display)	Possible



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The OSD circuit has an extended display mode. This mode allows multiple lines (3 lines or more) to be displayed on the screen by interrupting the display each time one line is displayed and rewriting data in the block for which display is terminated by software.

Figure 8.10.1 shows the configuration of OSD character. Figure 8.10.2 shows the block diagram of the OSD circuit. Figure 8.10.3 shows the CRT control register.

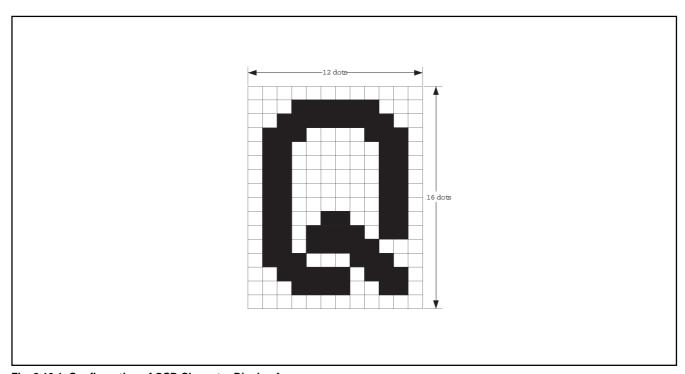


Fig. 8.10.1 Configuration of OSD Character Display Area

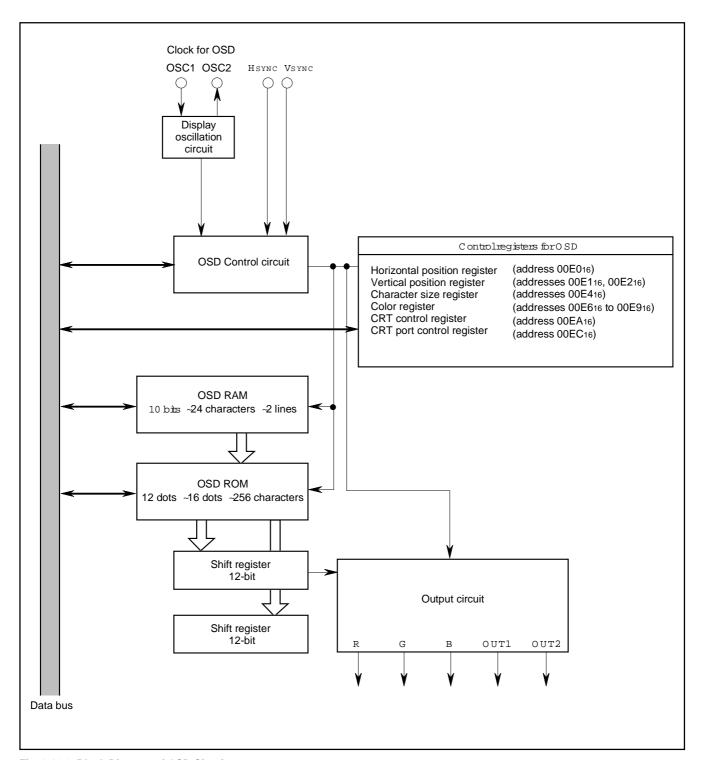


Fig. 8.10.2 Block Diagram of OSD Circuit

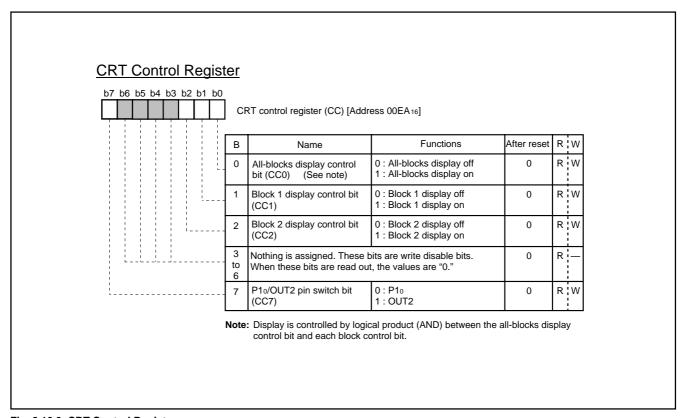


Fig. 8.10.3 CRT Control Register

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8.10.1 Display Position

The display positions of characters are specified in units called a "block." There are 2 blocks, blocks 1 and 2. Up to 24 characters can be displayed in each block (refer to "8.10.3 Memory for OSD").

The display position of each block can be set in both horizontal and vertical directions by software.

The display start position in the horizontal direction can be selected for all blocks in common from 64-step display positions in units of 4Tc (Tc = OSD oscillation cycle).

The display start position in the vertical direction for each block can be selected from 128-step display positions in units of 4 scanning lines.

Blocks are displayed in conformance with the following rules:

- Block 2 is displayed after the display of block 1 is completed (Figure 8.10.4 (a)).
- When the display position of block 1 is overlapped with that of block
 2 (Figure 8.10.4 (b)), the block 1 is displayed on the front.
- When another block display position appears while one block is displayed (Figure 8.10.4 (c)), only block 1 is displayed. Similarly, when multiline display, block 1 is displayed after the display of block 2 is completed.

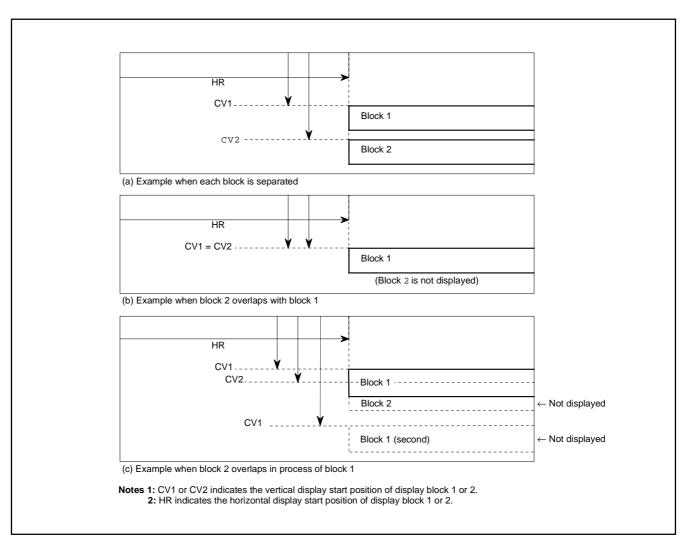


Fig. 8.10.4 Display Position

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The vertical display start position is determined by counting the horizontal sync signal (HSYNC). At this time, when VSYNC and HSYNC are positive polarity (negative polarity), it starts to count the rising edge (falling edge) of HSYNC signal from after fixed cycle of rising edge (falling edge) of VSYNC signal. So interval from rising edge (falling edge) of VSYNC signal to rising edge (falling edge) of HSYNC signal needs enough time (2 machine cycles or more) for avoiding jitter. The polarity of HSYNC and VSYNC signals can select with the CRT port control register (address 00EC16).

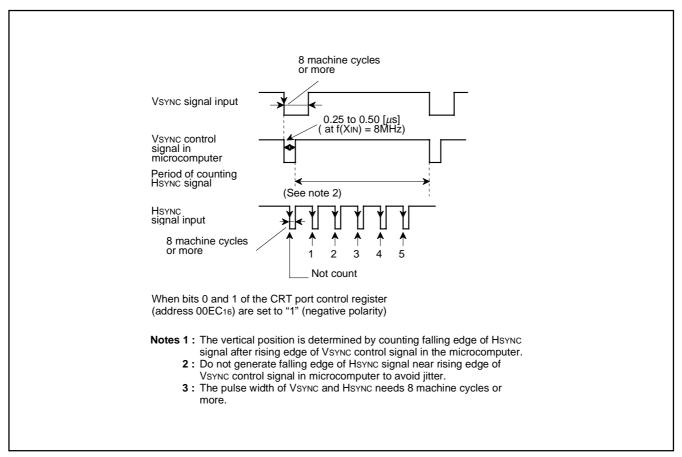


Fig. 8.10.5 Supplement Explanation for Display Position

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The vertical display start position for each block can be set in 512 steps (where each step is 1TH (TH: HSYNC cycle)) as values "0016" to "7F16" in vertical position register i (i = 1 and 2) (addresses 00E116 and 00E216) The vertical position register i is shown in Figure 8.10.6.

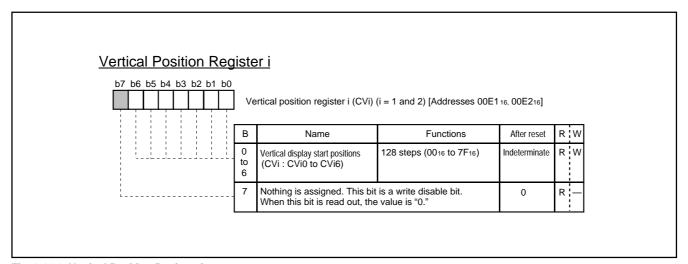


Fig. 8.10.6 Vertical Position Register i

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The horizontal display start position is common to all blocks, and can be set in 64 steps (where 1 step is 4Tc, Tc being the OSD oscillation cycle) as values "0016" to "3F16" in bits 0 to 5 of the horizontal position register (address 00D116). The horizontal position register is shown in Figure 8.10.7.

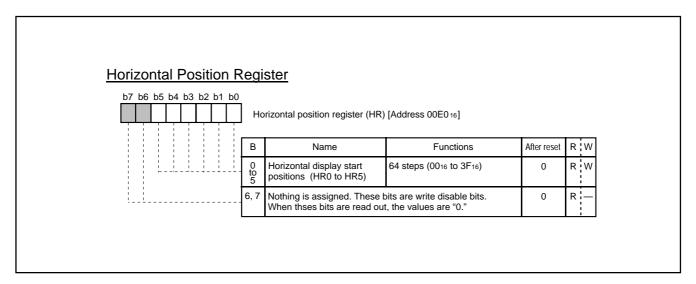


Fig. 8.10.7 Horizontal Position Register

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8.10.2 Character Size

The size of characters to be displayed can be from 3 sizes for each block. Use the character size register (address 00E416) to set a character size. The character size of block 1 can be specified by using bits 0 and 1 of the character size register; the character size of block 2 can be specified by using bits 2 and 3. Figure 8.10.8 shows the character size register.

The character size can be selected from 3 sizes: minimum size, medium size and large size. Each character size is determined by the number of scanning lines in the height (vertical) direction and the oscillating cycle for display (Tc) in the width (horizontal) direction. The minimum size consists of [1 scanning line] \times [1Tc]; the medium size consists of [2 scanning lines] \times [2Tc]; and the large size consists of [3 scanning lines] \times [3Tc]. Table 8.10.2 shows the relation between the set values in the character size register and the character sizes.

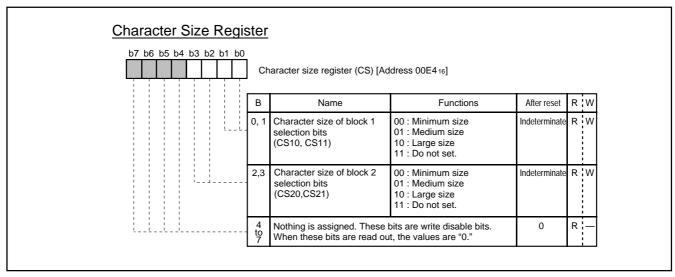


Fig. 8.10.8 Character Size Register

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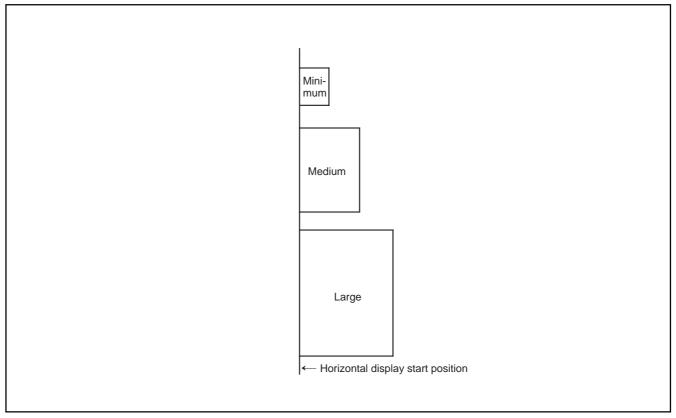


Fig. 8.10.9 Display Start Position of Each Character Size (Horizontal Direction)

Table. 8.10.2 Relation between Set Values in Character Size Register and Character Sizes

Set values of char	acter size register	Character	Width (horizontal) direction	Height (vertical) direction		
CSn1	CSn0	size	Tc: oscillating cycle for display	scanning lines		
0	0	Minimum	1 Tc	1		
0	1	Medium	2 Tc	2		
1	0	Large	3 Tc	3		
1	1	This is not a	available			

Note: The display start position in the horizontal direction is not affected by the character size. In other words, the horizontal display start position is common to all blocks even when the character size varies with each block (refer to Figure 8.10.9).

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.10.3 Clock for OSD

As a clock for display to be used for OSD, it is possible to select one of the following 4 types.

- Main clock supplied from XIN pin
- Main clock supplied from XIN pin divided by I.5
- Clock from the ceramic resonator or the LC or oscillator from the pins OSC1 and OSC2
- Clock from the ceramic resonator or the quartz-crystal oscillator supplied from the pins OSC1 and OSC2.

This OSD clock for each block can be selected by the CRT clock selection register (address 00ED16).

When selecting the main clock, set the oscillation frequency to 8 MHz.

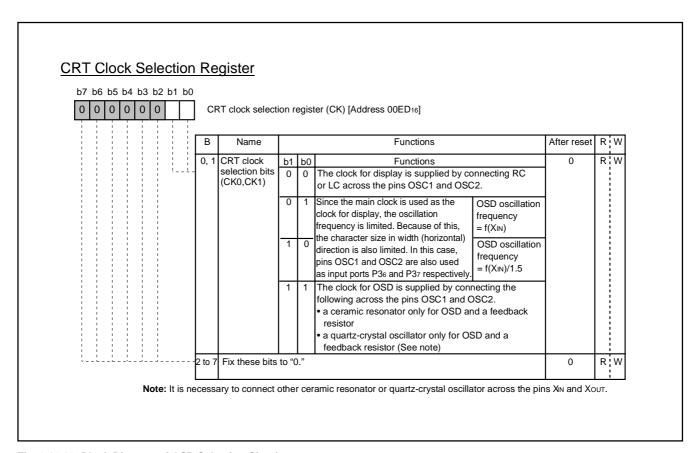


Fig. 8.10.10 Block Diagram of OSD Selection Circuit

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.10.4 Memory for OSD

There are 2 types of memory for OSD: OSD ROM (addresses 1000016 to 11FFF16) used to store character dot data and OSD RAM (addresses 060016 to 06B716) used to specify the characters and colors to be displayed.

(1) OSD ROM (addresses 1000016 to 11FFF16)

The dot pattern data for OSD characters is stored in OSD ROM. To specify the kinds of the character font, it is necessary to write the character code (Table 8.10.3) into the OSD RAM.

The OSD ROM has a capacity of 8K bytes. Since 32 bytes are required for 1 character data, the ROM can stores up to 256 kinds of characters.

The OSD ROM space is broadly divided into 2 areas. The [vertical 16 dots] X [horizontal (left side) 8 dots] data of display characters are stored in addresses 1000016 to 107FF16 and 1100016 to 117FF16; the [vertical 16 dots] X [horizontal (right side) 4 dots] data of display characters are stored in addresses 1080016 to 10FFF16 and 1180016 to 11FFF16 (refer to Figure 8.10.11). Note however that the high-order 4 bits in the data to be written to addresses 1080016 to 10FFF16 and 1180016 to 11FFF16 must be set to "1" (by writing data "FX16"). Data of the character font is specified shown in Figure 8.10.11.

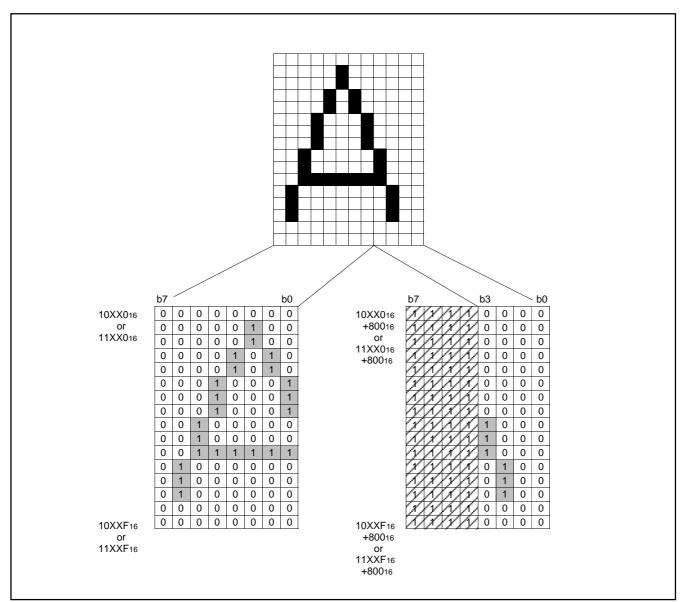


Fig. 8.10.11 Character Font Data Storing Address



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Table 8.10.3 Character Code List (Partially Abbreviated)

Character code	Character data storage address				
Character code	Left 8 dots lines	Right 4 dots lines			
0016	1000016 to 1000F16	1080016 to 1080F16			
0116	1001016 to 1001F16	1081016 to 1081F16			
0216	1002016 to 1002F16	1082016 to 1082F16			
0316	1003016 to 1003F16	1083016 to 1083F16			
:	:	:			
7E16	107E016 to 107EF16	10FE016 to 10FEF16			
7F16	107F0 ₁₆ to 107FF ₁₆	10FF016 to 10FFF16			
8016	1100016 to 1100F16	1180016 to 1180F16			
8116	11010 ₁₆ to 1101F ₁₆	11810 ₁₆ to 1181F ₁₆			
:	:	:			
FD16	117D016 to 117DF16	11FD0 ₁₆ to 11FDF ₁₆			
FE16	117E0 ₁₆ to 117EF ₁₆	11FE0 ₁₆ to 11FEF ₁₆			
FF16	117F0 ₁₆ to 117FF ₁₆	11FF016 to 11FFF16			

(2) OSD RAM (addresses 060016 to 06B716)

The OSD RAM is allocated at addresses 060016 to 06B716, and is divided into a display character code specification part, and color code specification part for each block. Table 8.10.4 shows the contents of the OSD RAM.

For example, to display 1 character position (the left edge) in block 1, write the character code in address 060016, write the color code at 068016

The structure of the OSD RAM is shown in Figure 8.10.12.

Table 8.10.4 Contents of OSD RAM

Block	Display Position (from left)	Character Code Specification	Color Specification
	1st character	060016	068016
	2nd character	060116	068116
	3rd character	060216	068216
Block 1	:	:	:
	22nd character	061516	069516
	23rd character	061616	069616
	24th character	061716	069716
		061816	069816
	Not used	:	:
		061F ₁₆	069F ₁₆
	1st character	062016	06A016
	2nd character	062116	06A1 ₁₆
	3rd character	062216	06A216
Block 2	:	:	:
	22nd character	063516	06B516
	23rd character	063616	06B616
	24th character	063716	06B7 ₁₆



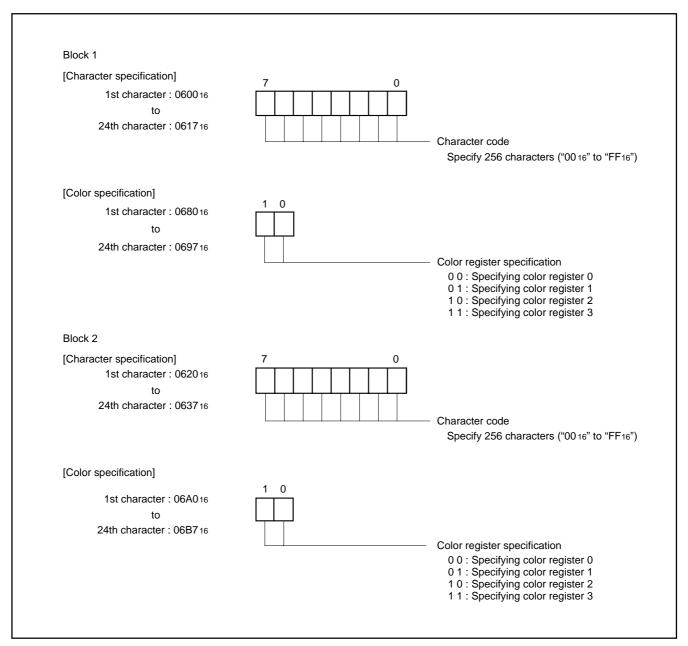


Fig. 8.10.12 Bit structure of OSD RAM

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8.10.5 Color Register

The color of a displayed character can be specified by setting the color to one of the 4 registers (CO0 to CO3: addresses 00E616 to 00E916) and then specifying that color register with the OSD RAM. There are 3 color outputs; R, G and B. By using a combination of these outputs, it is possible to set 8 colors. However, since only 4 color registers are available, up to 4 colors can be disabled at one time.

R, G and B outputs are set by using bits 1 to 3 in the color register. Bit 5 is used to specify whether a character output or blank output. Bits 4, 6 and 7 are used to specify character background color. Figure 8.10.12 shows the color register.

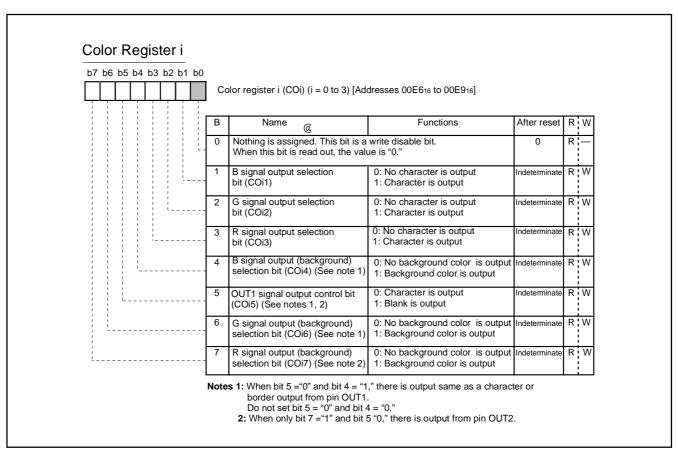


Fig. 8.10.13 Color Register i



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Table 8.10.5 Display Example of Character Background Coloring (When Green Is Set for a Character and Blue Is Set for Background Color)

Borde	er sele	ction r	egiste	r	Col	or reg	ster i					
MD ₀	COi7	COi6	COi5	COi4	СОіЗ	COi2	COi1	G output	B output	OUT1 output	Character output	OUT2 output
0	0	×	0 (1	1 Note 1	0	1	0	A	No output	Same output as character A	Green Green Video signal and character color (green) are not mixed.	No output (See note 2)
0	1	×	0	1	0	1	0	A	No output	Same output as character A	Green Green Green Green Green Green Green	Blank output
0	0	0	1	0	0	1	0	A	No output	Blank output	Green -> -> TV image of character background is not displayed.	No output (See note 2)
0	0	0	1	1	0	1	0	A	Background color	Blank output	Blue	No output (See note 2)
1	×	×	0	1	0	1	0	A	No output	Border output (Black)	Border Green output> (Black) Video signal and character color (green) are not mixed.	No output (See note 2)
1	0	0	1	0	0	1	0	A	No output	Blank output	Green Black TV image of character background is not displayed.	No output (See note 2)
1	0	0	1	1	0	1	0	A	Background color – border	Blank output	Border Output (Black) Blue TV image of character background is not displayed.	No output (See note 2)

Notes 1 : When COi5 = "0" and COi4 = "1," there is output same as a character or border output from the OUT1 pin.

Do not set COi5 = "0" and COi4 = "0."

2: When only COi7 = "1" and COi5 = "0," there is output from pin OUT2.

3: The portion "A" in which character dots are displayed is not mixed with any TV video signal.

4: The wavy-lined arrows in the Table denote video signals.

5:n:0 to 3, X:0 or 1



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8.10.6 Border

An border of 1 clock (1 dot) equivalent size can be added to a character to be displayed in both horizontal and vertical directions. The border is output from the OUT pin. In this case, set bit 5 of a color register to "0" (character is output).

Border can be specified in units of block by using the border selection register (address 00E516). Figure 8.10.14 shows the border selection register. Table 8.10.6 shows the relationship between the values set in the border selection register and the character border function.

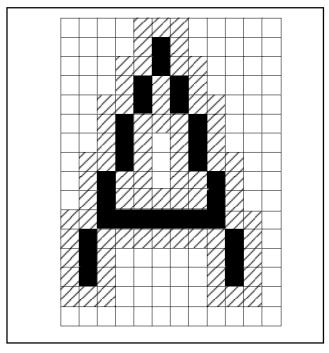


Fig. 8.10.15 Example of Border

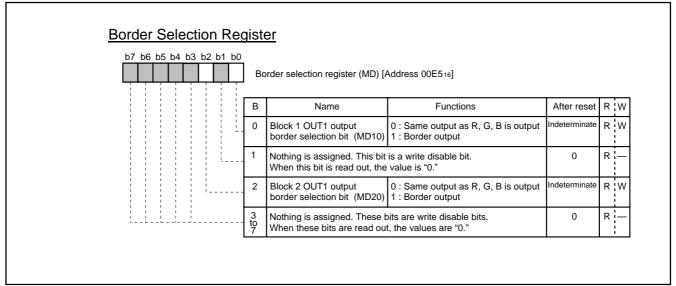


Fig. 8.10.14 Border Selection Register

Table 8.10.6 Relationship between Set Value in Border Selection Register and Character Border Function

Border selection register MDn0	Functions	Example of output
0	Ordinary	R, G, B output
1	Border including character	R, G, B output OUT1 output



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8.10.7 Multiline Display

This microcomputer can ordinarily display 2 lines on the CRT screen by displaying 2 blocks at different vertical positions. In addition, it can display up to 16 lines by using OSD interrupts.

An OSD interrupt request occurs at the point at which display of each block has been completed. In other words, when a scanning line reaches the point of the display position (specified by the vertical position registers) of a certain block, the character display of that block starts, and an interrupt occurs at the point at which the scanning line exceeds the block.

Note: An OSD interrupt does not occur at the end of display when the block is not displayed. In other words, if a block is set to off display by the display control bit of the CRT control register (address 00EA16), an OSD interrupt request does not occur (refer to Figure 8.10.16).

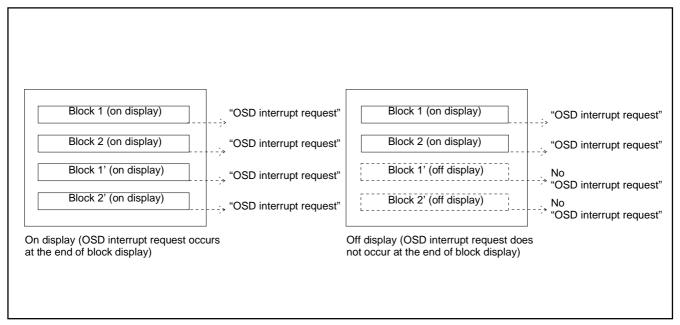


Fig. 8.10.16 Note on Occurence of OSD Interrupt

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8.10.8 OSD Output Pin Control

The OSD output pins R, G, B and OUT1 can also function as ports P52–P55. Set corresponding bit of the port P5 direction register (address 00CB16) to "0" to specify these pins as OSD output pins, or set it to "1" to specify it as a general-purpose port P5.

The OUT2 can also function as port P10. Set bit 0 of the CRT port control register (address 00EC16) to "1" (output mode). After that, set bit 7 of the CRT port control register to "1" to specify the pin as OSD output pin, or set it to "0" to specify as port P10.

The input polarity of the HSYNC, VSYNC and output polarity of signals R, G, B, OUT1 and OUT2 can be specified with the CRT port control register (address 00EC) . Set a bit to "0" to specify positive polarity; set it to "1" to specify negative polarity (refer to Figure 8.11.13). The CRT port control register is shown in Figure 8.10.17.

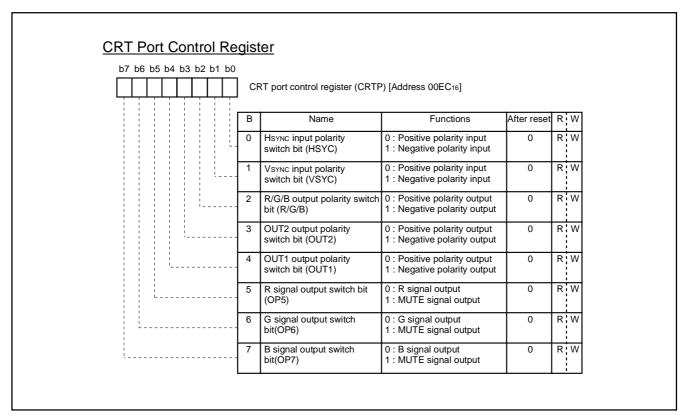


Fig. 8.10.17 CRT Port Control Register

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8.10.9 Raster Coloring Function

An entire screen (raster) can be colored by setting the CRT port control register. Since each of the R, G, B, OUT1, and OUT2 pins can be switched to raster coloring output, 8 raster colors can be obtained. When the character color/the character background color overlaps with the raster color, the color (R, G, B, OUT1, OUT2), specified for the character color/the character background color, takes priority of the raster color. This ensures that character color/character background color is not mixed with the raster color.

The example of raster coloring is shown in Figure 8.10.18.

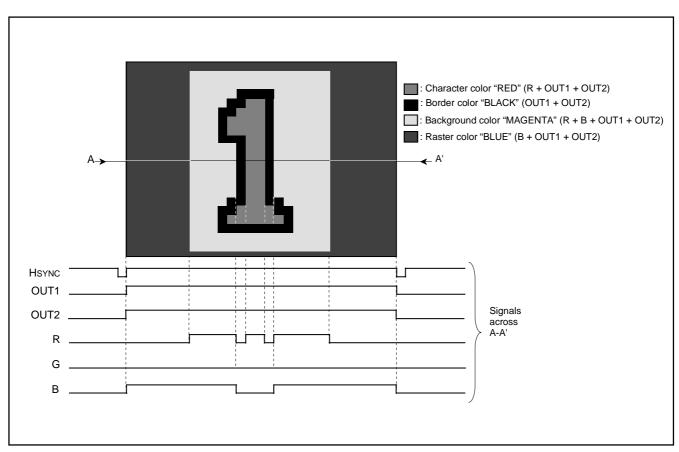


Fig. 8.10.18 Example of Raster Coloring

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8.11 SOFTWARE RUNAWAY DETECT FUNCTION

This microcomputer has a function to decode undefined instructions to detect a software runaway.

When an undefined op-code is input to the CPU as an instruction code during operation, the following processing is done.

- ① The CPU generates an undefined instruction decoding signal.
- ② The device is internally reset because of occurrence of the undefined instruction decoding signal.
- ③ As a result of internal reset, the same reset processing as in the case of ordinary reset operation is done, and the program restarts from the reset vector.

Note, however, that the software runaway detecting function cannot be invalid.

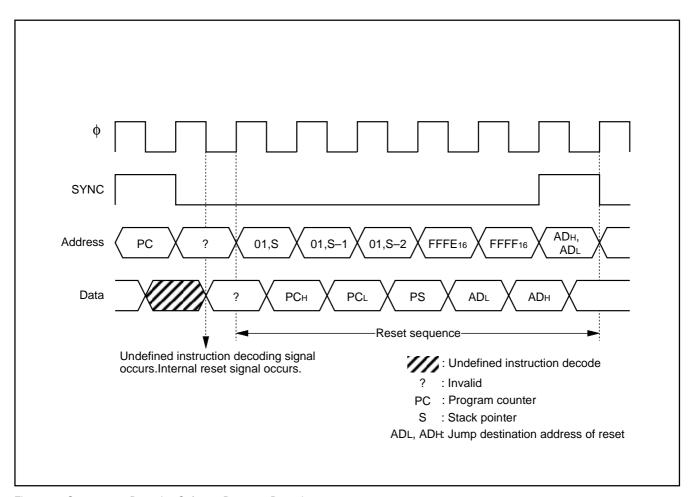


Fig. 8.11.1 Sequence at Detecting Software Runaway Detection

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8.12. RESET CIRCUIT

When the oscillation of a quartz-crystal oscillator or a ceramic resonator is stable and the power source voltage is 5 V \pm 10 %, hold the $\overline{\mbox{RESET}}$ pin at LOW for 2 μs or more, then return is to HIGH. Then, as shown in Figure 8.12.2, reset is released and the program starts form the address formed by using the content of address FFFF16 as the high-order address and the content of the address FFFE16 as the low-order address. The internal state of microcomputer at reset are shown in Figures 8.2.3 to 8.2.6.

An example of the reset circuit is shown in Figure 8.12.1.

The reset input voltage must be kept 0.6 V or less until the power source voltage surpasses 4.5 V.

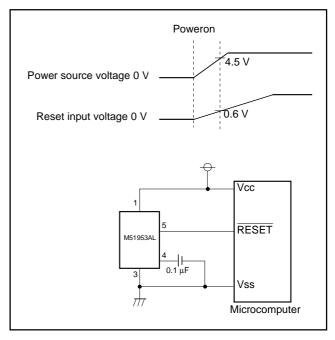


Fig. 8.12.1 Example of Reset Circuit

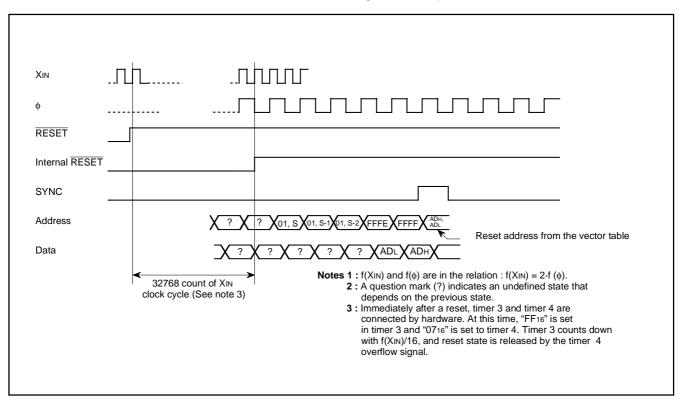


Fig. 8.12.2 Reset Sequence

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.13 CLOCK GENERATING CIRCUIT

The built-in clock generating circuit is shown in Figure 8.13.3. When the STP instruction is executed, the internal clock ϕ stops at HIGH. At the same time, timers 3 and 4 are connected by hardware and "FF16" is set in timer 3 and "0716" is set in the timer 4. Select f(XIN)/16 as the timer 3 count source (set bit 0 of the timer mode register 2 to "0" before the execution of the STP instruction). Moreover, set the timer 3 and timer 4 interrupt enable bits to disabled ("0") before execution of the STP instruction). The oscillator restarts when external interrupt is accepted. However, the internal clock ϕ keeps its HIGH until timer 4 overflows, allowing time for oscillation stabilization when a ceramic resonator or a quartz-crystal oscillator is used.

When the WIT instruction is executed, the internal clock ϕ stops in the HIGH but the oscillator continues running. This wait state is released when an interrupt is accepted (See note). Since the oscillator does not stop, the next instruction can be executed at once.

When returning from the stop or the wait state, to accept an interrupt, set the corresponding interrupt enable bit to "1" before executing the STP or the WIT instructions.

Note: In the wait mode, the following interrupts are invalid.

- VSYNC interrupt
- OSD interrupt
- All timers interrupts using TIM2 and TIM3 pins input as count source
- All timers interrupts using f(XIN)/2 as count source
- All timers interrupts using f(XIN)/4092 as count source
- f(XIN)/4096 interrupt
- Multi-master I2C-BUS interface interrupt

A circuit example using a ceramic resonator (or a quartz-crystal oscillator) is shown in Figure 8.13.1. Use the circuit constants in accordance with the resonator manufacture's recommended values. A circuit example with external clock input is shown in Figure 8.13.2. Input the clock to the XIN pin, and open the XOUT pin.

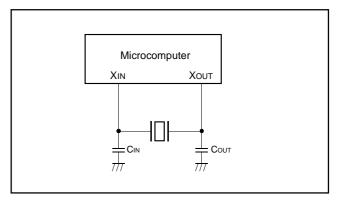


Fig. 8.13.1 Ceramic Resonator Circuit Example

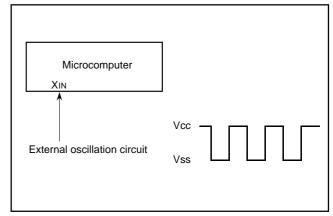


Fig. 8.13.2 External Clock Input Circuit Example

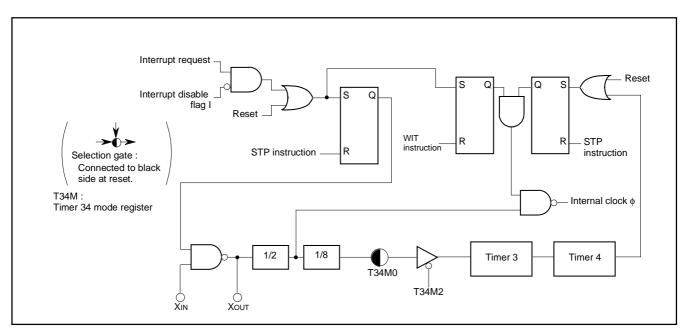


Fig. 8.13.3 Clock Generating Circuit Block Diagram



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

8.14 DISPLAY OSCILLATION CIRCUIT

The OSD oscillation circuit has a built-in clock oscillation circuits, so that a clock for OSD can be obtained simply by connecting an LC, an RC, a ceramic resonator, or a quartz-crystal oscillator across the pins OSC1 and OSC2. Which of the sub-clock or the OSD oscillation circuit is selected by setting bits 0 and 1 of the CRT clock selection register (address 00ED16).

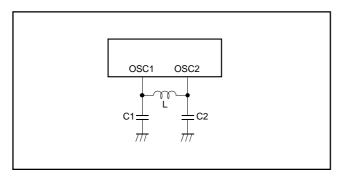


Fig. 8.14.1 Display Oscillation Circuit

8.15 AUTO-CLEAR CIRCUIT

When a power source is supplied, the auto-clear function will operate by connecting the following circuit to the $\overline{\text{RESET}}$ pin.

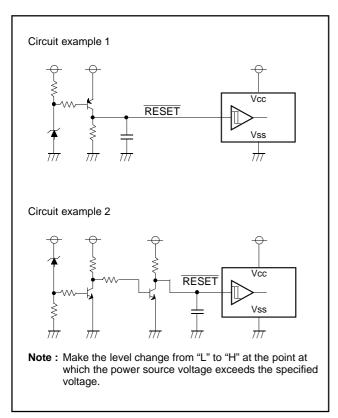


Fig. 8.15.1 Auto-clear Circuit Example

8.16 ADDRESSING MODE

The memory access is reinforced with 17 kinds of addressing modes. Refer to SERIES 740 <Software> User's Manual for details.

8.17 MACHINE INSTRUCTIONS

There are 71 machine instructions. Refer to SERIES 740 <Soft-ware> User's Manual for details.

9. PROGRAMMING NOTES

- The divide ratio of the timer is 1/(n+1).
- Even though the BBC and BBS instructions are executed immediately after the interrupt request bits are modified (by the program), those instructions are only valid for the contents before the modification. At least one instruction cycle is needed (such as an NOP) between the modification of the interrupt request bits and the execution of the BBC and BBS instructions.
- After the ADC and SBC instructions are executed (in the decimal mode), one instruction cycle (such as an NOP) is needed before the SEC, CLC, or CLD instruction is executed.
- An NOP instruction is needed immediately after the execution of a PLP instruction.
- In order to avoid noise and latch-up, connect a bypass capacitor ($\approx 0.1 \mu F$) directly between the Vcc pin–Vss pin and the Vcc pin–CNVss pin, using a thick wire.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

10. ABSOLUTE MAXIMUM RATINGS

Symbol		Parametear	Conditions	Ratings	Unit
Vcc, AVcc	Power source volta	age Vcc	All voltages are	-0.3 to 6	V
Vı	Input voltage	CNVss	based on Vss. Output transistors	-0.3 to 6	V
Vı	Input voltage	P00-P07, P10-P17, P20-P27, P30-P37, P40-P42, OSC1, XIN, HSYNC, VSYNC, RESET	are cut off.	-0.3 to Vcc + 0.3	V
Vo	Output voltage	P10-P14, P20-P17, P30, P31, P40, P41, R, G, B, OUT1, DA XOUT, OSC2		-0.3 to Vcc + 0.3	V
Vo	Output voltage	P00-P07, P60-P63		-0.3 to 13	V
Іон	Circuit current	R, G, B, OUT1, P10–P14, P20–P27, P30, P31, DA		0 to 1 (See note 1)	mA
IOL1	Circuit current	R, G, B, OUT1, P06, P07, P10, P20–P23, P30, P31, P40, P41, DA		0 to 2 (See note 2)	mA
IOL2	Circuit current	P11-P14		0 to 6 (See note 2)	mA
IOL3	Circuit current	P00-P07, P60-P63		0 to 1 (See note 2)	mA
IOL4	Circuit current	P24-P27		0 to 10 (See note 3)	mA
Pd	Power dissipation		Ta = 25 °C	550	mW
Topr	Operating tempera	ture		-10 to 70	°C
Tstg	Storage temperatu	re		-40 to 125	°C

11. RECOMMENDED OPERATING CONDITIONS ($Ta = -10 \, ^{\circ}\text{C}$ to 70 $^{\circ}\text{C}$, Vcc = 5 V \pm 10 %, unless otherwise noted)

0	P		11-2		
Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Power source voltage (See note 4), During CPU, OSD operation	4.5	5.0	5.5	V
Vss	Power source voltage	0	0	0	V
VIH1	HIGH input voltage P00–P07, P10–P17, P20–P27, P30–P37, SIN, SCLK, HSYNC, VSYNC, RESET, XIN, OSC1, TIM2, TIM3, INT1–INT3	0.8Vcc		Vcc	V
VIH2	HIGH input voltage SCL1, SCL2, SDA1, SDA2 (When using PC-BUS)	0.7Vcc		Vcc	V
VIL1	LOW input voltage P00–P07, P10–P17, P20–P27, P30–P37, P40–P42	0		0.4 Vcc	V
VIL2	LOW input voltage SCL1, SCL2, SDA1, SDA2 (When using PC-BUS)	0		0.3 Vcc	V
VIL3	LOW input voltage (See note 6) HSYNC, VSYNC, RESET, TIM2, TIM3, INT1-INT3, XIN, OSC1, SIN, SCLK	0		0.2 Vcc	V
Юн	HIGH average output current (See note 1) R, G, B, OUT1, DA, P10–P14, P20–P27, P30, P31			1	mA
IOL1	LOW average output current (See note 2) R, G, B, OUT1, DA, P10, P20–P23, P30, P31, P40, P41			2	mA
IOL2	LOW average output current (See note 2) P11–P14			6	mA
IOL3	LOW average output current (See note 2) P00–P07, P60–P63			1	mA
IOL4	LOW average output current (See note 3) P24–P27			10	mA
f(XIN)	Oscillation frequency (for CPU operation) (See note 5) XIN	7.9	8.0	8.1	MHz
fosc	Oscillation frequency (for OSD) OSC1	5.0		8.0	MHz
fhs1	Input frequency TIM2, TIM3			100	kHz
fhs2	Input frequency SCLK			1	MHz
fhs3	Input frequency SCL1, SCL2			400	kHz



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

12. ELECTRIC CHARACTERISTICS (Vcc = 5 V ± 10 %, Vss = 0 V, f(Xin) = 8 MHz, Ta = -10 °C to 70 °C, unless otherwise noted)

Symbol	Parameter		Test conditions			Limits		Unit	Test		
Symbol		raiaiiielei		rest conditions		Min.	Тур.	Max.	Unit	circuit	
Icc	Power source current	İ	System operation	Vcc = 5.5 V,		OSD OFF		10	20	mA	
				f(XIN) = 4 MHz	z	OSD ON		20	40		
				VCC = 5.5 V,	_	OSD OFF		20	40		1
				f(XIN) = 8 MHz		OSD ON		30	60		
			Stop mode	VCC = 5.5 V, f	f(XIN) = 0			300	μΑ	
Vон	HIGH output voltage	R, G, B, O P20–P27,		VCC = 4.5 V IOH = -0.5 m/s	A		2.4			V	
VOL	LOW output voltage		DUT1, DA, P10, P30, P31, P40,	VCC = 4.5 V IOL = 0.5 mA					0.4	V	2
	LOW output voltage	P24-P27		VCC = 4.5 V IOL = 10.0 mA	4				3.0		2
	LOW output voltage	P11-P14		Vcc = 4.5 V	lol	= 3 mA			0.4		
					lol	= 6 mA			0.6		
	LOW output voltage	P00-P07,	P60-P63	VCC = 4.5 V IOL = 0.5 mA					0.4		
VT+ - VT-	Hysteresis	RESET		Vcc = 5.0 V				0.5	0.7	V	3
	Hysteresis (See note 6)	INT1-INT	SYNC, TIM2, TIM3, 3, SCL1, SCL2, DA2, SIN, SCLK	VCC = 5.0 V				0.5	1.3		
lizh	HIGH input leak current		P10-P17, P20-P27, P40-P42, HSYNC, VSYNC	VCC = 5.5 V VI = 5.5 V					5	μА	
lizL	LOW input leak current	P20-P27,	P00-P07, P10-P17, P30-P37, P40-P42, HSYNC, VSYNC	VCC = 5.5 V VI = 0 V					5	μА	4
lozh	HIGH input leak current	P00-P07,	P60-P63	VCC = 5.5 V VI = 12 V					10	μА	5
RBS	I ² C-BUS-BUS switch (between SCL1 and S			VCC = 4.5 V					130	Ω	6

Notes 1: The total current that flows out of the IC must be 20 mA or less.

- 2: The total input current to IC (IOL1 + IOL2 + IOL3) must be 30 mA or less.
- 3: The total average input current for ports P24–P27 to IC must be 20 mA or less.
- 4: Connect 0.1 μF or more capacitor externally between the power source pins Vcc–Vss so as to reduce power source noise. Also connect 0.1 μF or more capacitor externally between the pins Vcc–CNVss.
- 5: Use a quartz-crystal oscillator or a ceramic resonator for the CPU oscillation circuit. When using the data slicer, use 8 MHz.
- 6: P15, P32–P35 have the hysteresis when these pins are used as interrupt input pins or timer input pins. P11–P14 have the hysteresis when these pins are used as multi-master I²C-BUS interface ports. P40–P42 have the hysteresis when these pins are used as serial I/O pins.
- 7: Pin names in each parameter is described as below.
 - (1) Dedicated pins: dedicated pin names.
 - (2) Duble-/triple-function ports
 - When the same limits: I/O port name.
 - When the limits of functins except ports are different from I/O port limits: function pin name.

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

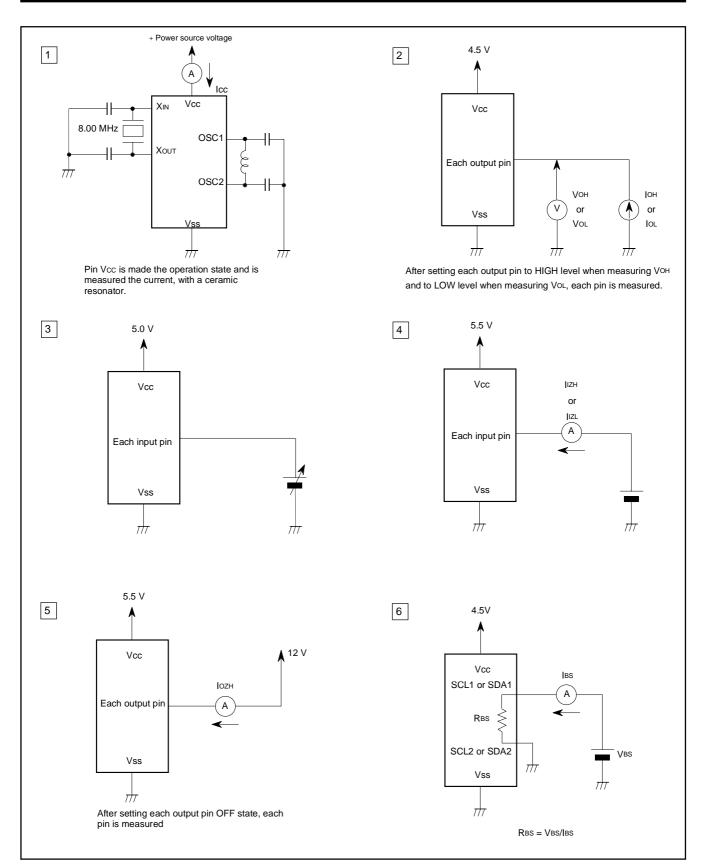


Fig.12.1 Measure Circuits

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

13. A-D COMPARISON CHARACTERISTICS

(Vcc = 5 V \pm 10 %, Vss = 0 V, f(XIN) = 8 MHz, Ta = 25 °C, unless otherwise noted)

Cymphal	Doromotor	Test conditions		Lloit		
Symbol	Parameter	rest conditions	Min.	Тур.	Max.	Unit
_	Resolution				6	bits
_	Absolute accuracy		0	±1	±2	LSB

14. MULTI-MASTER I²C-BUS BUS LINE CHARACTERISTICS

Cumbal	Parameter		Standard clock mode		High-speed clock mode	
Symbol			Max.	Min.	Max.	Unit
tBUF	Bus free time	4.7		1.3		μs
tHD; STA	Hold time for START condition	4.0		0.6		μs
tLOW	LOW period of SCL clock	4.7		1.3		μs
tR	Rising time of both SCL and SDA signals		1000	20+0.1Cb	300	ns
tHD; DAT	Data hold time	0		0	0.9	μs
tHIGH	HIGH period of SCL clock	4.0		0.6		μs
tF	Falling time of both SCL and SDA signals		300	20+0.1Cb	300	ns
tsu; dat	Data set-up time	250		100		ns
tsu; sta	Set-up time for repeated START condition	4.7		0.6		μs
tsu; sto	Set-up time for STOP condition	4.0		0.6		μs

Note: Cb = total capacitance of 1 bus line

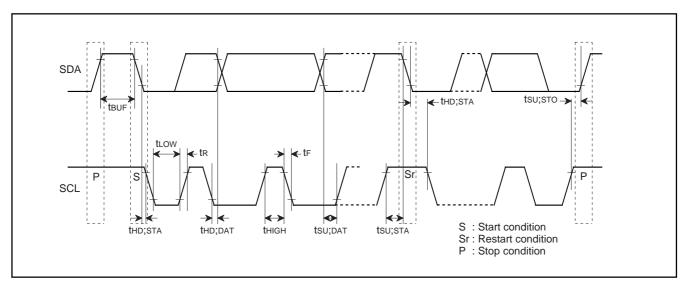


Fig.14.1 Definition Diagram of Timing on Multi-master I²C-BUS

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

15. PROM PROGRAMMING METHOD

The built-in PROM of the One Time PROM version (blank) and the built-in EPROM version can be read or programmed with a general-purpose PROM programmer using a special programming adapter.

Product	Name of Programming Adapter
M37212EFSP	PCA7406
M37212EFFP	PCA7420

The PROM of the One Time PROM version (blank) is not tested or screened in the assembly process nor any following processes. To ensure proper operation after programming, the procedure shown in Figure 15.1 is recommended to verify programming.

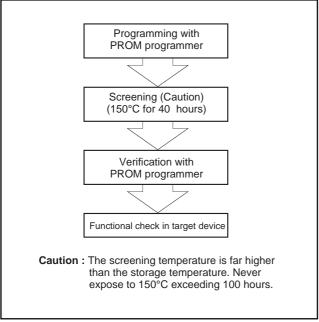


Fig. 15.1 Programming and Testing of One Time PROM Version

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

16. DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:

- Mask ROM Order Confirmation Form
- Mark Specification Form
- Data to be written to ROM, in EPROM form (32-pin DIP Type 27C101, three identical copies) or FDK



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

17. MASK CONFIRMATION FORM

GZZ-SH55-23B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M4-XXXSP MITSUBISHI ELECTRIC

or
; C

Mask ROM number

Note: Please fill in all items marked *.

		Company		TEL		Submitted by	Supervisor
*	Customer	name		()	ance ature		
		Date issued	Date :		lssu sign		

*1. Confirmation

Three EPROMs are required for each pattern if this order is performed by EPROMs. One floppy disk is required for each pattern if this order is performed by a floppy disk.

Ordering by EPROMs

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

EPROM type (indicate the type used)

Checksum code for entire EPROM

e i	used))		•

(hexadecimal notation)

٠.					
27C101					
EPROM ac	ddress				
0000 ₁₆ 000F ₁₆	Product nameASCII code: 'M37212M4-'				
C000 ₁₆					
FFFF ₁₆	Data ROM(16K)				
10000 ₁₆ 107FF ₁₆	Character ROM1-a				
10800 ₁₆ 10FFF ₁₆	Character ROM2-a				
11000 ₁₆ 117FF ₁₆	Character ROM1-b				
11800 ₁₆ 11FFF ₁₆	Character ROM2-b				
1200016					
1FFFF ₁₆	(//////////////////////////////////////				

(1) Set "FF16" in the shaded area.

(1/3)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-23B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M4-XXXSP MITSUBISHI ELECTRIC

(2)	Write the ASCII codes that indica	ate the product name	e of "M37	7212M4–" to add	resses 00001	6 to 000F16.
	Addresses 0000 ₁₆ to 000F ₁₆ store	the product name. A	ddress		Address	
	ASCII codes 'M37212M4-' are liste		000016	'M' = 4D ₁₆	000816	'–' = 2D ₁₆
	The addresses and data are in hex	kadecimal notation.	000116	'3' = 33 ₁₆	000916	FF ₁₆
			000216	'7' = 37 ₁₆	000A ₁₆	FF ₁₆
			000316	'2' = 32 ₁₆	000B ₁₆	FF ₁₆
Note:	If the name of the product contained in	the EPROMs does	000416	'1' = 31 ₁₆	000C16	FF ₁₆
	not match the name on the mask ROM	confirmation form,	000516	'2' = 32 ₁₆	000D ₁₆	FF ₁₆
	the ROM processing is disabled. Ple	ase make sure the	000616	'M' = 4D ₁₆	000E ₁₆	FF ₁₆
	data is written correctly.		000716	'4' = 34 ₁₆	000F16	FF ₁₆
resp care The one	will produce masks based on the consibility for errors only if the mask a must be taken to verify the mask submitted floppy disk must be 3.5-floppy disk. File code Mask file name	ROM data on the pro	ducts we p floppy dis	oroduce differs from k. at. And the number (hexadecim	m this mask file er of the mask f al notation)	. Thus, extreme
Mar mar	k specification must be submitted k specification form (52P4B for M3 mments	· ·	•		•	

(2/3)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-23B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M4-XXXSP MITSUBISHI ELECTRIC

Inputting the character ROM

Input the character ROM data by dividing it into character ROM1 and character ROM2.

The structure of character ROM (divided into 12 ×16 dots font)

Example

Character code

"1A16"

Character

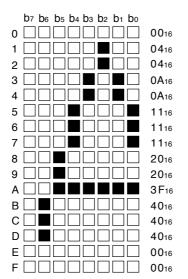
ROM₁

<u>C</u>haracter

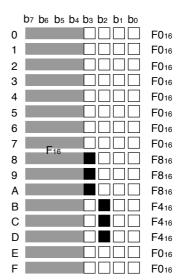
ROM2

(Note)

Write the character code "00 $_{16}$ " to "7F $_{16}$ " to Addresses 10000 $_{16}$ to 10FFF $_{16}$. Write the character code "80 $_{16}$ " to "FF $_{16}$ " to Addresses 11000 $_{16}$ to 11FFF $_{16}$.



Example 101A0₁₆ to 101AF₁₆



 $\begin{array}{c} \text{Example} \quad 109\text{A}0_{16} \\ \quad \text{to} \\ \quad 109\text{AF}_{16} \end{array}$

(3/3)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-24B < 91A0 >

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M6-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head signature	Supervisor signature
Receipt		
Re		

Note: Please fill in all items marked *.

.•.		Company name		TEL ()	nce ture	Submitted by	Supervisor
*	Customer	Date issued	Date :		Issua signa		

*1. Confirmation

Specify the name of the product being ordered.

Three EPROMs are required for each pattern if this order is performed by EPROMs.

One floppy disk is required for each pattern if this order is performed by a floppy disk.

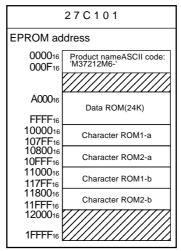
Microcomputer name: M37212M6-XXXSP M37212M6-XXXFP

☐ Ordering by EPROMs

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Checksum code for entire EPROM (hexadecimal notation)

EPROM type (indicate the type used)



(1) Set "FF16" in the shaded area.

(1/3)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-24B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M6-XXXSP/FP MITSUBISHI ELECTRIC

(2)	Write the ASCII codes that in	ndicate the product name	of "M37	'212M6-" to addr	esses 00001	6 to 000F16.
	Addresses 000016 to 000F16 sto	re the product name. A	ddress		Address	
	ASCII codes 'M37212M6-' are li	sted on the right.	000016	'M' = 4D ₁₆	000816	'-' = 2D ₁₆
	The addresses and data are in	000116	'3' = 33 ₁₆	000916	FF ₁₆	
			000216	'7' = 37 ₁₆	000A16	FF ₁₆
			000316	'2' = 32 ₁₆	000B ₁₆	FF ₁₆
Note:	If the name of the product contain	ined in the EPROMs does	000416	'1' = 31 16	000C16	FF ₁₆
	not match the name on the mas	k ROM confirmation form,	000516	'2' = 32 ₁₆	000D16	FF16
	the ROM processing is disable	d. Please make sure the	000616	'M' = 4D ₁₆	000E16	FF ₁₆
	data is written correctly.		000716	'6' = 36 ₁₆	000F ₁₆	FF ₁₆
res ca Th	dering by floppy disk e will produce masks based on sponsibility for errors only if the n re must be taken to verify the n e submitted floppy disk must be e floppy disk.	nask ROM data on the products file in the submitted f	ducts we p loppy dist	roduce differs from k.	n this mask file	e. Thus, extreme
	File code		(r	nexadecimal nota	ition)	
	Mask file name		۸.	/ISK (equal or les	s than eight	characters)
 *2. Mark specification Mark specification must be submitted using the correct form for the type of package being ordered. Fill the appropriat mark specification form (52P4B for M37212M6-XXXSP, 80P6N for M37212M6-XXXFP) and attach to the mask RON confirmation form. *3. Comments 						



(2/3)

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-24B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M6-XXXSP/FP MITSUBISHI ELECTRIC

Inputting the character ROM

Input the character ROM data by dividing it into character ROM1 and character ROM2.

The structure of character ROM(divided into 12 ×16 dots font)

Character code

"1A16"

(Note)

Write the character code "00 16" to "7F16" to Addresses 10000 16 to 10FFF16.

Write the character code "80 16" to "FF16" to Addresses 11000 16 to 11FFF16.

Addresses 11000 16 to 11FFF16.

	b7 b6 b5 b4 b3 b2 b1 b0			b7 b6 b5 b4 b3 b2 b1 b0
	0	0016	0	
	1	0416	1	
	2	0416	2	
	3	0A ₁₆	3	
	4	0A ₁₆	4	
	5	1116	5	
	6	1116	6	
	7	1116	7	F ₁₆
	8	2016	8	
	9	2016	9	
	A	3 F ₁₆	Α	
	В	4016	В	
		4016	С	
	D	4016	D	
	E	0016	Е	
	F	0016	F	
,	101A0 ₁₆		Example	109A0 ₁₆
	to			to
	101AF ₁₆			109AF ₁₆

Renesas Technology Corp.

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Example

F0₁₆ F0₁₆ F0₁₆ F0₁₆ F0₁₆ F0₁₆ F0₁₆ F0₁₆ F8₁₆ F8₁₆ F8₁₆ F4₁₆ F4₁₆ F4₁₆ F0₁₆ F0₁₆

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-42B < 91A0 >

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M8-XXXSP MITSUBISHI ELECTRIC

	Date:	
	Section head signature	Supervisor signature
Receipt		
Re		

Note: Please fill in all items marked *.

**		Company name		TEL ()	nce ture	Submitted by	Supervisor
*	Customer	Date issued	Date :		Issua signa		

*1. Confirmation

Three EPROMs are required for each pattern if this order is performed by EPROMs. One floppy disk is required for each pattern if this order is performed by a floppy disk.

$\overline{}$	10			
	Ordering	bν	EPR	ROMs

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Checksum code for entire EPROM			(hexadecimal notation)
enconcam code for online in them			(110Maaoonnai 110tation)

EPROM type (indicate the type used)

27C101				
EPROM ac	ddress			
0000 ₁₆ 000F ₁₆	Product nameASCII code: 'M37212M8-'			
8000 ₁₆ FFFF ₁₆	Data ROM(32K)			
10000 ₁₆ 107FF ₁₆	Character ROM1-a			
10800 ₁₆ 10FFF ₁₆	Character ROM2-a			
11000 ₁₆ 117FF ₁₆	Character ROM1-b			
11800 ₁₆ 11FFF ₁₆	Character ROM2-b			
12000 ₁₆ 1FFFF ₁₆				

(1) Set "FF16" in the shaded area.

(1/3)



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-42B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M8-XXXSP

(2)	Write the ASCII codes that indicate the product name	e of "M3	37212M8-" to add	dresses 00001	6 to 000F16.
	Addresses 000016 to 000F16 store the product name.	ddress		Address	
	ASCII codes 'M37212M8-' are listed on the right.	000016	'M' = 4D ₁₆	000816	'-' = 2D ₁₆
	The addresses and data are in hexadecimal notation.	000116	'3' = 33 ₁₆	000916	FF ₁₆
		000216	'7' = 37 ₁₆	000A ₁₆	FF ₁₆
		000316	'2' = 32 ₁₆	000B ₁₆	FF ₁₆
Note	: If the name of the product contained in the EPROMs does	000416	'1' = 31 ₁₆	000C ₁₆	FF ₁₆
	not match the name on the mask ROM confirmation form,	000516	'2' = 32 ₁₆	000D ₁₆	FF ₁₆
	the ROM processing is disabled. Please make sure the	000616	'M' = 4D ₁₆	000E16	FF ₁₆
	data is written correctly.	000716	'8' = 38 ₁₆	000F16	FF ₁₆
*2. I	ridering by floppy disk /e will produce masks based on the mask files generated asponsibility for errors only if the mask ROM data on the proper must be taken to verify the mask file in the submitted he submitted floppy disk must be 3.5-inch 2HD type and DO ne floppy disk. File code Mask file name Mark specification lark specification must be submitted using the correct form park specification form (52P4B for M37212M8-XXXSP) are comments	ducts we floppy di DS/V form	produce differs from sk. nat. And the number (hexadecimal new small). MSK (equal or leading to the specific package begins of package begins of package begins and several productions.	er of the mask file otation) ess than eight	. Thus, extreme iles must be 1 in characters)



(2/3)

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH55-42B < 91A0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37212M8-XXXSP MITSUBISHI ELECTRIC

Inputting the character ROM

Input the character ROM data by dividing it into character ROM1 and character ROM2.

The structure of character ROM (divided into 12 ×16 dots font)

Character code

"1A16"

Character code

"1A16"

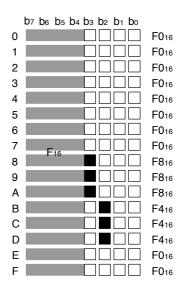
(Note)

Write the character code "00 16" to "7F 16" to addresses 10000 16 to 10FF 16.

Write the character code "80 16" to "FF 16" to addresses 11000 16 to 11FFF 16.

b7 b6 b5 b4 b3 b2 b1 b0	
o 🗆 🗆 🗆 🗆 🗆 🗆	0016
1	0416
2	0416
3	0A ₁₆
4	0A 16
5	11 ₁₆
6	1116
7	11 16
8	2016
9	2016
A 🗌 🗌 🖿 🖝 🖝 🖝 🖝	3F16
в 🗌 📕 🔲 🗎 🔲 📗 📗	4016
c 🗆 🖪 🗆 🗆 🗆 🗆	4016
D	4016
E	0016
F 🗆 🗆 🗆 🗆 🗆 🗆	0016

Example $101A0_{16}$ to $101AF_{16}$ (3/3)



Example 109A0₁₆ to 109AF₁₆

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

18. MARK SPECIFICATION FORM

52P4B (52-PIN SHRINK DIP) MARK SPECIFICATION FORM

Mitsubishi IC catalog name
Please choose one of the marking types below (A, B, C), and enter the Mitsubishi IC catalog name and the special mark (if needed).
A. Standard Mitsubishi Mark
Mitsubishi lot number (6-digit or 7-digit) ————Mitsubishi IC catalog name
B. Customer's Parts Number + Mitsubishi Catalog Name
Customer's parts number Note: The fonts and size of characters are standard Mitsubishi type. Mitsubishi lot number (6-digit or 7-digit) Note1: The mark field should be written right aligned. 2: The fonts and size of characters are standard Mitsubishi type. 3: Customer's parts number can be up to 18 characters:
Only $0\sim 9$, $A\sim Z$, $+$, $-$, $/$, $($, $)$, &, \mathbb{C} , .(period), and ,(comma) are usable. C. Special Mark Required
Note1: If the special mark is to be printed, indicate the desired layout of the mark in the upper figure. The layout will be duplicated as close as possible. Mitsubishi lot number (6-digit or 7-digit) and mask ROM number (3-digit) are always marked.
2: If the customer's trade mark logo must be used in the special mark, check the box below. Please submit a clean original of the logo.
For the new special character fonts a clean font original (ideally logo drawing) must be submitted. Special logo required
The standard Mitsubishi font is used for all characters except for a logo.

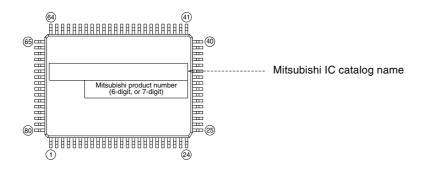
SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

80P6N (80-PIN QFP) MARK SPECIFICATION FORM

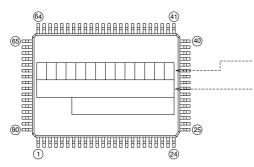
Mitsubishi IC catalog name	
----------------------------	--

Please choose one of the marking types below (A, B, C), and enter the Mitsubishi IC catalog name and the special mark (if needed).

A. Standard Mitsubishi Mark



B. Customer's Parts Number + Mitsubishi IC Catalog Name



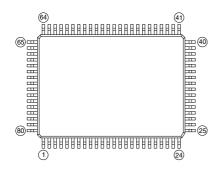
Customer's Parts Number

Note : The fonts and size of characters are standard Mitsubishi type.

Mitsubishi IC catalog name

- Notes 1: The mark field should be written right aligned.
 - 2: The fonts and size of characters are standard Mitsubishi type.
 - 3: Customer's parts number can be up to 14 alphanumeric characters for capital letters, hyphens, commas, periods and so on.

C. Special Mark Required



Notes1: If special mark is to be printed, indicate the desired layout of the mark in the left figure. The layout will be duplicated technically as close as possible.

Mitsubishi product number (6-digit, or 7-digit) and Mask ROM number (3-digit) are always marked for sorting the products.

2 : If special character fonts (e,g., customer's trade mark logo) must be used in Special Mark, check the box below

For the new special character fonts, a clean font original (ideally logo drawing) must be submitted.

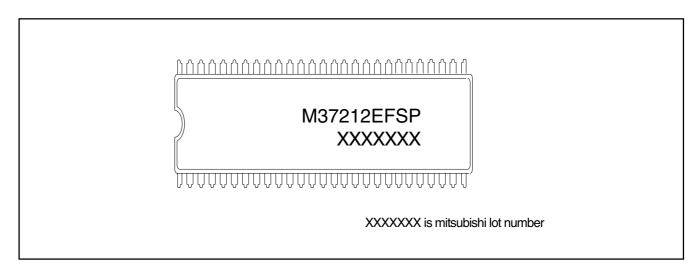
Special character fonts required

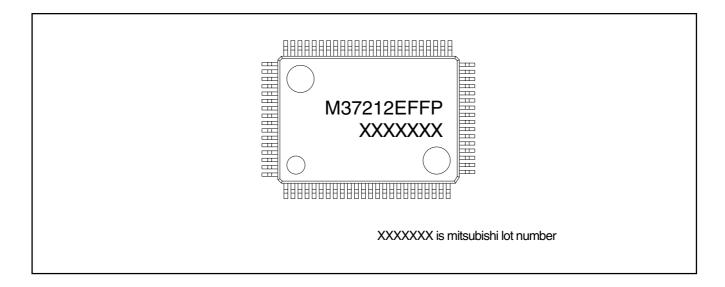




SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

19. ONE TIME PROM VERSION M37212EFSP/FP MARKING

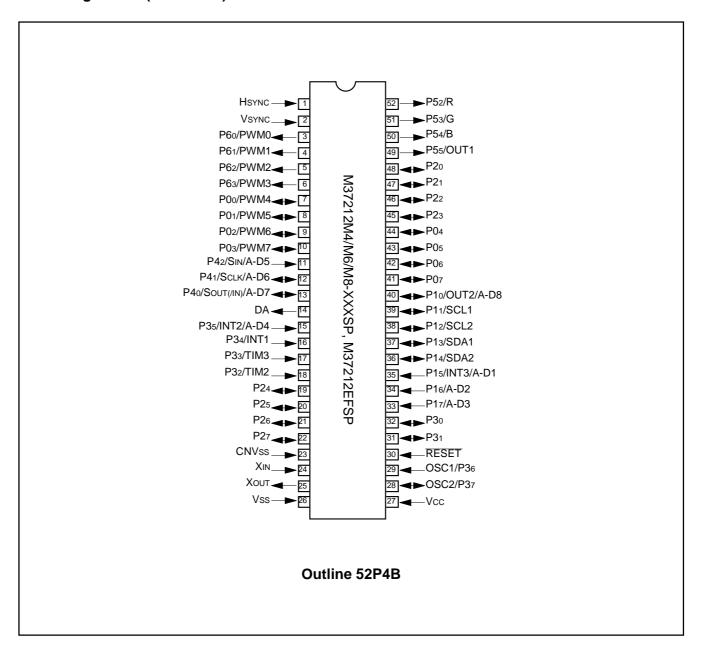




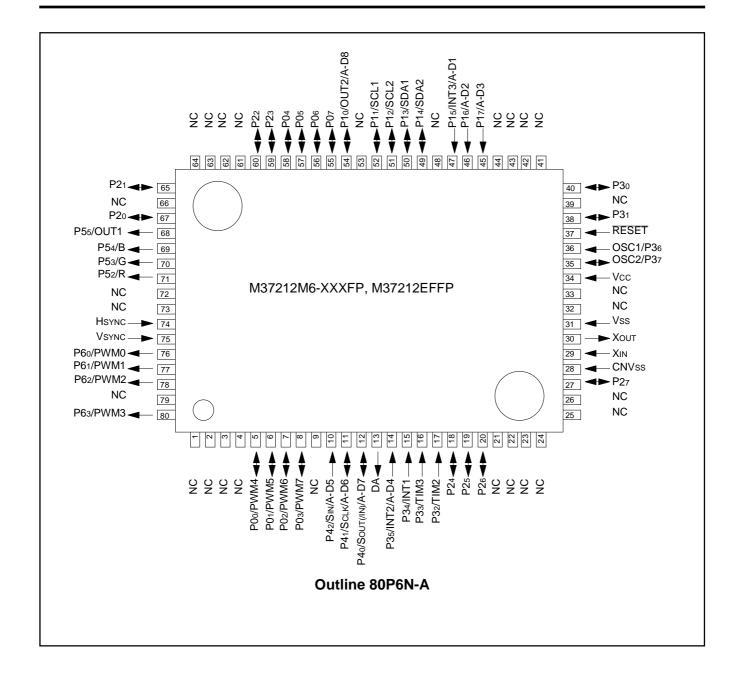
SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

20. APPENDIX

Pin Configuration (TOP VIEW)

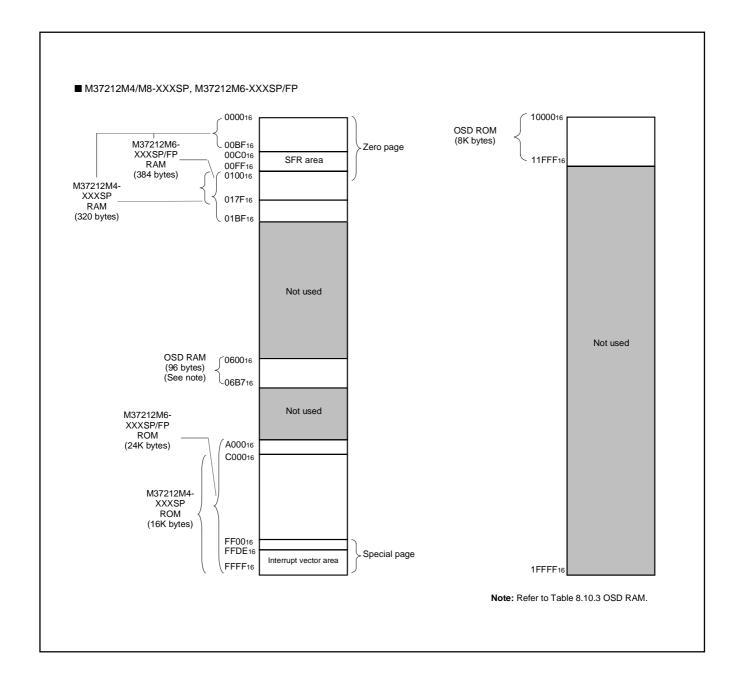


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

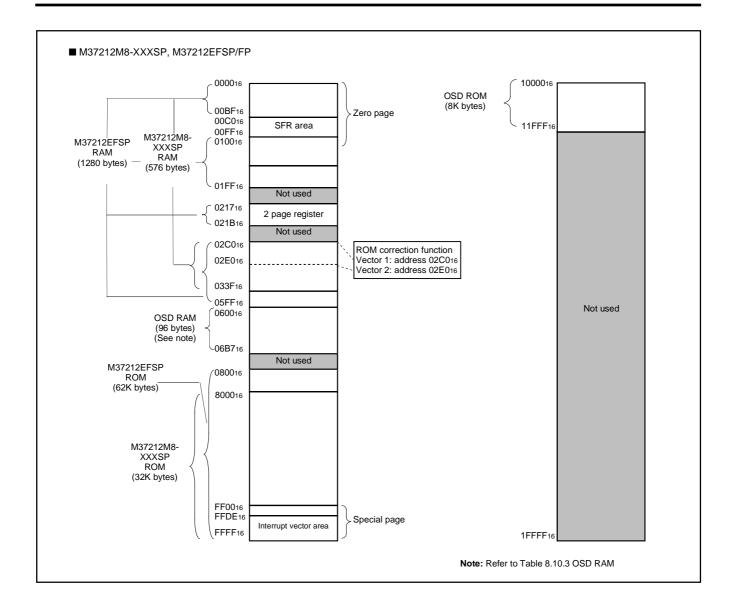


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Memory Map



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Memory Map of Special Function Register (SFR)

■ S	FR area (addresses C0 ₁₆ to	DF ₁	6)																
	•		alloc	atio	n					State immediately after reset									
									0 : "0" immediately after reset										
		Function bit																	
		Name .	,							1	: "1"	imm	ediately	/ afte	r res	et			
		:	No fu	unctio	on bit					?	: Ind	leter	minate	imme	ediat	ely			
		0:	Fix t	o th	is bi	t to "	0"				afte	er re	set						
			(do	not v	write	to "	1")												
		1 :	Fix to																
Address	Register		`			ocati	•			S	tate	imm	ediately	/ afte	r res	et			
/ (dai 000	3	b7			J				b0	<u>b7</u>						b0			
C016	Port P0 (P0)												?						
C1 ₁₆	Port P0 direction register (D0)												0016						
	Port P1 (P1)												?						
C3 ₁₆	Port P1 direction register (D1)												0016						
C416	Port P2 (P2)												?						
C516	Port P2 direction register (D2)												0016						
C616	Port P3 (P3)							_					?						
C7 ₁₆	Port P3 direction register (D3)							P31D	P30D				0016						
C816	Port P4 (P4)							P41	P40	0	0	0	0 0	?	?	?			
C9 ₁₆	Port P4 direction register (D4)							P41D	P40D	0	0	0	0 0	?	?	?			
	Port P5 (P5)			P55	P54	P53	P52			0	0	?	? ?	?	0	0			
CB ₁₆	Port P5 direction register (D5)			P55 SEL	P54 SEL	P53 SEL	P52 SEL	0	0				0016						
CC16	Port P6 (P6)				-	P63	P62	P61	P60				0F16						
CD ₁₆						1	1	1	1				0F16						
CE ₁₆	DA-H register (DA-H)					-	!	-					?						
CF ₁₆	DA-L register (DA-L)									0	0	?	? ?	?	?	?			
D016	PWM0 register (PWM0)				J		<u> </u>		-	Ť			?	l					
D1 ₁₆	PWM1 register (PWM1)												?						
D216	PWM2 register (PWM2)												?						
D3 ₁₆	PWM3 register (PWM3)												?						
	PWM4 register (PWM4)												?						
D516	PWM output control register 1 (PW)	PW7	PW6	PW5	PW4	PW3	PW2	PW1	PW0				0016						
D616	PWM output control register 2 (PN)							PN1	-				0016						
D716	I ² C data shift register (S0)	D7	D6	D5	D4	D3	D2	D1	D0				?						
D816	I ² C address register (S0D)	SAD	SAD5		SAD3	SAD2	_	SADO	RBW				0016						
	I ² C status register (S1)		TRX		PIN			AD0	-	0	0	0	1 0	0	0	?			
	I ² C control register (S1D)		BSEL0		ALS			BC1	\vdash	۲	<u> </u>		0016						
	I ² C clock control register (S2)	ACK	ACK	FAST MODE				CCR1	-				0016						
	Serial I/O mode register (SM)	ACK	BIT	MODE SM5				SM1	-	-			0016						
	Serial I/O register (SIO)		SIVIO	SIVIS	0	SIVIS	SIVIZ	JIVI I	SIVIU				?						
DE16	Conai i/O register (SIO)												?						
DF16													?						



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

- 0.	-D (- dd				,														
■ 51	FR area (addresses E0				•					Qt ₀	to ir	mma	diat	oby i	ofto	roce	\ 1		
	_	— —	alloc	atio	n					State immediately after reset									
	Function bit							0 :	0 : "0" immediately after reset										
	Na	ame :	J							1:	"1"	imm	edia	tely	afte	er res	et		
			No fi	ınotic	n bit									•					
			INO IC	incuc	ווט וונ					? :		eteri er re:		ate i	mm	ediat	ely		
					s bit vrite						ane	erre	sei						
					s bit vrite														
Address	Register			Bi	t allo	cati	on				ate	imm	edia	tely	afte	er res	et		
- 0	Llavinantal position register (LID)	b7		Lune	LID4	LIDO	LIDO	LIDA	-	b7							b0		
E016	Horizontal position register (HR) Vertical position register 1 (CV1)		0) / : 5	-	HR4						_	2)16	T 2	10			
	, ,			-	CV14	-		-	\vdash	0	?	?	?	?	?	?	?		
E2 ₁₆ E3 ₁₆	Vertical position register 2 (CV2)		CV26	CV25	CV24	CV23	CV22	CV21	CV20	0	?	?		? 016	?	?	?		
	Character sine register (CC)			Г		CS21	CS20	CS11	CS10						12	12			
	Character size register (CS)					0021	MD20		MD10	0	0	0	0	?	?	?	?		
E516	Border selection register (MD) Color register 0 (CO0)	0007	COOC	0005	CO04	0003				0	0	0	0	0 0 016	?	0	!		
	Color register 1 (CO1)			_	CO14	-		-	-)16)16					
	Color register 2 (CO2)		-	_	CO24	-		-	\vdash	-)16)16					
	= : :		-	-	CO24				-	-)16)16					
	Color register 3 (CO3)	CC7	0030	1	0004	0000	<u> </u>	CC1		-)16)16					
EA ₁₆ EB ₁₆	CRT control register (CC)	CCI					002	1001	1000)16					
	CRT port control register (CRTP)	OP7	OP6	OP5	OUT1	OLIT2	R/G/F	VSYC	HSYC	-)16					
	CRT clock selection register (CK)		0	0	0	0	0		CK0)16					
	A-D mode register (ADM)	0	0		ADM4	_	_		ADM0	0	0	0	?	0	0	0	Το		
	A-D control register (ADC)			ADC5	ADC4				igsquare	-	0	0) 16	0	10	10		
	Timer 1 (T1)			<u> </u>					1.200	-				=16					
F1 ₁₆	Timer 2 (T2)									 				716			$\overline{}$		
	Timer 3 (T3)													=16			$\overline{}$		
	Timer 4 (T4)													716					
F4 ₁₆	Timer 12 mode register (T12M)			0	T12M4	T12M3	T12M2	T12M1	T12M0)16					
	Timer 34 mode register (T34M)				T34M4				-) 16					
	PWM5 register (PWM5)			l	J		<u> </u>							?					
	PWM6 register (PWM6)													 ?			$\overline{}$		
	PWM7 register (PWM7)													 ?					
	Interrupt input polarity register (RE)	0		RE5	RE4	RE3	0) 16					
FA ₁₆	interrupt input polarity register (INE)								_					?					
	CPU mode register (CM)	1	1	1	1	1	СМ2	0	0				FC	C16					
	Interrupt request register 1 (IREQ1)	IT3R	IICR	-	-	TM4R	-		TM1R) 16			=		
	Interrupt request register 2 (IREQ2)				MSR		S1R	IT2R	IT1R)16					
	Interrupt control register 1 (ICON1)		IICE	VSCE	OSDE	TM4E			-) 16					
	Interrupt control register 2 (ICON2)		0	0	MSE	0	C1E	IT2E	IT1E	?	0	0	0	0	0	0	0		

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

		Bit allo	ocation				State immediately after reset					
		: _{`.}	unction	hit		[0 : "0" immediately after reset					
		Name : 5 '	unotion	Dit		[1 : "1" immediately after reset					
		: No	function	bit		[? : Indeterminate immediately					
		- U	to this		-	ı	after reset					
			to this									
Address	Register		Bit	allocat	ion		State immediately after reset					
	Ŭ	b7				b0	b7 b0					
217 ₁₆ ROM	A correction address 1 (high-order	.)					0016					
218 ₁₆ ROM	A correction address 1 (low-order))					0016					
219 ₁₆ ROM	A correction address 2 (high-order	r)					0016					
21A ₁₆ ROM	A correction address 2 (low-order))					0016					
	I correction enable register (RCR	١ .		0	0	RCR1RCR0	0016					

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

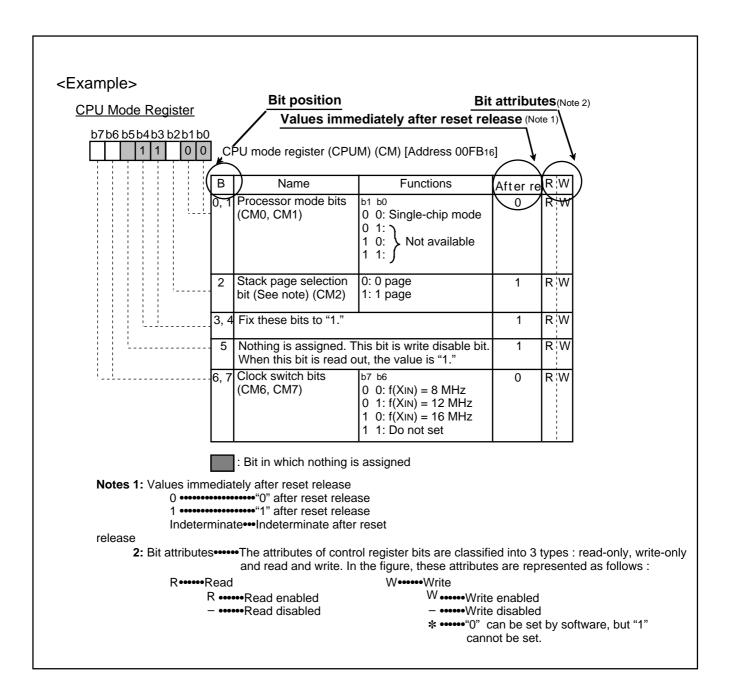
Internal State of Processor Status Register and Program Counter at Reset

	Bit allocation	State immediately after reset
	: Function bit	0 : "0" immediately after reset
	Name : S	1 : "1" immediately after reset
	: No function bit	? : Indeterminate immediately
	O: Fix to this bit to "0" (do not write to "1")	after reset
	1: Fix to this bit to "1" (do not write to "0")	
Register	Bit allocation b7	State immediately after reset b0 b7 b0
Processor status register (PS) Program counter (PCH) Program counter (PCL)	N V T B D I	Z C ? ? ? ? ? 1 ? ? Contents of address FFFF16 Contents of address FFFE16

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Structure of Register

The figure of each register structure describes its functions, contents at reset, and attributes as follows:

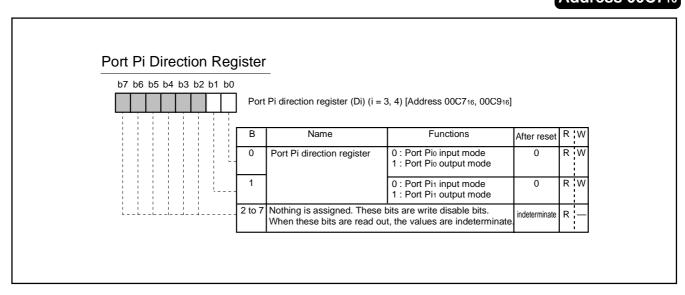


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Addresses 00C116, 00C316, 00C516

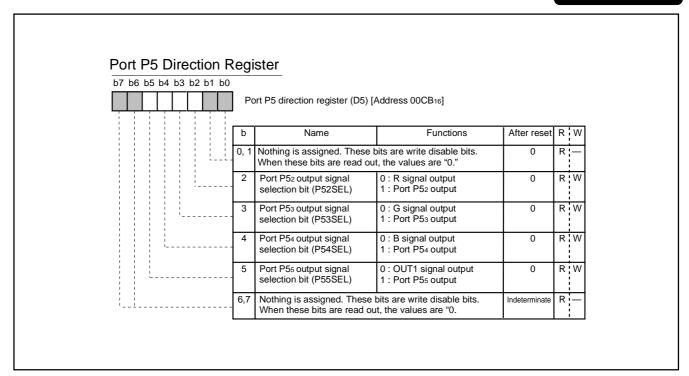
b7 b6 b5 b4 b3 b2 b1 b0	_				
	Po	ort Pi direction register (Di) (i	=0,1,2) [Addresses 00C1 16, 00C	C316, 00C516]	
	В	Name	Functions	After reset	R W
	0	Port Pi direction register	0 : Port Pio input mode 1 : Port Pio output mode	0	R W
	1		0 : Port Pi1 input mode 1 : Port Pi1 output mode	0	R W
	2		0 : Port Pi2 input mode 1 : Port Pi2 output mode	0	R W
	3		0 : Port Pi3 input mode 1 : Port Pi3 output mode	0	R W
	4		0 : Port Pi4 input mode 1 : Port Pi4 output mode	0	R W
	5		0 : Port Pis input mode 1 : Port Pis output mode	0	R W
	6		0 : Port Pis input mode 1 : Port Pis output mode	0	R W
	7		0 : Port Pi7 input mode 1 : Port Pi7 output mode	0	R W

Address 00C7₁₆

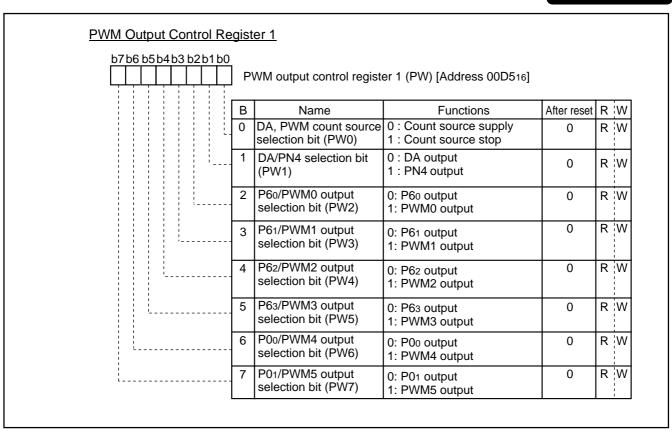


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00CB₁₆



Address 00D5₁₆



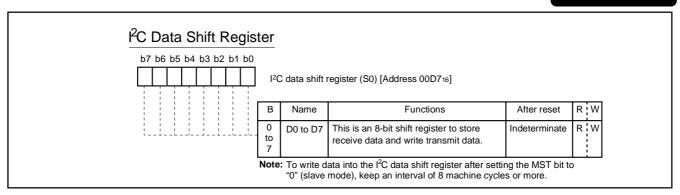


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

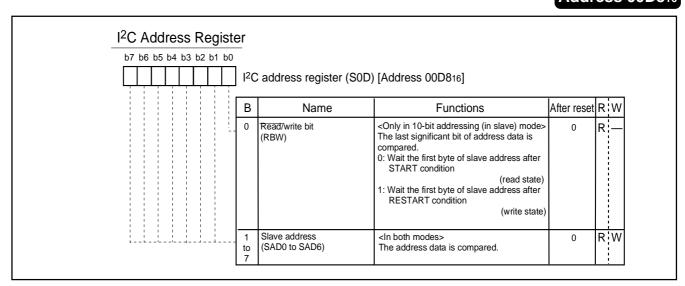
Address 00D6₁₆

PWM Output Control Red		er 2_					
b7 b6 b5 b4 b3 b2 b1 b0		WM output control regist	er 2 (PN) [Address 00D6 16]				
	В	Name	Functions	After reset	R	W	
<u>.</u>	0	P02/PWM6 output selection bit (PN0)	0 : P02 1 : PWM6 output	0	R	W	
	1	P03/PWM7 output selection bit (PN1)	0 : P03 1 : PWM7 output	0	R	W	
	2	DA output polarity selection bit (PN2)	0 : Positive polarity 1 : Negative polarity	0	R	W	
	3	PWM output polarity selection bit (PN3)	0 : Positive polarity 1 : Negative polarity	0	R	W	
	4	DA general-purpose output bit (PN4)	0 : Output LOW 1 : Output HIGH	0	R	W	
	5 to 7		nese bits are write disable bits. ad out, the values are "0."	0	R		

Address 00D7₁₆



Address 00D8₁₆



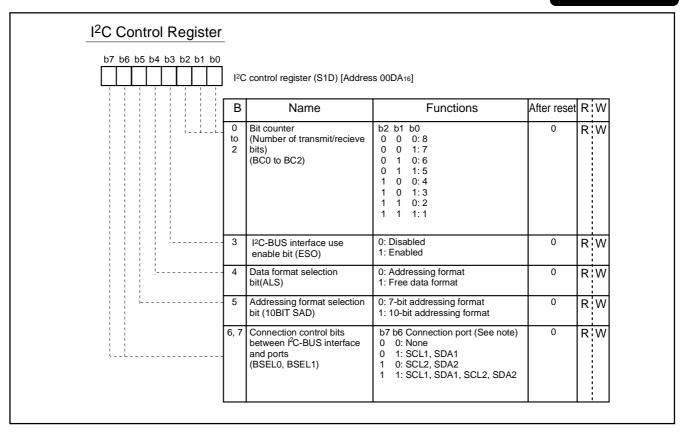


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00D9₁₆

b7 b6 b5 b4 b3 b2 b1 b0	2	C status register (S1) [A	ddress 00D916]			
	В	Name	Functions	After reset	R	W
	0	Last receive bit (LRB) (See note)	0 : Last bit = "0 " 1 : Last bit = "1 " (See note)	Indeterminate	R	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	1	General call detecting flag (AD0) (See note)	0 : No general call detected 1 : General call detected (See note)	0	R	
	2	Slave address comparison flag (AAS) (See note)	0 : Address mismatch 1 : Address match (See note)	0	R	_
	3	Arbitration lost detecting flag (AL) (See note)	0 : Not detected 1 : Detected (See note)	0	R	
	4	I ² C-BUS interface interrupt request bit (PIN)	0 : Interrupt request issued 1 : No interrupt request issued	1	R	W
	5	Bus busy flag (BB)	0 : Bus free 1 : Bus busy	0	R	W
ii	6, 7	Communication mode specification bits (TRX, MST)	b7 b6 0 0: Slave recieve mode 0 1: Slave transmit mode 1 0: Master recieve mode 1 1: Master transmit mode	0	R	8

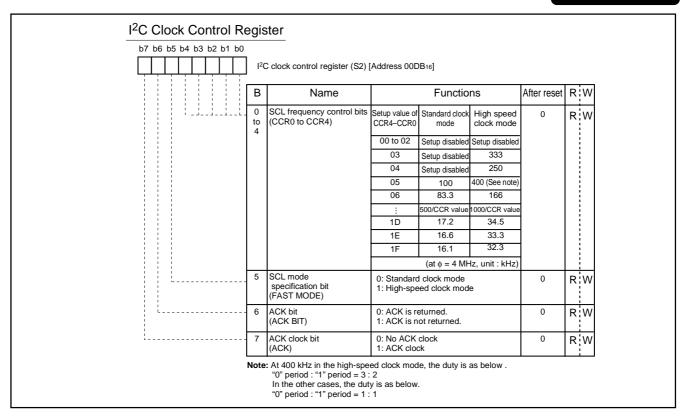
Address 00DA₁₆



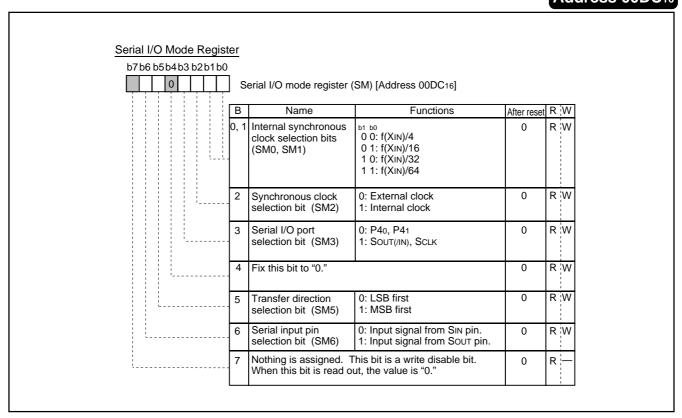


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00DB₁₆



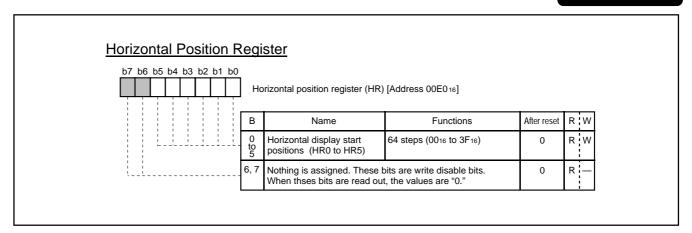
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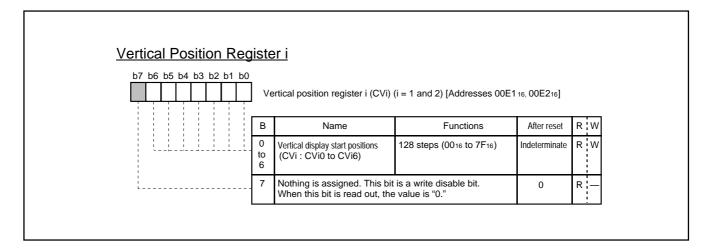


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

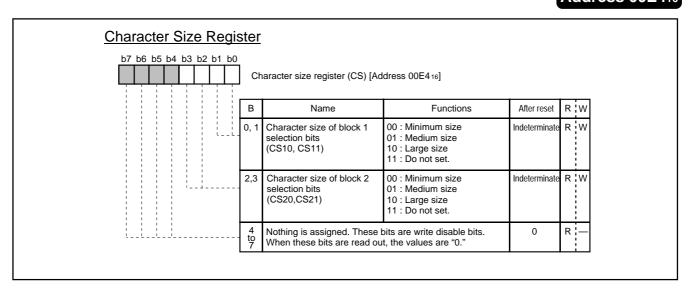
Address 00E0₁₆



Addresses 00E116 and 00E216



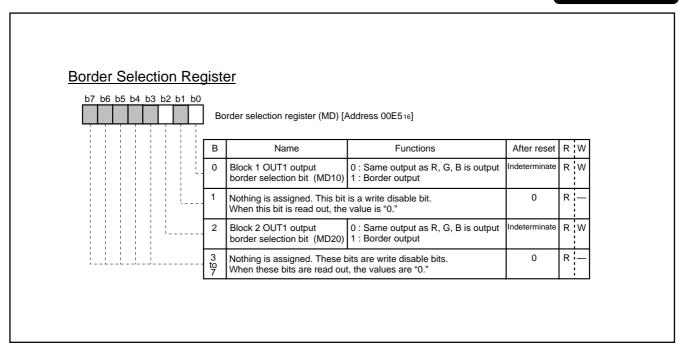
Address 00E416



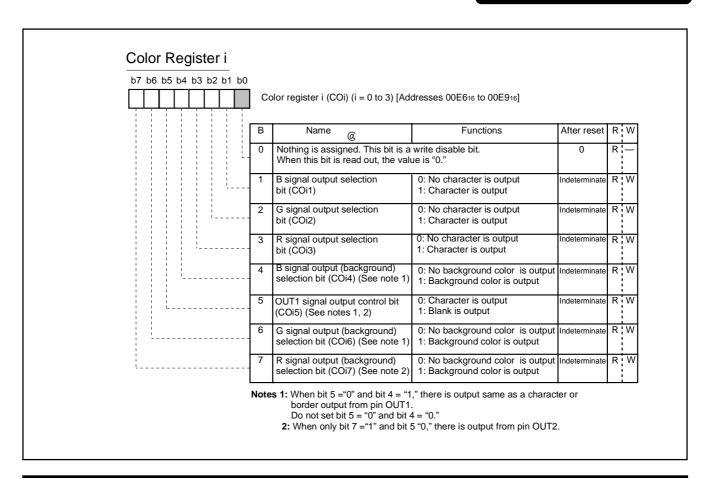


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00E5₁₆



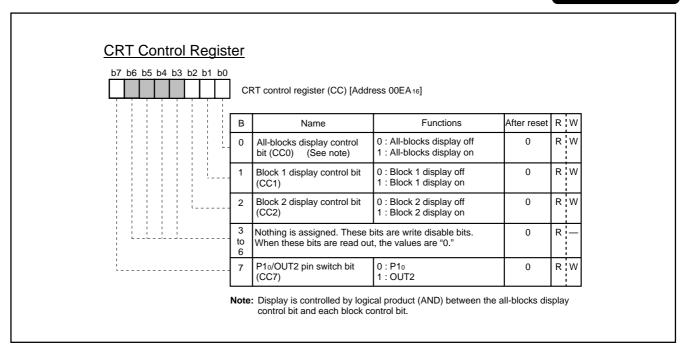
Addresses 00E616 to 00E916



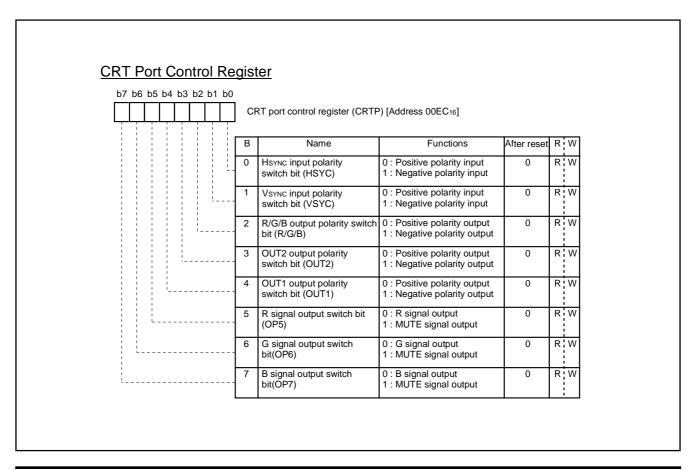


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER
with ON-SCREEN DISPLAY CONTROLLER

Address 00EA₁₆



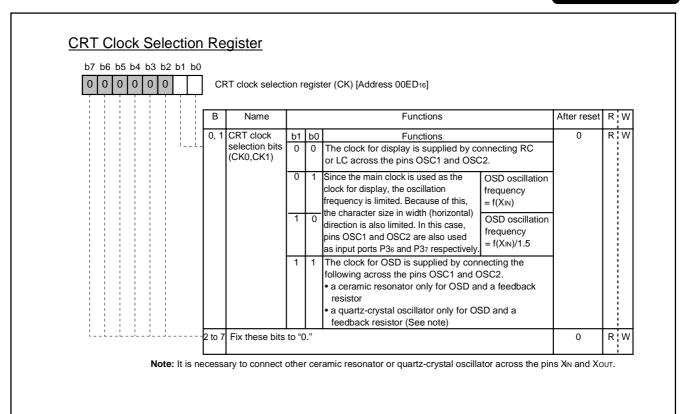
Addresses 00EC₁₆



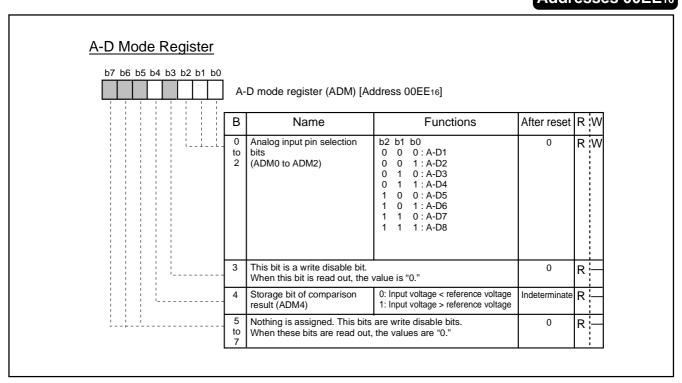


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00ED₁₆



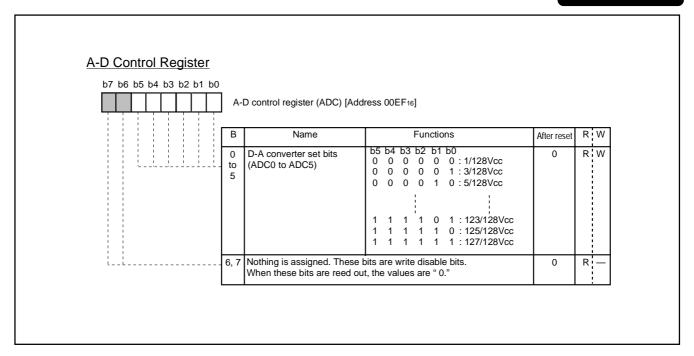
Addresses 00EE₁₆



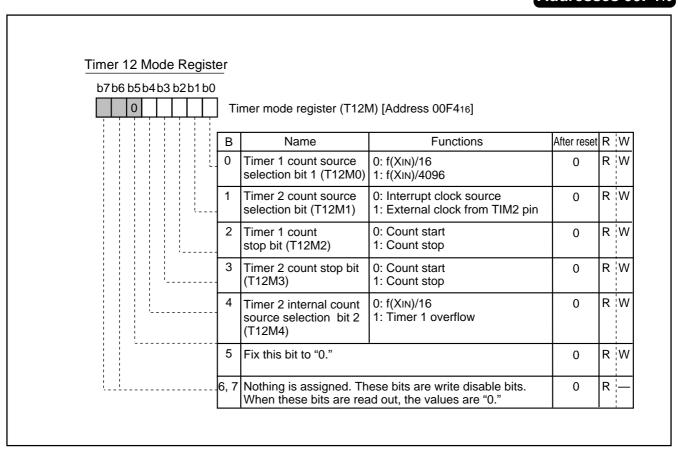


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00EF₁₆



Addresses 00F4₁₆



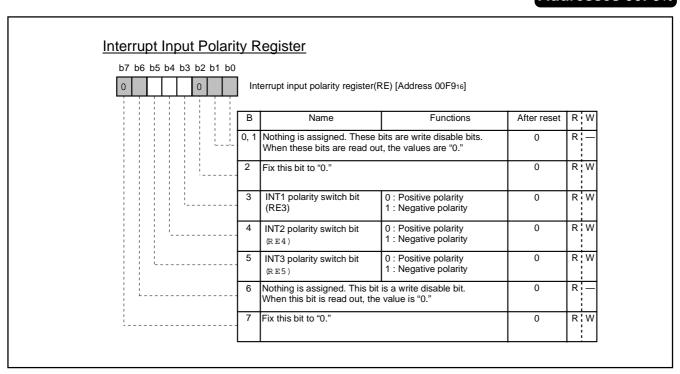


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00F5₁₆

b7b6b	5b4b3b2b1b0	_							
] Ti	Timer 34 mode register (T34M) [Address 00F516]						
		В	Name	Functions	After reset	R	W		
		0	Timer 3 count source selection bit (T34M0)	0 : f(XIN)/16 1 : External clock source	0	R	٧		
		1	Timer 4 internal interrupt count source selection bit (T34M1)	0 : Timer 3 overflow signal 1 : f(XIN)/16	0	R	٧		
		2	Timer 3 count stop bit (T34M2)	0: Count start 1: Count stop	0	R	V		
		3	Timer 4 count stop bit (T34M3)	0: Count start 1: Count stop	0	R	٧		
		4	Timer 4 count source selection bit (T34M4)	0: Internal clock source 1: f(X _{IN})/2	0	R	V		
	! ! !	5	Timer 3 external count source selection bit (T34M5)	0: TIM3 pin input 1: Hsync pin input	0	R	٧		
! !		6, 7		ese bits are write disable bits. ad out, the values are "0."	0	R	-		

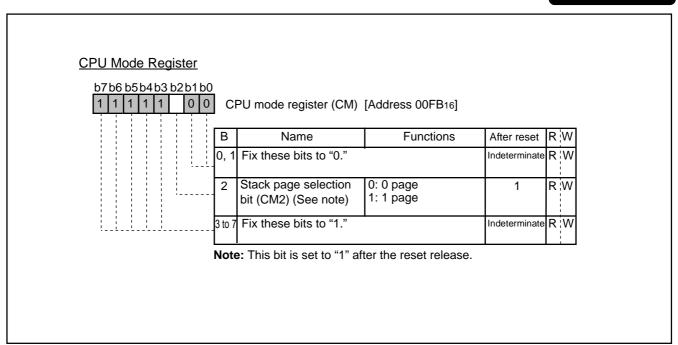
Addresses 00F9₁₆



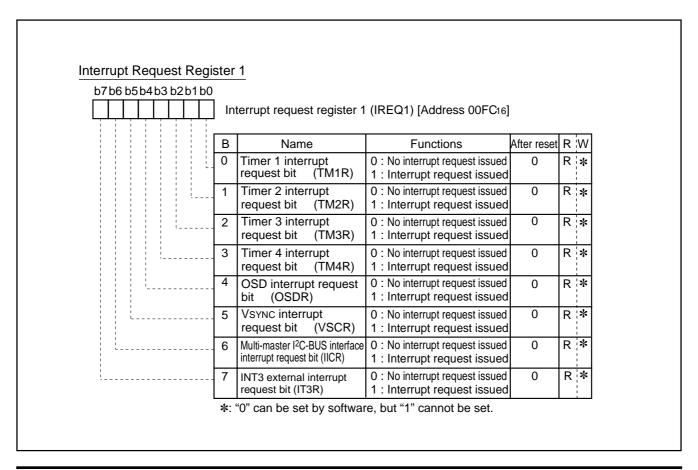


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00FB₁₆



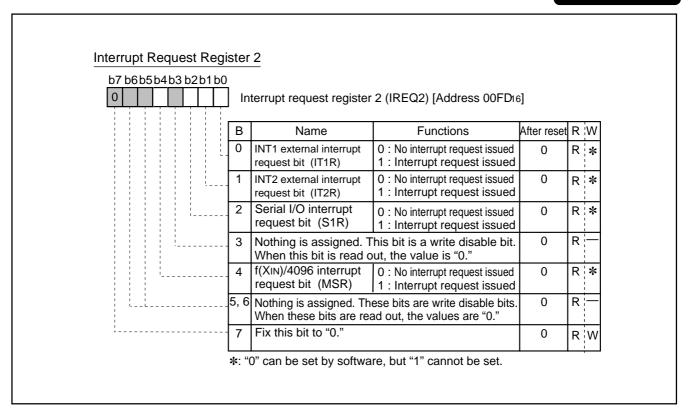
Addresses 00FC₁₆



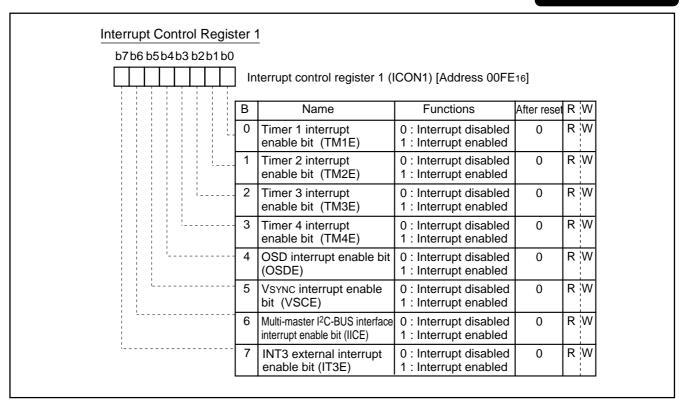


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00FD₁₆



Addresses 00FE₁₆



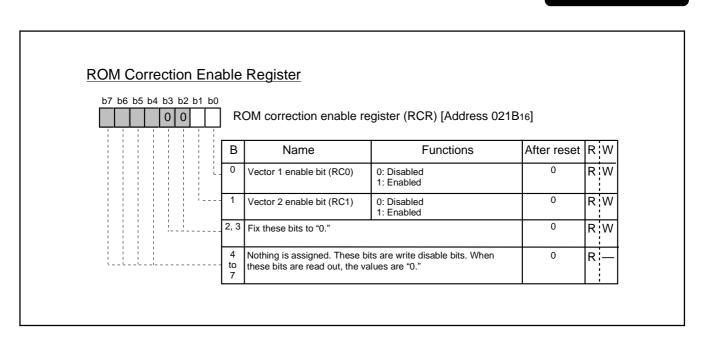


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Address 00FF₁₆

b7b6b5b4b3b2b1b0		_				
0 0 0	Interrupt control register 2 (ICON2) [Address 00FF16]					
	В	Name	Functions	After reset	R	W
	0	INT1 external interrupt enable bit (IT1E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
1	1	INT2 external interrupt enable bit (IT2E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	2	Serial I/O interrupt enable bit (S1E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	3	Fix this bit to "0."		0	R	W
	4	f(XIN)/4096 interrupt enable bit (MSE)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	5, 6	Fix these bits to "0."		0	R	W
(7	Nothing is assigned. These bits a these bits are read out, the value		indeterminate	R	-

Addresses 021B₁₆



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

21. PACKAGE OUTLINE

52P4B Plastic 52pin 600mil SDIP EIAJ Package Code SDIP52-P-600-1.78 JEDEC Code Weight(g) Lead Material Alloy 42/Cu Alloy 5.1 **6**4 **Dimension in Millimeters** Symbol Nom Max Α 5.5 D A1 0.51 38 A₂ 0.4 0.6 b 0.5 b1 0.9 1.0 1.3 0.65 0.75 1.05 b2 0.22 0.27 0.34 С 45.65 45.85 D 46.05 е Ε 12.85 13.0 13.15 е 1.778 SEATING PLANE **e**1 15.24 3.0

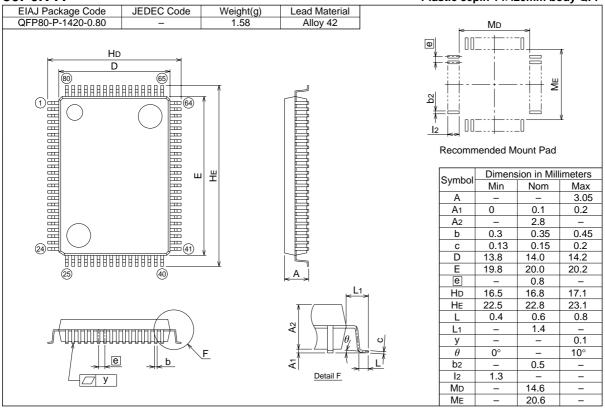
80P6N-A

Plastic 80pin 14×20mm body QFP

15°

0°

 θ



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Renesas Technology Corp.

Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

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SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

	REVISION HISTORY	M37212M4/M8-XXXSP, M37212N M37212EFSP/FP (Rev.1.0)	16-XXXSP/FP, DATA SHEET
Rev.		Revision Description	Rev.
No.			date
1.0	PDF First Edition		9909